

SAMSUNG

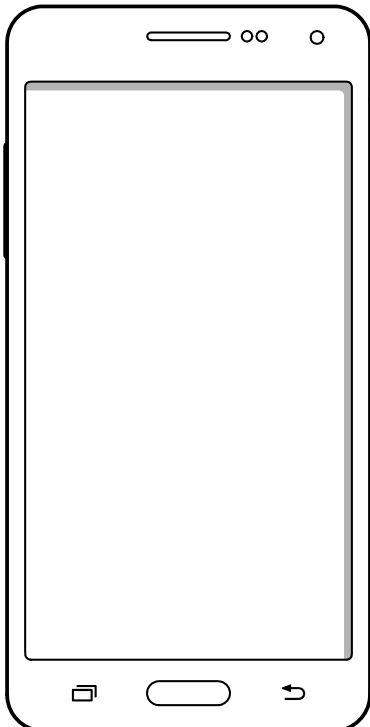
Wireless Device

SM-A500H

SERVICE *Manual*

Wireless Device

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ELECTRONICS**

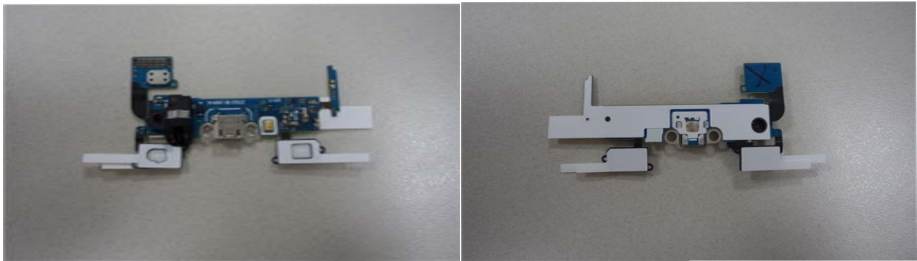


7. Level 2 Repair

7-1. Pre-requisite

	
Tweezers / Disass'y Stick / Screw Driver	Anti-static Gloves
	
OCTA Disassembly Holder	Anti-static Mat
	
Acryl Jig Rework Form	Glass Absorbers (2ea)
	
Tape Rework Form	Mobile Dryer

7-2. Parts which must be changed after repair

OCTA Form Tape	 A rectangular blue tape with a white rectangular area in the center, used for protecting the screen during repair.
Bracket Cu Tape	 A blue tape with a white rectangular area in the center, used for protecting the bracket during repair.
Touch Key Top Tape	 Two images showing the Touch Key Top Tape. The left image shows the tape with a white rectangular area in the center. The right image shows the tape with a white rectangular area in the center.

7-3. Disassembly

1



Temperature :
 $70 \pm 10^{\circ} \text{C}$

1) After heating for 10 minutes the device at $70 \sim 80^{\circ}\text{C}$, take out the device from Mobile dryer.

2



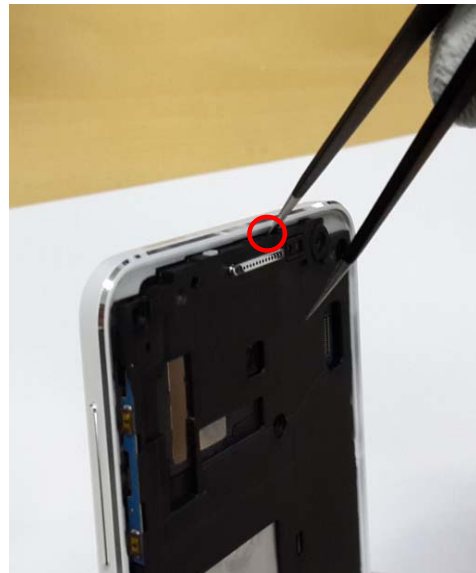
1) Detach the Bracket CU tape carefully from the OCTA Cu sheet using Glass absorber and holder.
2) Be careful not to separate LCD from TSP.

3



1) Disassemble loosen 12 Point of Bracket

4



1) Disassemble Bracket and REAR

5



1) Detach the Bracket and REAR

6



1) Loosen a Screw in PBA Ass'y

7



1) Detach Connector and Coaxial Cable from PBA

8



1) Detach the PBA from bottom REAR
2) Be careful not to damage

9



1) Detach Main and Sub Camera on PBA

10



1) Detach the Receiver, Speaker, Coaxial Cable and Battery

11



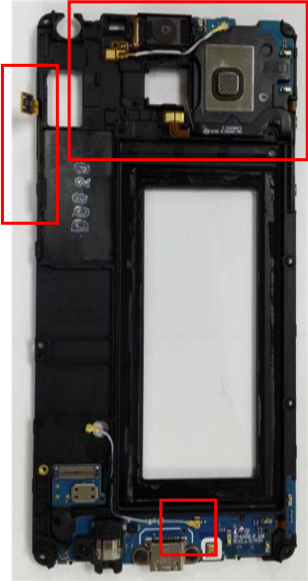
1) Detach upper Sub PBA and Power key
2) Be careful not to Damage

12



1) Detach lower Sub PBA from Bracket
2) Be careful not to Damage

7-4. Assembly

1 	2 
1) Assemble lower Sub PBA on Bracket	1) Assemble the Upper/Lower SUB PBA and Coaxial Cable Then RCV, Speaker, Power Key
3 	4 
1) Attach Battery on Bracket 2) Press Battery using Battery Pressing JIG.	1) Attach Main and Sub Camera on PBA

5



- 1) Assemble PBA on Bracket
- 2) Assemble lower Sub PBA and Main PBA

6



- 1) Assemble Connector on the PBA Assy
- 2) Assemble Coaxial Cable

7



- 1) Tighten a screw
 1.2 ± 0.1 Kgf/cm²

8



- 1) Assemble PBA ass'y and REAR

5	6
1) Tighten screw the 12 point $1.2 \pm 0.1 \text{ Kg/cm}^2$	1) Assemble LCD Connector 2) Attach LCD and REAR ass'y
7	
1) Press OCTA Window using Window pressing JIG.	

5. MAIN Electrical Parts List

SEC CODE	Design LOC	Description
0404-001250	D4000	DIODE
0406-001361	ZD6002	DIODE
0406-001413	ZD5002	DIODE
0406-001459	ZD5015	DIODE
0406-001553	ZD2000,ZD2001	DIODE
0406-001561	ZD5014	DIODE
0406-001568	ZD5005,ZD5006	DIODE
0406-001642	ZD5003,ZD5004,ZD6000	DIODE
0406-001642	ZD6001	DIODE
0406-001645	ZD5007,ZD5008,ZD5009	DIODE
0406-001645	ZD5010,ZD5011,ZD5016	DIODE
0406-001667	ZD7000,ZD7001	DIODE
0406-001675	ZD4000	DIODE
0406-001676	ZD5012,ZD5013	DIODE
0504-001171	Q4000,Q7000	TR-DIGITAL
0505-002341	Q4001	FET-SILICON
0505-003403	Q6000	FET-SILICON
0601-003398	LED7000	LED
1001-001841	U7002	IC
1001-001903	U5004	IC
1003-002415	U6008	IC
1108-000573	UME4000	MEMORY
1201-003786	U2000	IC
1201-003788	U1003	IC
1201-003866	PA1000	IC
1201-003876	U5000	IC
1201-003894	PA1001	IC
1203-007324	U6003,U6004	IC
1203-007790	U5002,U6006	IC
1203-007791	U1002,U6002	IC
1203-007796	U6000,U6007,U7000	IC
1203-007842	U6001	IC
1203-007992	U4001	IC
1203-008167	U7004	IC
1203-008288	U2002	IC
1203-008295	U6005	IC;SM3004

1203-008324	U4000	IC
1205-004819	U2001	IC
1205-005106	U5001	IC
1205-005142	U2004	IC
1205-005162	UCP3000	IC
1209-002204	U7003	IC
1209-002318	U7001	IC
1404-001724	TH2000,TH3000	THERMISTOR
2007-000148	R3033,R7007	R-CHIP
2007-007315	R3007	R-CHIP
2007-007480	R5024	R-CHIP
2007-007573	R5036	R-CHIP
2007-007589	R2001	R-CHIP
2007-007741	R7002	R-CHIP
2007-008045	R4027,R5029,R5030	R-CHIP
2007-008045	R5032,R7000,R7009	R-CHIP
2007-008045	R7012,R7013,R7015	R-CHIP
2007-008052	R5004,R6000,R6007	R-CHIP
2007-008052	R6008,R7001	R-CHIP
2007-008055	R4029,R5019,R6004	R-CHIP
2007-008055	R6012	R-CHIP
2007-008057	R7005	R-CHIP
2007-008210	R1000	R-CHIP
2007-008419	R4028,R5001,R5002	R-CHIP
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2007-008420	R3038	R-CHIP
2007-008483	R4015,R4016,R4017	R-CHIP
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2007-008516	R3008,R3009,R3021	R-CHIP
2007-008516	R3022,R3046,R3048	R-CHIP
2007-008516	R3051,R3053,R4014	R-CHIP
2007-008516	R5008,R5013,R5015	R-CHIP
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2203-008094	C7014	C-CERAMIC,CHIP
2203-008097	C1005,C1072,C1085	C-CERAMIC,CHIP
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2203-008126	C7011	C-CERAMIC,CHIP
2203-008192	C2037,C2052,C2053	C-CERAMIC,CHIP
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2203-008692	C4044	C-CERAMIC,CHIP
2203-008876	C1084,C1089	C-CERAMIC,CHIP
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2203-009076	C2036	C-CERAMIC,CHIP
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2203-009223	C2018,C2095	C-CERAMIC,CHIP
2703-002309	L5015	INDUCTOR-SMD
2703-002313	L6007,L6008	INDUCTOR-SMD
2703-002901	L1065,L1067	INDUCTOR-SMD
2703-002958	L1055,L2005	INDUCTOR-SMD
2703-002960	L1009	INDUCTOR-SMD
2703-002961	L1014	INDUCTOR-SMD
2703-003004	L1051	INDUCTOR-SMD
2703-003878	L5007	INDUCTOR-SMD
2703-004000	L2013	INDUCTOR-SMD
2703-004012	C1013,L1001	INDUCTOR-SMD
2703-004014	L1040	INDUCTOR-SMD
2703-004018	L1036,L1038,L2002	INDUCTOR-SMD
2703-004030	C2096,L1064,L1071	INDUCTOR-SMD
2703-004032	C1069,L1000,L1016	INDUCTOR-SMD

2703-004032	L1020,L1062	INDUCTOR-SMD
2703-004034	L2011,L2012	INDUCTOR-SMD
2703-004035	L1007,L1025,L1042	INDUCTOR-SMD
2703-004035	L1046,L1049	INDUCTOR-SMD
2703-004037	L1031,L1041,L1047	INDUCTOR-SMD
2703-004037	L1073	INDUCTOR-SMD
2703-004038	L1019,L1048,L1053	INDUCTOR-SMD
2703-004038	L1060,L1063	INDUCTOR-SMD
2703-004230	L5011	INDUCTOR-SMD
2703-004286	L2001,L2004	INDUCTOR-SMD
2703-004299	L1072,L1075	INDUCTOR-SMD
2703-004302	L1068,L1069,L1074	INDUCTOR-SMD
2703-004302	L1077	INDUCTOR-SMD
2703-004328	L1070,L2018	INDUCTOR-SMD
2703-004364	L1004	INDUCTOR-SMD
2703-004366	C1105,L1011,L2003	INDUCTOR-SMD
2703-004368	C1034,L1005,L1012	INDUCTOR-SMD
2703-004368	L1017,L1018,L1021	INDUCTOR-SMD
2703-004368	L1026,L1027,L1032	INDUCTOR-SMD
2703-004371	L1002,L1061	INDUCTOR-SMD
2703-004684	L3000	INDUCTOR-SMD
2703-004718	L4004	INDUCTOR-SMD
2703-004775	L4000,L5009,L7001	INDUCTOR-SMD
2703-004786	L7002	INDUCTOR-SMD
2703-005017	L2006	INDUCTOR-SMD
2703-005056	L6002	INDUCTOR-SMD
2703-005061	L4002,L4003	INDUCTOR-SMD
2703-005069	L6003	INDUCTOR-SMD
2703-005100	L5002,L5004	INDUCTOR-SMD
2703-005109	L4001	INDUCTOR-SMD
2703-005117	L6006	INDUCTOR-SMD
2801-005154	OSC2000	OSCILLATOR
2801-005390	OSC4000	OSCILLATOR
2901-001690	F4000,F4001,F4002	FILTER
2901-001786	F6000,F6001,F6002	FILTER
2901-001786	F6003,F6004	FILTER
2901-001798	F6005,F6006,F6007	FILTER

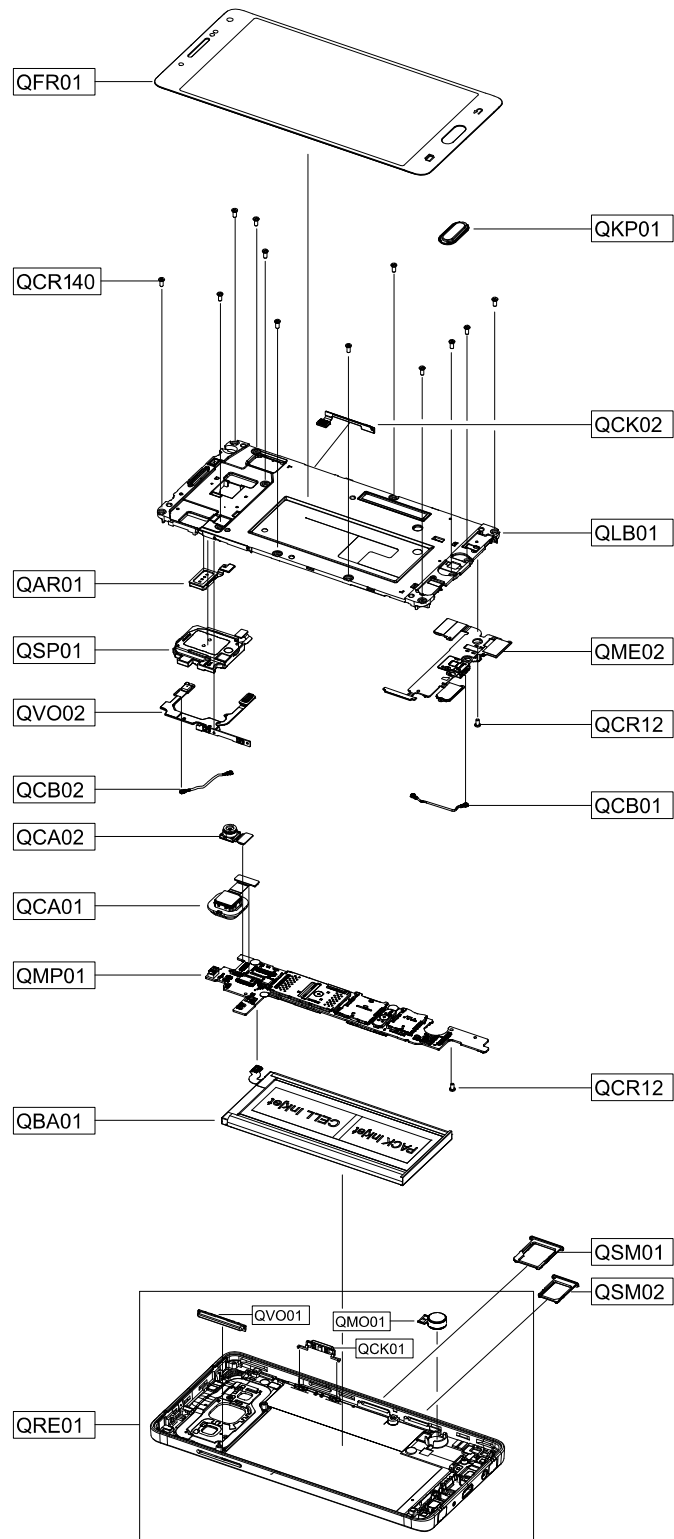
2901-001798	F6008,F6009,F6010	FILTER
2901-001798	F6011,F6012	FILTER
2904-002162	F2001	FILTER
2904-002168	F2000	FILTER
2904-002206	F2002	FILTER
2910-000200	F1004	FILTER
2910-000256	F1001	FILTER
2911-000278	F1002	FILTER
2911-000318	F1007	FILTER
3301-001659	L1045,L2000	CORE-FERRITE
3301-001729	L6000	CORE-FERRITE
3301-001789	L6001,L6004,L6005	CORE-FERRITE
3301-001885	L5006,L5012,L5013	CORE-FERRITE
3301-001885	L5017,L5018	CORE-FERRITE
3301-001914	L4005	CORE-FERRITE
3301-002035	L5003,L5005	CORE-FERRITE
3301-002078	L5010	CORE-FERRITE
3301-002236	L5000,L5001,L5019	CORE-FERRITE
3301-002236	L5021,L5022	CORE-FERRITE
3301-002239	L5016	CORE-FERRITE
3301-002248	L2007	CORE-FERRITE
3301-002254	L7000	CORE-FERRITE
3301-002286	L5020	CORE-FERRITE
3301-002304	R6001,R6003	CORE-FERRITE
3705-001448	RFS1000	CONNECTOR
3705-001708	RFS1001	CONNECTOR
3705-002014	RFS2000	CONNECTOR
3709-001859	SIM6000	CONNECTOR
3709-001860	SIM6001	CONNECTOR
3711-007295	HDC6002	CONNECTOR
3711-008010	HDC5002	CONNECTOR
3711-008151	HDC5000	CONNECTOR
3711-008182	HDC6000	CONNECTOR
3711-008511	HDC6001	CONNECTOR
3711-008593	HDC5001	CONNECTOR
3711-008847	BTC4000	CONNECTOR
3712-001518	ANT2001,ANT2002	CONNECTOR

3712-001524	ANT6000,ANT6001	CONNECTOR
3712-001537	ANT1000,ANT1001	CONNECTOR
3712-001537	ANT1002,ANT2000	CONNECTOR
3712-001537	ANT2004,ANT5000	CONNECTOR
3712-001537	ANT5001,ANT5002	CONNECTOR
3712-001537	ANT5003	CONNECTOR
3712-001538	ANT2003	CONNECTOR
4709-001997	F2003	FREQ-DISTRIBUTER
4709-002193	F1000	COUPLER-DIRECTION
GH63-08836A	SC2001,SC2002	SHIELD-CAN G_COVER(A500F)
GH80-03320A	R3000,R3001,R3002	SOLDER-CREAM
GH80-03320A	R3003,R3004,R3005	SOLDER-CREAM
GH98-34829A	SC2005	ASSY COVER-SHIELD CAN H
GH98-34830A	SC2003	ASSY COVER-SHIELD CAN I
GH98-35708A	SC2000	ASSY COVER-SHIELD CAN C_CIS
GH98-35743A	SC2004	ASSY COVER-SHIELD CAN A_CIS

Please consult the GSPN website (Samsung Portal) for the most recent version of the product's part list.

4. Exploded View and Parts List

4-1. Cellular phone Exploded View



2. Specification

2-1. GSM General Specification

	GSM850	EGSM 900	DCS1800	PCS1900	WCDMA 2100	WCDMA 1900	WCDMA 900	WCDMA 850
Freq. Band[MHz] Uplink/ Downlink	824~849 869~894	880~915 925~960	1710~1785 1805~1880	1850~1910 1930~1990	1922~1977 2110~2170	1852~1907 1932~1987	880~915 925~960	824~849 869~894
ARFCN range	128~251	0~124 & 975~1023	512~885	512~810	UL:9612~9888 DL:10562~10838	UL:9262~9538 DL:9662~9938	UL: 2712~2863 DL: 2937~3088	UL: 4132~4233 DL: 4357~4458
Tx/Rx spacing	45MHz	45MHz	95MHz	80MHz	190MHz	80MHz	45MHz	45MHz
Mod. Bit rate/ Bit Period	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us	3.84Mcps	3.84Mcps	3.84Mcps	3.84Mcps
Time Slot Period/ Frame Period	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms
Modulation	0.3GMSK	0.3GMSK	0.3GMSK	0.3GMSK	QPSK, HPSK	QPSK, HPSK	QPSKHQPSK	QPSKHQPSK
MS Power	33dBm~5dBm	33dBm~5dBm	30dBm~0dBm	30dBm~0dBm	24dBm~-50dBm	24dBm~-50dBm	24dBm~-50dBm	24dBm~-50dBm
Power Class	5pcl ~ 19pcl	5pcl ~ 19pcl	0pcl ~ 15pcl	0pcl ~ 15pcl	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)
Sensitivity	-102dBm	-102dBm	-100dBm	-100dBm	-106.7dBm	-106.7dBm	-106.7dBm	-106.7dBm
TDMA Mux	8	8	8	8	8	8	8	8
Cell Radius	35Km	35Km	2Km	2Km	2Km	2Km	2Km	2Km

2-2. GSM Tx Power Class

TX Power control level	GSM850	TX Power control level	EGSM900	TX Power control level	DCS1800	TX Power control level	PCS1900
5	33±2 dBm	5	33±2 dBm	0	30±3 dBm	0	30±3 dBm
6	31±2 dBm	6	31±2 dBm	1	28±3 dBm	1	28±3 dBm
7	29±2 dBm	7	29±2 dBm	2	26±3 dBm	2	26±3 dBm
8	27±2 dBm	8	27±2 dBm	3	24±3 dBm	3	24±3 dBm
9	25±2 dBm	9	25±2 dBm	4	22±3 dBm	4	22±3 dBm
10	23±2 dBm	10	23±2 dBm	5	20±3 dBm	5	20±3 dBm
11	21±2 dBm	11	21±2 dBm	6	18±3 dBm	6	18±3 dBm
12	19±2 dBm	12	19±2 dBm	7	16±3 dBm	7	16±3 dBm
13	17±2 dBm	13	17±2 dBm	8	14±3 dBm	8	14±3 dBm
14	15±2 dBm	14	15±2 dBm	9	12±4 dBm	9	12±4 dBm
15	13±2 dBm	15	13±2 dBm	10	10±4 dBm	10	10±4 dBm
16	11±3 dBm	16	11±3 dBm	11	8±4 dBm	11	8±4 dBm
17	9±3dBm	17	9±3dBm	12	6±4 dBm	12	6±4 dBm
18	7±3 dBm	18	7±3 dBm	13	4±4 dBm	13	4±4 dBm
19	5±3 dBm	19	5±3 dBm	14	2±5 dBm	14	2±5 dBm
				15	0±5 dBm	15	0±5 dBm

3. Operation Instruction and Installation

Main Function

- Android OS: KitKat
- MSM8916 (Quad 1.2 Ghz)
- 16G Bytes (eMMC) + 2GByte LPDDR
- 5.0" on-Cell Touch AMOLED (1280 x 720(HD))
- 13MP Camera + 5MP Front Camera
- GPS / BT v4.0 / USB v2.0 / WiFi (802.11 a/b/g/n/ac)
- Sensors: Gyro/Accelerometer, Proximity, Light, RGB, Hall IC
- Additional :
 - FM Radio, Wifi Direct
 - Charger 5V / 1.55A
 - Data Cable 3.3pi, 1.0m
 - Ear phone 3.5p, 4pin

9. Reference Abbreviate

Reference Abbreviate

- **AAC**: Advanced Audio Coding.
- **AVC** : Advanced Video Coding.
- **BER** : Bit Error Rate
- **BPSK**: Binary Phase Shift Keying
- **CA** : Conditional Access
- **CDM** : Code Division Multiplexing
- **C/I** : Carrier to Interference
- **DMB** : Digital Multimedia Broadcasting
- **EN** : European Standard
- **ES** : Elementary Stream
- **ETSI**: European Telecommunications Standards Institute
- **MPEG**: Moving Picture Experts Group
- **PN** : Pseudo-random Noise
- **PS** : Pilot Symbol
- **QPSK**: Quadrature Phase Shift Keying
- **RS** : Reed-Solomon
- **SI** : Service Information
- **TDM** : Time Division Multiplexing
- **TS** : Transport Stream

1. Safety Precautions

1-1. Repair Precaution

Before attempting any repair or detailed tuning, shield the device from RF noise or static electricity discharges.

Use only demagnetized tools that are specifically designed for small electronic repairs, as most electronic parts are sensitive to electromagnetic forces.

Use only high quality screwdrivers when servicing products. Low quality screwdrivers can easily damage the heads of screws.

Use only conductor wire of the properly gauge and insulation for low resistance, because of the low margin of error of most testing equipment.

We recommend 22-gauge twisted copper wire.

Hand-soldering is not recommended, because printed circuit boards (PCBs) can be easily damaged, even with relatively low heat. Never use a soldering iron with a power rating of more than 100 watts and use only lead-free solder with a melting point below 250°C (482°F).

Prior to disassembling the battery charger for repair, ensure that the AC power is disconnected. Always use the replacement parts that are registered in the SEC system. Third-party replacement parts may not function properly.

1-2. ESD(Electrostatically Sensitive Devices) Precaution

Many semiconductors and ESDs in electronic devices are particularly sensitive to static discharge and can be easily damaged by it. We recommend protecting these components with conductive anti-static bags when you store or transport them.

Always use an anti-static strap or wristband and remove electrostatic buildup or dissipate static electricity from your body before repairing ESDs.

Ensure that soldering irons have AC adapter with ground wires and that the ground wires are properly connected.

Use only desoldering tools with plastic tips to prevent static discharge.

Properly shield the work environment from accidental electrostatic discharge before opening packages containing ESDs.

The potential for static electricity discharge may be increased in low humidity environments, such as air-conditioned rooms. Increase the airflow to the working area to decrease the chance of accidental static electricity discharges.

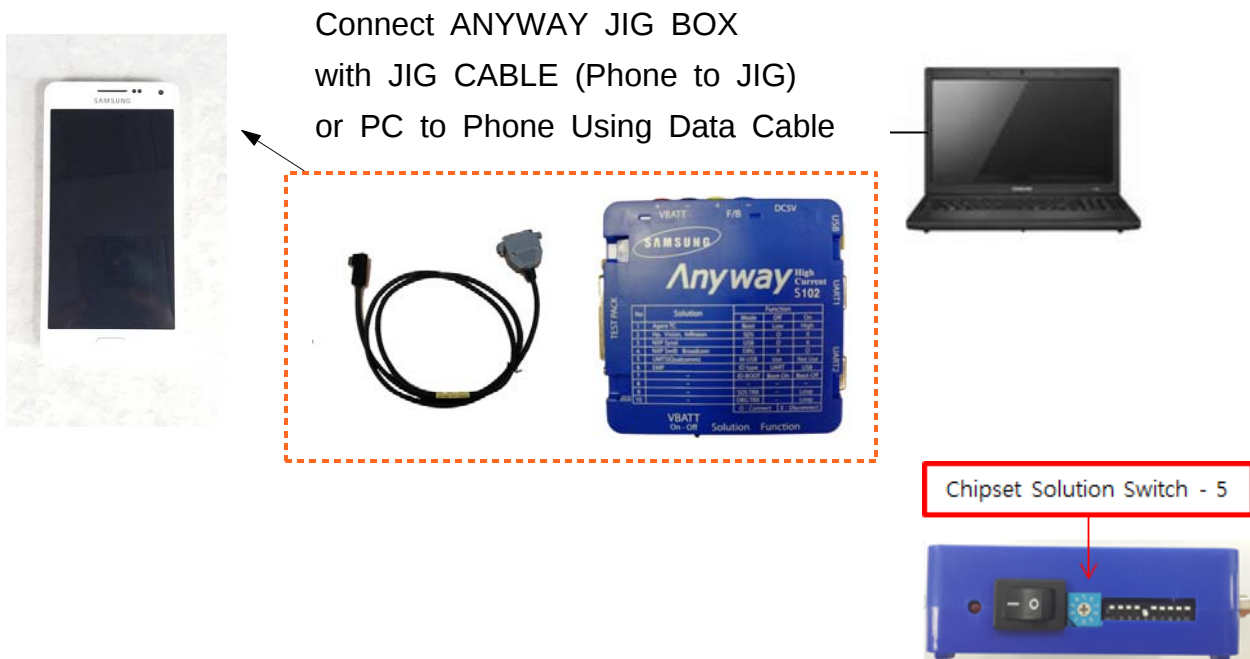
6. Level 1 Repair

6-1. S/W installation

6-1-1. Required items in order to install S/W

- Installation program: Downloader Program (**Odin3 v3.09.exe with odin3.ini**)
- SM-A500H Mobile Phone
- Data Cable
- JIG BOX (GH81-11888A)
- JIG Cable (GH81-10952A)
- Adapter (GH91-11888K)
- Serial Cable
- Mobile device specific S/W: Binary files

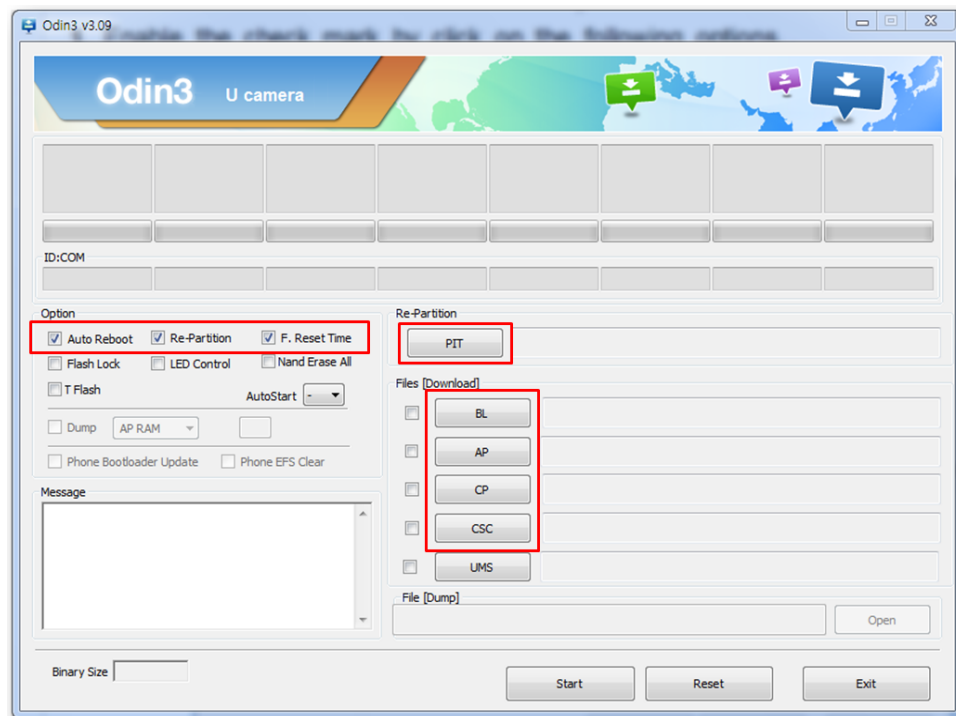
※ Settings



6-1-2. S/W Installation Program (Downloader program)

- Open up the S/W Installation Program by executing the **"Odin3 v3.09.exe"**
("odin3.ini" file should be in the same folder with odin3 v3.09.exe)

1. Enable the check mark by click on the following options,
 - Check Re-Partition, Auto Reboot, and F. Reset Time
 - Check PIT
 - Check BL,AP,CP and CSC Files

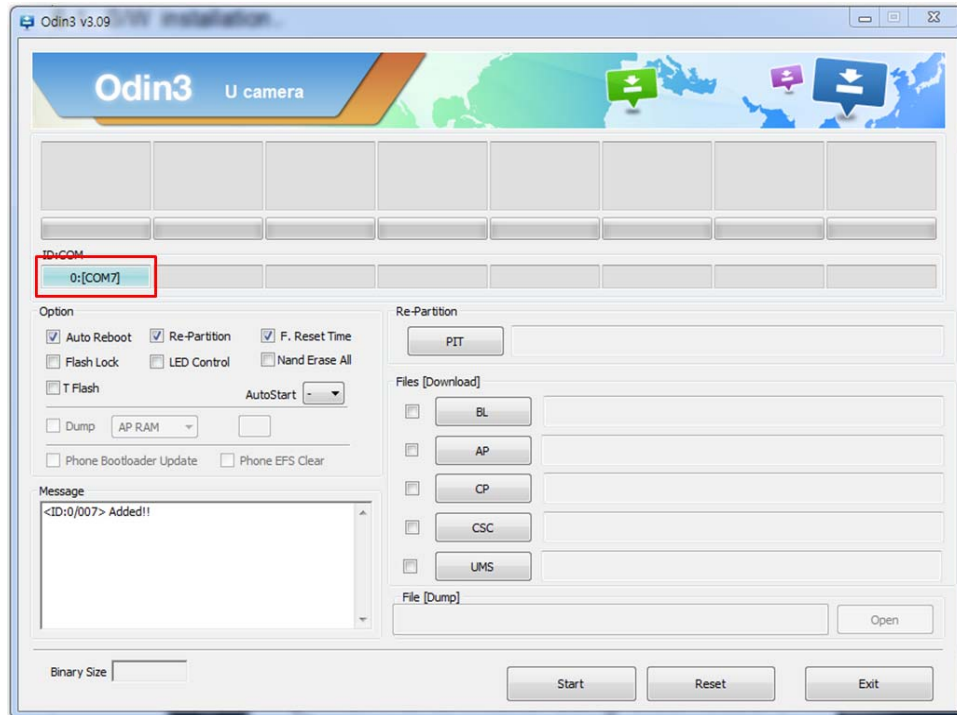


2. Enter into Download Mode

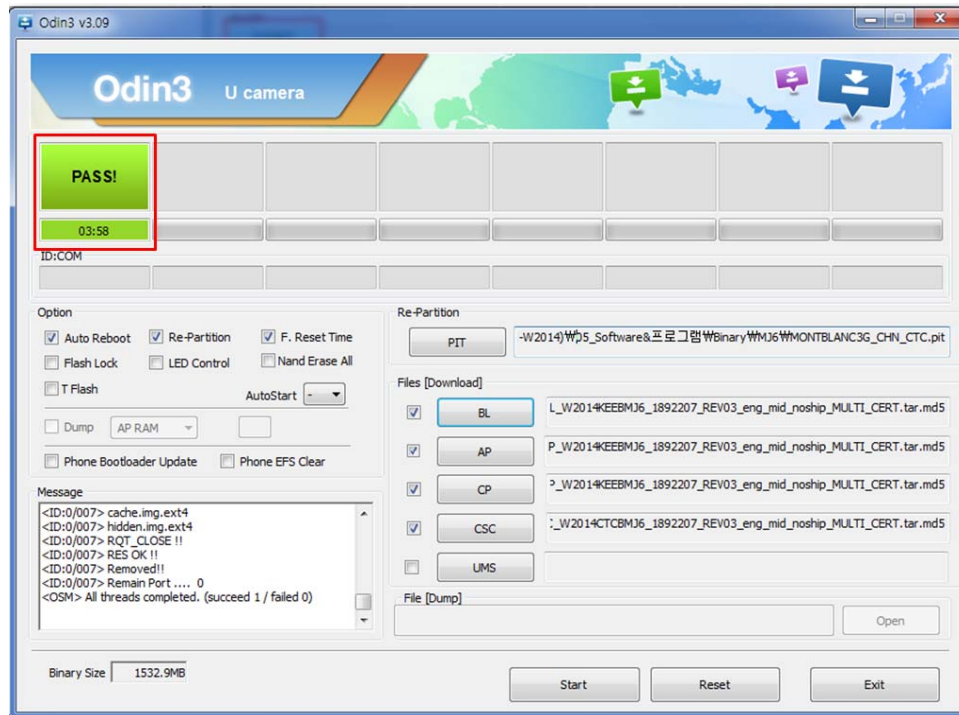
- ① Enter into Download Mode by pressing Volume Down button and ON/OFF Button simultaneously.
- ② Next, press Volume Up button.

3. Connect the device to PC via Data Cable.

Make sure that the one of communication port [ID:COM] box is highlighted in yellow. The device is now connected with the PC and ready to download the binary file into the device.



4. Start downloading binary file into the device by clicking Start Button on the screen. the green colored "PASS!" sign will appear on the upper-left box if the binary file has been successfully downloaded into the device.



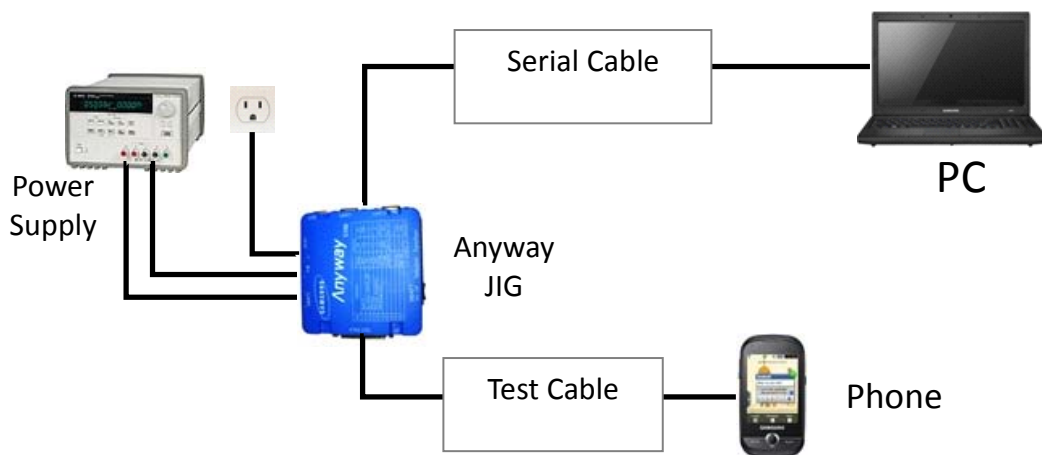
5. Disconnect the device from the Data cable.
6. Once the device boots up, you can check the version of the binary file or name by pressing the following code in sequence;
***#1234#**

6-2 IMEI writing

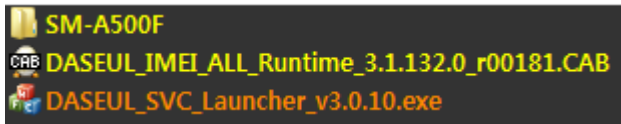
6-2-1 Preparation

- New IMEI writing Program has been released.
- Supported Model : Models which CAB files are uploaded on HHPsvc INI File category, instead of ini file.
- Refer to below IMEI writing procedure.(For SM-A500F/G/H Model)

- H/W

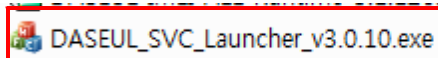


- S/W

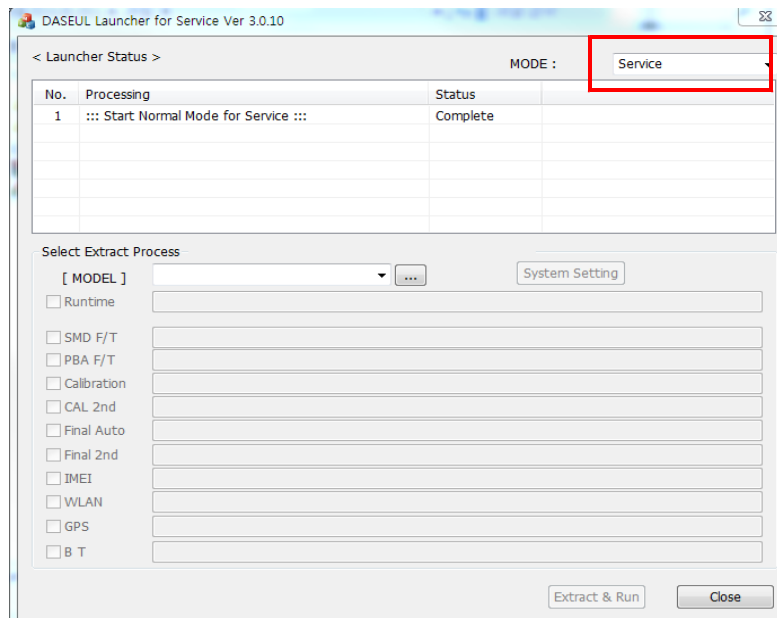
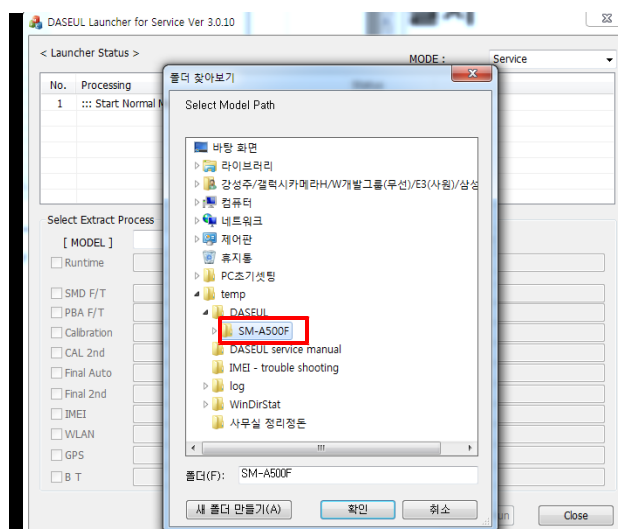
① Library Install	To use Daseul, library files should be installed. Refer to SVC Bulletin “(11-82) Daseul (New IMEI writing Program) Library Install guide_rev1.0”
② Launcher	DASEUL_SVC_Launcher_v3_0_10 or higher -Uploaded on HHPsvc Notice
③ Runtime File	1. DASEUL_IMEI_ALL_Runtime_129_r00165 .CAB or higher -Uploaded on HHPsvc Notice 2. Make 'ModelName' folder at the same position with launcher & Runtime file. 
④ Model File	Copy Model File under the 'Model Name' folder

6-2-2 IMEI writing Process

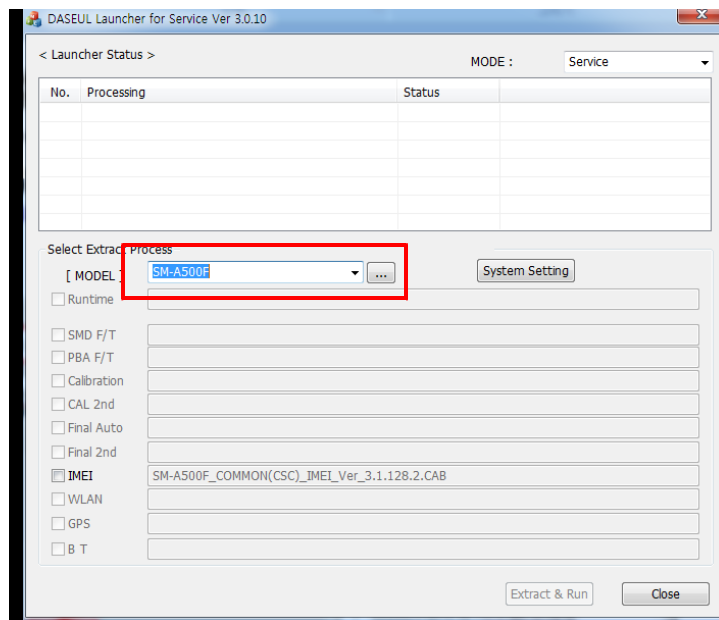
1. Run DASEUL_SVC_Launcher_v3.0.10.exe



2. Select Service Mode

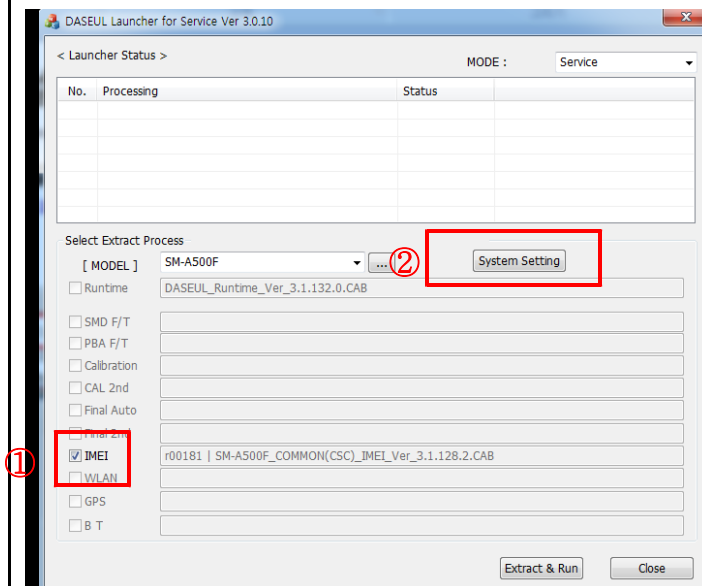
3. Click and Select folder where the Launcher exists

4. Select Model



5. Check IMEI and click 'System Setting'

※Once you setup the setting, you don't have to do it again, unless there is change. From second run of the IMEI program, check IMEI and click 'Extract & Run'.



6. Check 'IMEI Write / IMEI Check', and click 'IMEI SVC & Repair Option'

Set System Configuration
Set System Configuration Dialog...

Test Process

[Process]	[Master]	[Slave]
SMD F/T	☐	☐
PBA F/T	☐	☐
Calibration	☐	☐
Calibration 2ND	☐	☐
Final Auto	☐	☐
Final Auto 2ND	☐	☐
Final Manual	☐	☐
IMEI Write	☒	☐
IMEI Check	☒	☐
MDL +2nd Check	☐	☐
MDL Rework	☐	☐
IMEI Read	☐	☐
STA Write	☐	☐
STA Check	☐	☐
STA Reset	☐	☐
WLAN	☐	☐
GPS	☐	☐
BT	☐	☐
WLAN	☐	☐
Power Off-On before WLAN	☐	☐
Bluetooth	☐	☐
LCIA	☐	☐
Merge 2G3G Block Rad.	☐	☐

Test Condition

Calibration
Real CAL Cycle: on every default CALs

Calibration Mode :

CAL2nd Mode :

Final
Supply RF Signal by

Reset Loss Correction Count

Test Mode :

WLAN
Test Mode :

IMEI
Use RFSM ☐
Use Second PC ☐
Save ODS ☐
Merge Felica Cal ☐
OQC Reset ☐
IBI Reset ☐

System Config.

Language

Line Name

Line Type

☒ Smart Cloud Cell

of Phone

Start Number of UI

Start Number of Jig

IP Address

SKD Mode ☐

MultiSharing(CMWS) ☐

Developer Mode ☐

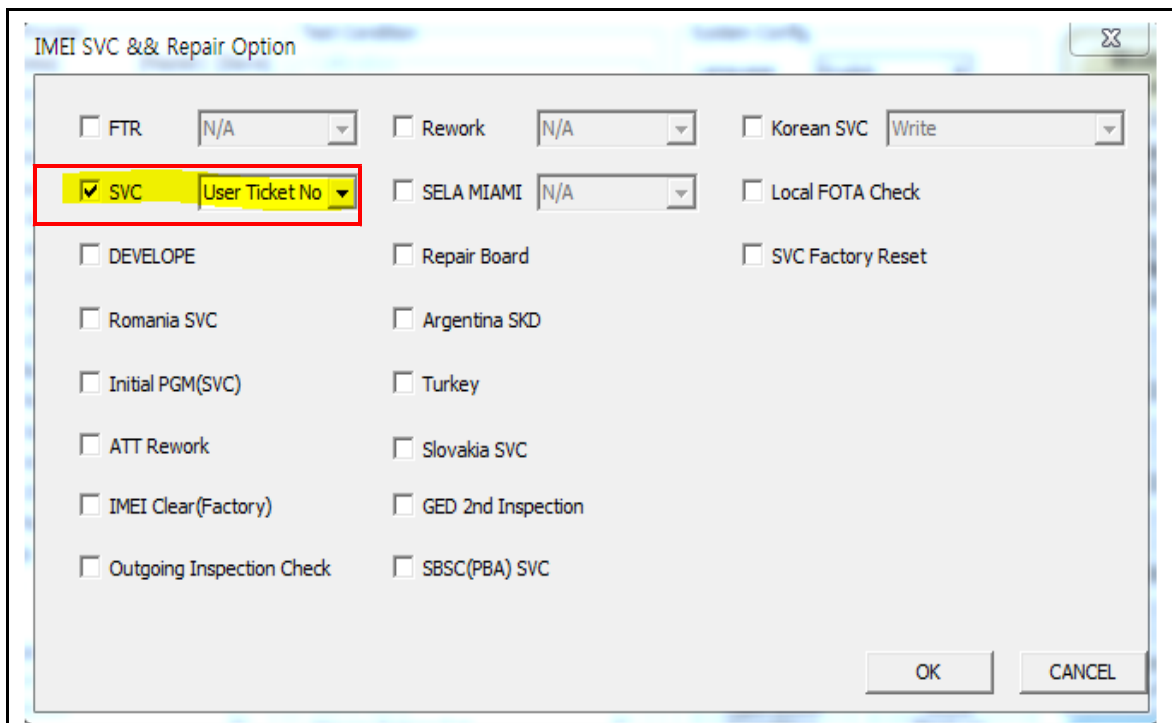
Advanced Separating(ADS) ☐

Operation Condition

Model Information

Process Order

7. Check 'SVC , User Ticket No' and click OK



IMEI SVC & Repair Option

☐ FTR
☐ Rework
☐ Korean SVC

☒ SVC
☐ SELA MIAMI
☐ Local FOTA Check

☐ DEVELOPE
 ☐ Repair Board
 ☐ SVC Factory Reset

☐ Romania SVC
 ☐ Argentina SKD

☐ Initial PGM(SVC)
 ☐ Turkey

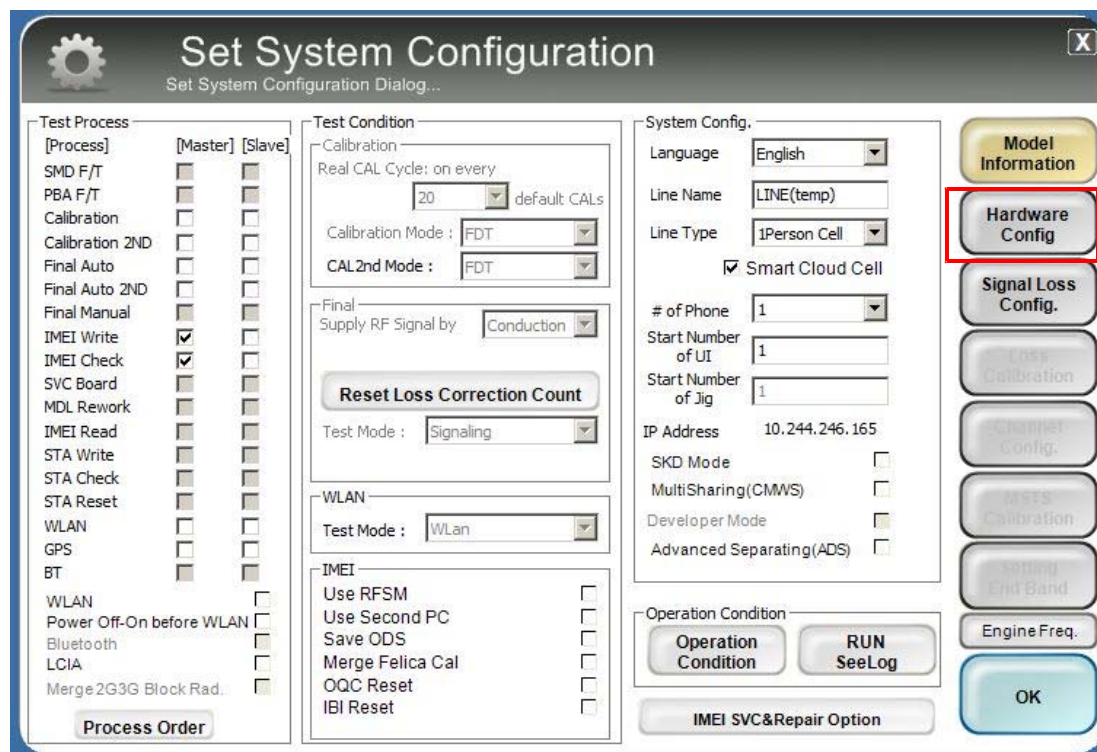
☐ ATT Rework
 ☐ Slovakia SVC

☐ IMEI Clear(Factory)
 ☐ GED 2nd Inspection

☐ Outgoing Inspection Check
 ☐ SBSC(PBA) SVC

OK CANCEL

8. Click 'Hardware Config'



Set System Configuration

Set System Configuration Dialog...

Test Process

[Process]	[Master]	[Slave]
SMD F/T	☐	☐
PBA F/T	☐	☐
Calibration	☐	☐
Calibration 2ND	☐	☐
Final Auto	☐	☐
Final Auto 2ND	☐	☐
Final Manual	☐	☐
IMEI Write	☒	☐
IMEI Check	☒	☐
SVC Board	☐	☐
MDL Rework	☐	☐
IMEI Read	☐	☐
STA Write	☐	☐
STA Check	☐	☐
STA Reset	☐	☐
WLAN	☐	☐
GPS	☐	☐
BT	☐	☐
WLAN	☐	☐
Power Off-On before WLAN	☐	☐
Bluetooth	☐	☐
LCIA	☐	☐
Merge2G3G Block Rad.	☐	☐

Process Order

Test Condition

Calibration

Real CAL Cycle: on every default CALs

Calibration Mode:

CAL2nd Mode:

Final

Supply RF Signal by:

Reset Loss Correction Count

Test Mode:

WLAN

Test Mode:

IMEI

☐ Use RFSM
☐ Use Second PC
☐ Save ODS
☐ Merge Felica Cal
☐ OQC Reset
☐ IBI Reset

System Config.

Language:

Line Name:

Line Type:

☒ Smart Cloud Cell

of Phone:

Start Number of UI:

Start Number of Jig:

IP Address: 10.244.246.165

SKD Mode: ☐

MultiSharing(CMWS): ☐

Developer Mode: ☐

Advanced Separating(ADS): ☐

Operation Condition

IMEI SVC&Repair Option

Model Information

Hardware Config

Signal Loss Config.

Loss Calibration

Channel Config.

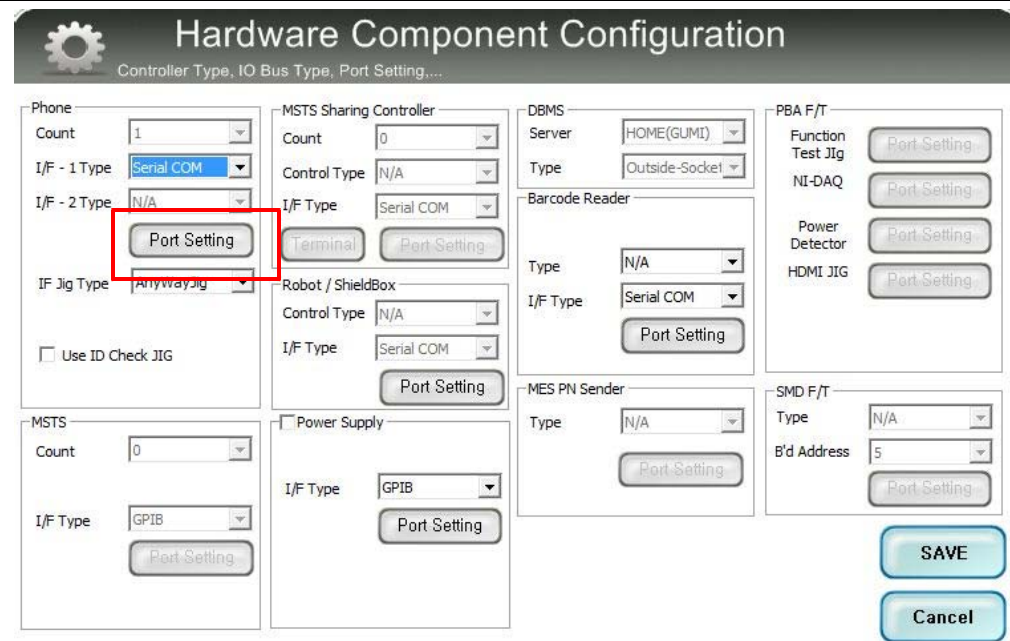
Tests Calibration

Setting End Band

Engine Freq.

OK

9. Click 'Port Setting'



Hardware Component Configuration
Controller Type, IO Bus Type, Port Setting,....

Phone
Count: 1
I/F - 1 Type: Serial COM
I/F - 2 Type: N/A
IF Jig Type: AnywayJig
☐ Use ID Check JIG

MSTS Sharing Controller
Count: 0
Control Type: N/A
I/F Type: Serial COM
Terminal: Port Setting

DBMS
Server: HOME(GUMI)
Type: Outside-Socket

Barcode Reader
Type: N/A
I/F Type: Serial COM
Port Setting

MES PN Sender
Type: N/A
Port Setting

PBA F/T
Function Test Jig: Port Setting
NI-DAQ: Port Setting
Power Detector: Port Setting
HDMI JIG: Port Setting

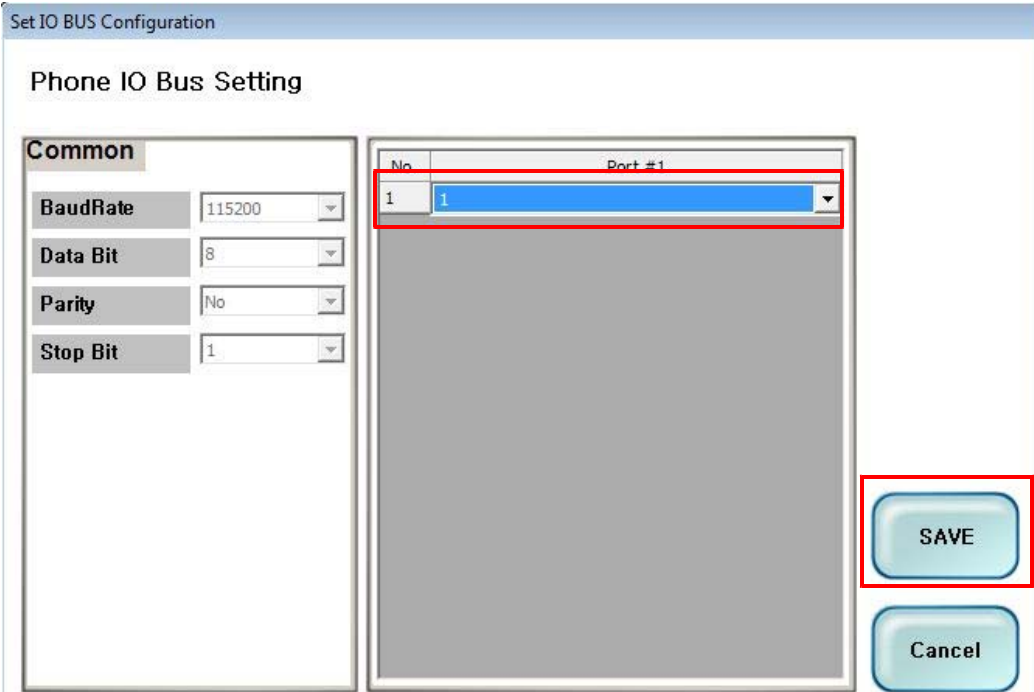
MSTS
Count: 0
I/F Type: GPIB
Port Setting

Power Supply
I/F Type: GPIB
Port Setting

SMD F/T
Type: N/A
B'd Address: 5
Port Setting

SAVE
Cancel

10. Select Port Number and SAVE



Set IO BUS Configuration

Phone IO Bus Setting

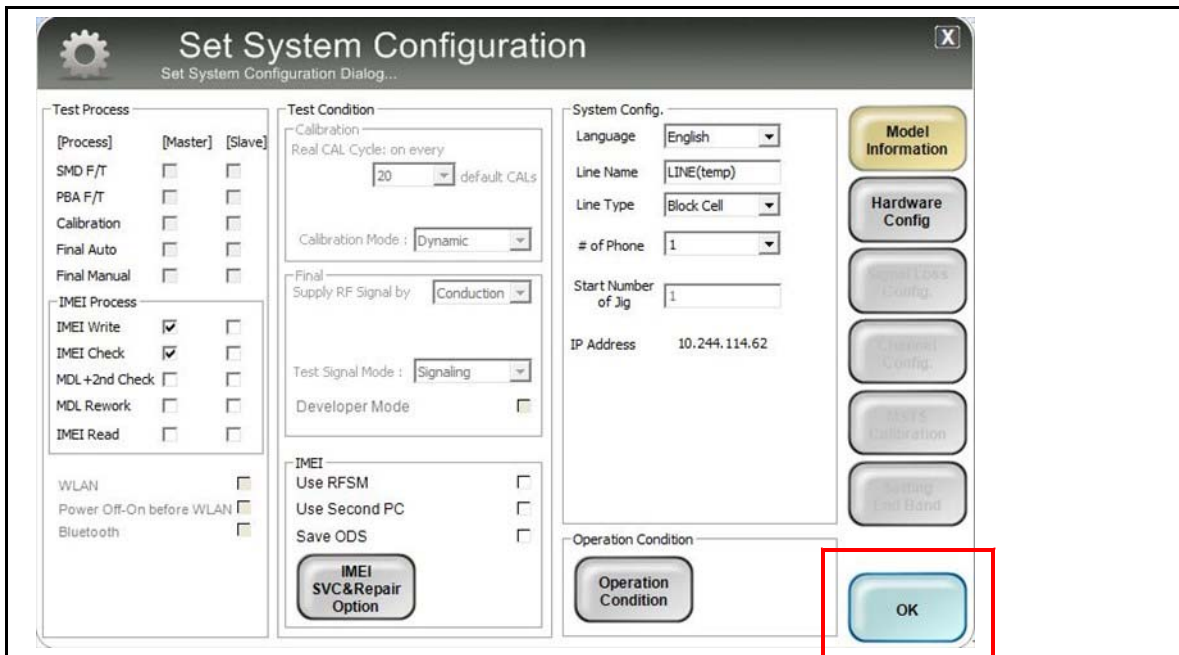
Common

BaudRate: 115200
Data Bit: 8
Parity: No
Stop Bit: 1

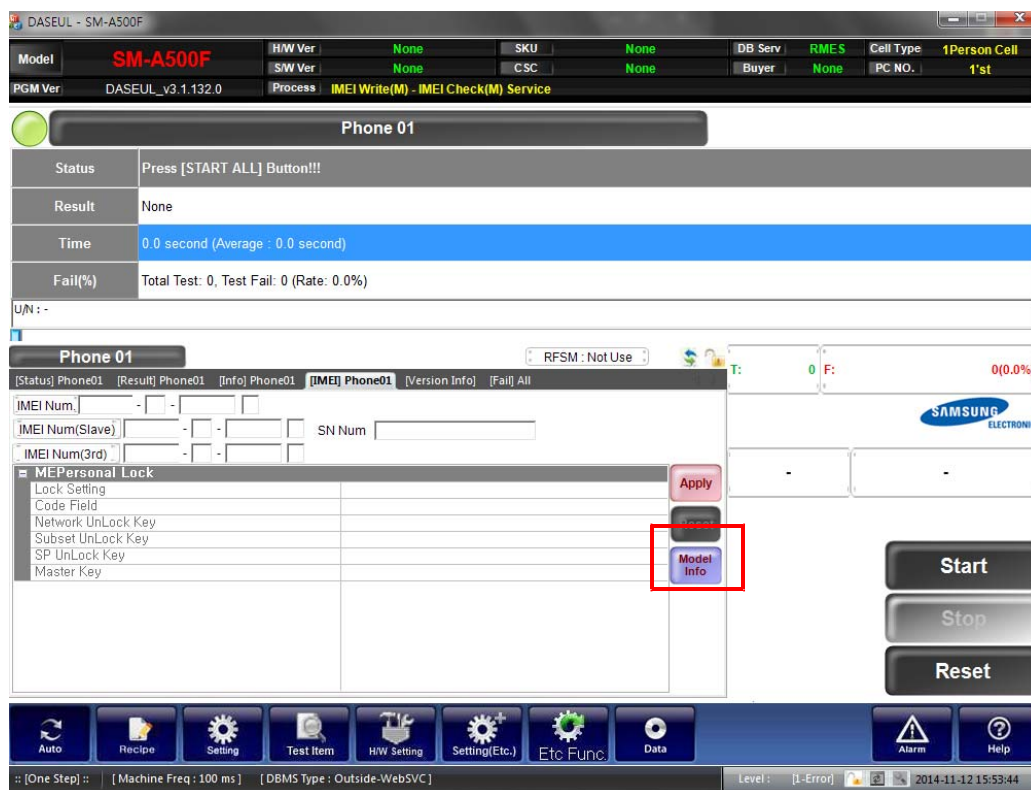
No.	Port #1
1	1

SAVE
Cancel

11. Click OK to proceed



12. Click Model Info and OK when pop-up shows

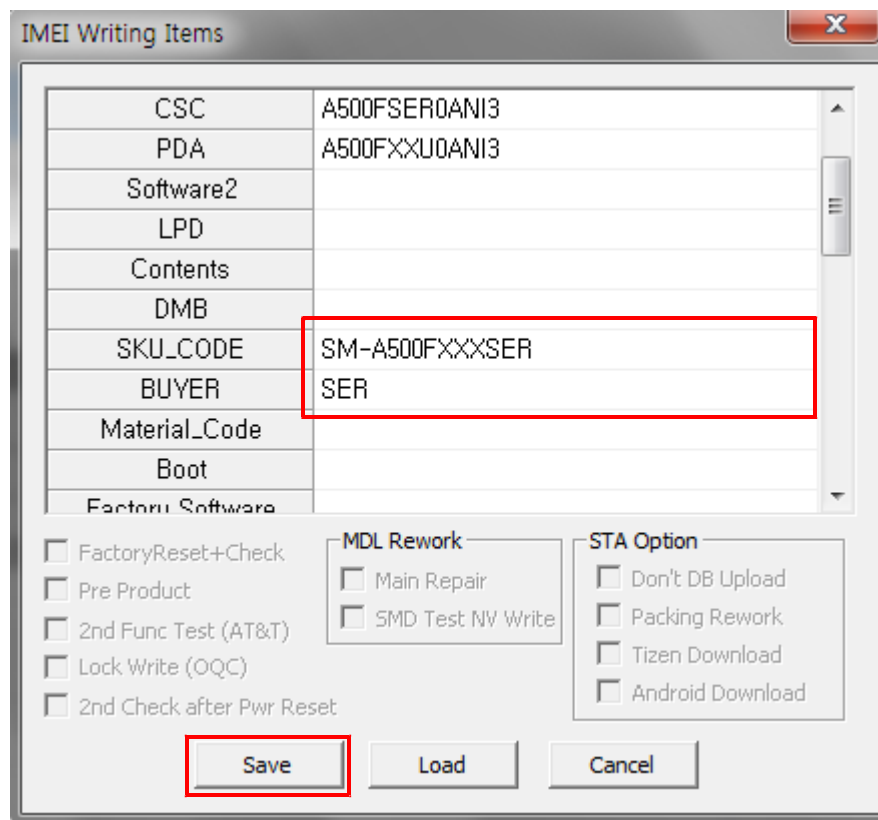


13. Click OK



14. Input SKU_CODE and BUYER, then click Save button.

※ Refer to HHPsvc→IMEI Review to check SKU Code and buyer



15. Input IMEI Number and click Apply

The screenshot shows the 'Phone 01' configuration screen in the DASEUL software. At the top, a status bar displays model information: Model SM-A500F, HW Ver A500F.03, SKU SM-A500FXXXSER, DB Serv HOME(GUMI), Cell Type 1Person Cell, PGM Ver DASEUL_v3.1.132.0, and Process IMEI Write(M) - IMEI Check(M) Service. Below this, a table shows test results: Status Wait End of Prior Test., Result None, Time 0.0 second (Average : 0.0 second), and Fail(%) Total Test: 0, Test Fail: 0 (Rate: 0.0%). The 'Phone 01' section contains input fields for IMEI Num (359973 - 06 - 013273 - 4), IMEI Num(Slave), IMEI Num(3rd), and SN Num. A red box highlights the 'Apply' button next to the IMEI Num field. Other buttons like 'Reset', 'Model Info', 'Start', 'Stop', and 'Pause' are also visible. The bottom toolbar includes icons for Auto, Recipe, Setting, Test Item, HW Setting, Setting(Etc.), Etc Func, and Data.

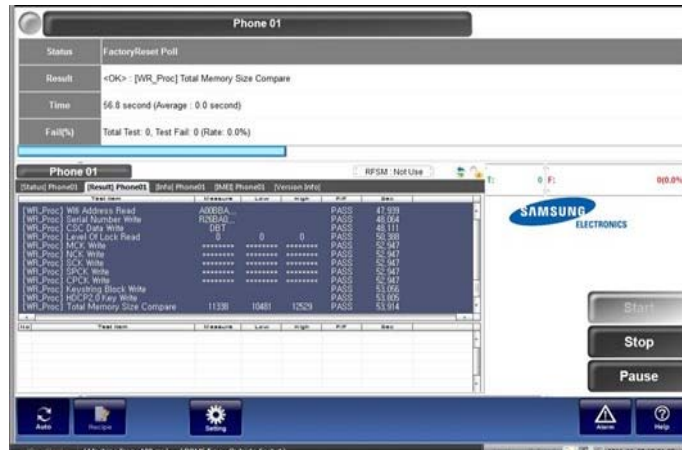
16. ① Click Start, and input IMEI writing ID and Password → ② input Ticket No

The screenshot shows the 'Phone 01' configuration screen with a 'User Login' dialog box overlaid. The dialog box has fields for 'User ID' (sj1305.kang) and 'Password' (masked with asterisks), and a 'Login' button. A red box highlights the 'Start' button on the main interface, which is located below the 'Reset' button. The background interface shows the same test results and input fields as in step 15. The bottom toolbar and status bar are also visible.

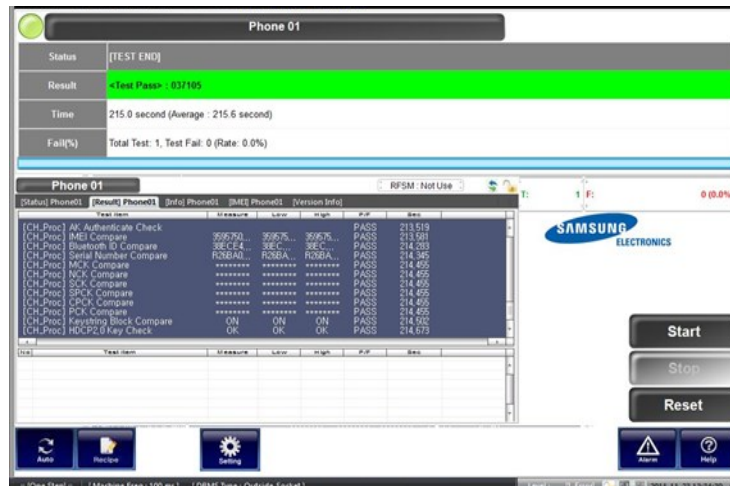
17. Connect the phone to Anyway JIG

- ※ When you connect the phone, the phone should be turned off.
After connecting the phone, the phone will be booted automatically.

18. IMEI Writing Proceeding



19. IMEI Writing Success



6-3. Boot Recovery

6-3-1. Symptom

- No Power on, Unable to enter download mode.

6-3-2. Coverage

- The device which get damaged for bootloader.

6-3-3. Required items in order to do Boot Recovery

- Downloader Program ([Odin3 v3.09.3.exe](#))
- SM-A500F Mobile Phone(Normal device)
- Data Cable
- Micro SD Card (Higher than SDHC type and 4GB)
- Full S/W binary(pit, BL, AP, CP)
- Recovery pit file and bootloader
 - pit file: A53G_EUR_OPEN.pit
 - boot loader: normal bootloader(BL)

6-3-4. Brief process for Boot Recovery

1. Download recovery pit and bootloader to SD card by using normal device
2. Insert SD card to no power device and try to enter download mode.
3. Download full S/W to the defected device

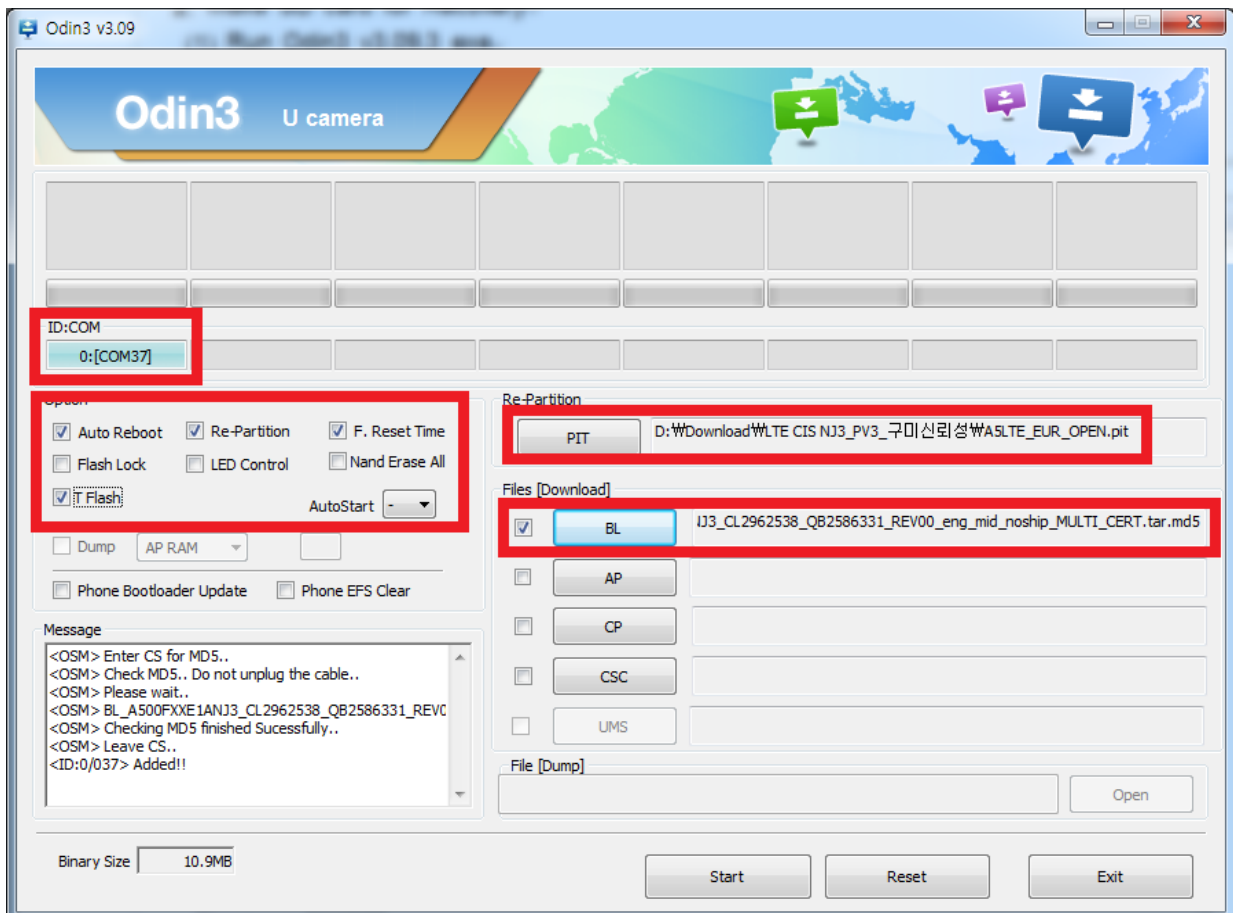
6-3-5. Process of Boot Recovery

1. SW download

- (1) Download full S/W(BL, AP, CP, CSC) to normal device.

2. Make SD card for Recovery

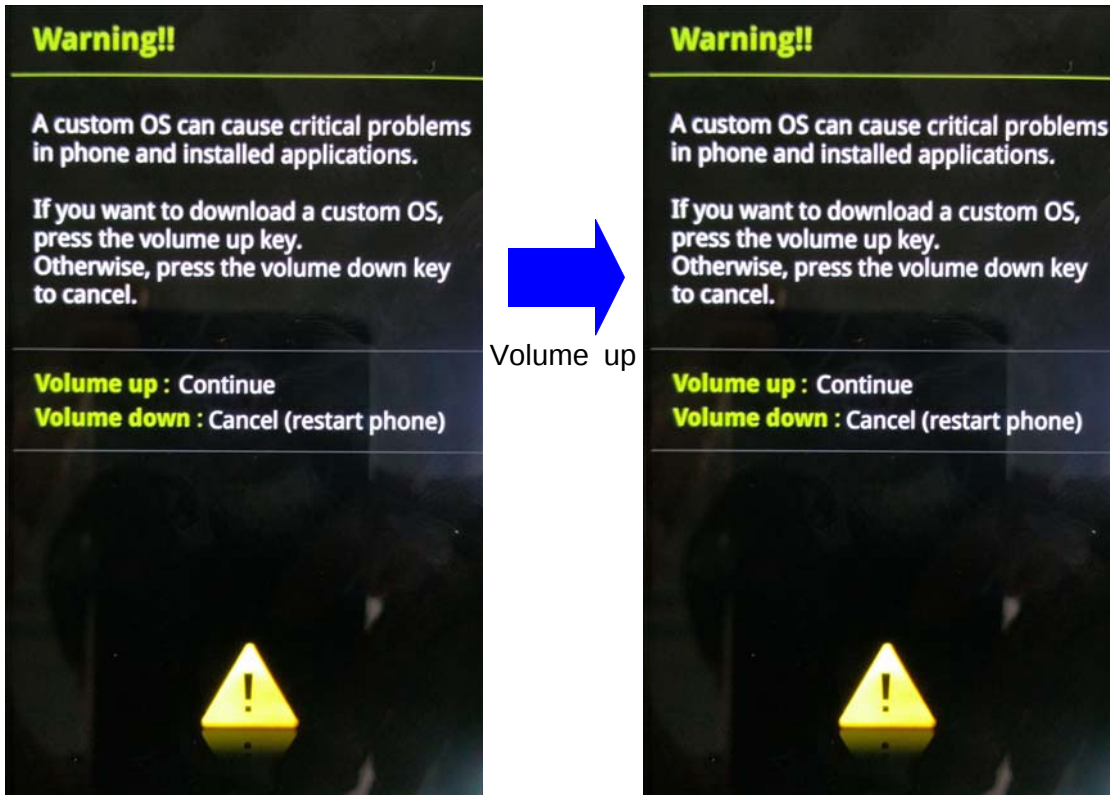
- (1) Run Odin3 v3.09.3 exe
- (2) Load "A53G_EUR_OPEN.pit" in PIT tap and "normal bootloader file" in BL tap.
- (3) Check "T-Flash" option
- (4) Insert SD card to normal device and enter to download mode.
- (5) Connect the device to PC



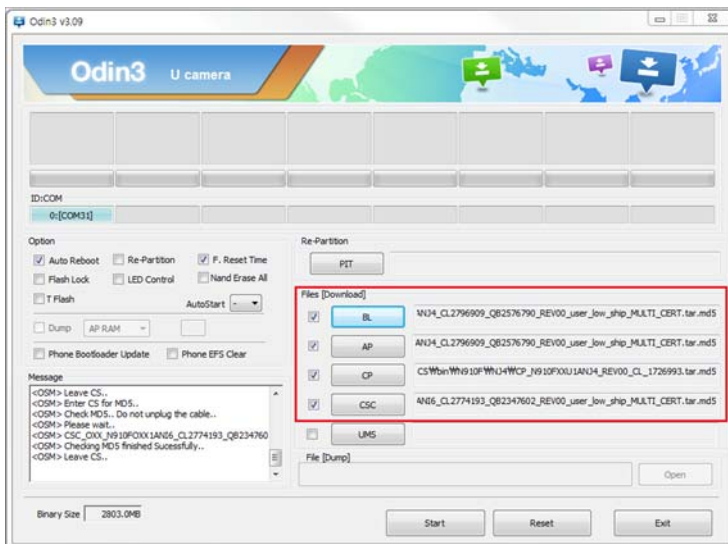
- (6) Click "Start" button to download Recovery pit and bootloader files to SD card.
 - If it is **Pass**, SD card has successfully made for boot recovery.
 - If it is **Fail**, try to this with another SD card.(It would be defect of SD card)

3. Boot Recovery for damaged device

- (1) Insert SD card to "No power" device
- (2) Enter to download mode, using key combination(Volume down + Home + Power)
- (3) If the device is successfully recovered, the device will enter download mode.



- (4) After entering download mode, download full S/W to the device including BL(Bootloader), AP(Platform binary), CP(Modem binary) and CSC.



6-4. RF Calibration

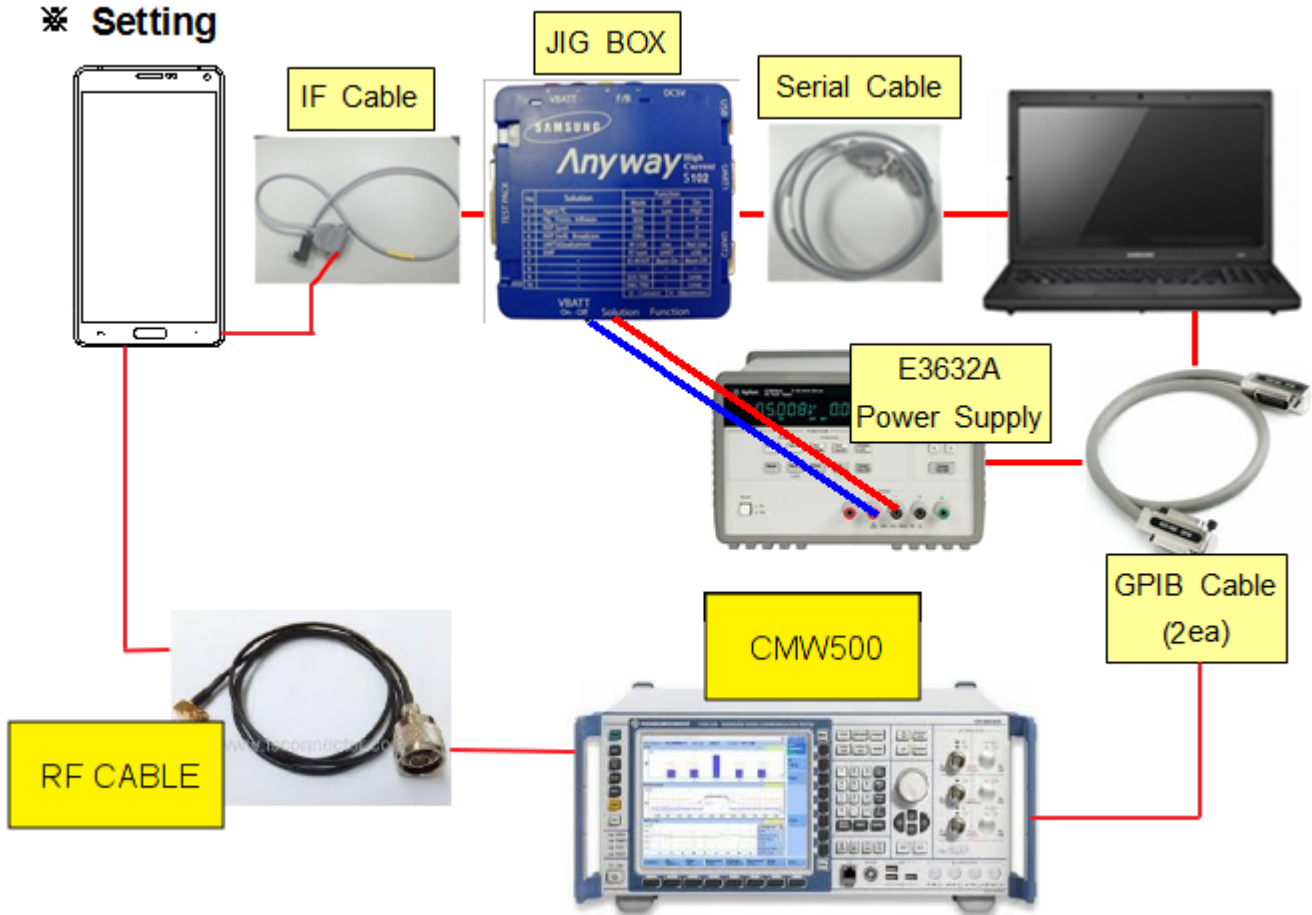
6-1-1. Required items in order to calibrate RF

- Installation program: RF Calibration Program
 - Daseul_Launcher_vx.x.xx.exe
 - Daseul_CAL_ALL_Runtime_x.x.xxx.x.CAB
 - Model File (SM-A500H_OPEN_CALIBRATION_VER_x.x.xxx.xx.CAB)

※ It is required to use the latest program.

- SM-A500 Mobile Phone
- E3632A Power Supply
- JIG BOX (GH81-11888A)
- Adapter (GH81-11888K)
- 1.6T RF Cable (GH81-11456A, 1ea)
- R&S CMW500
- GPIB Cable (2ea)
- IF Cable (GH81-10631A)
- UART Serial Cable

※ Setting

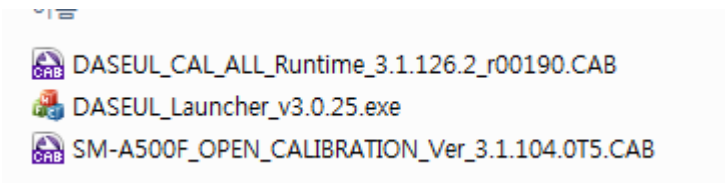


- Table of test cables

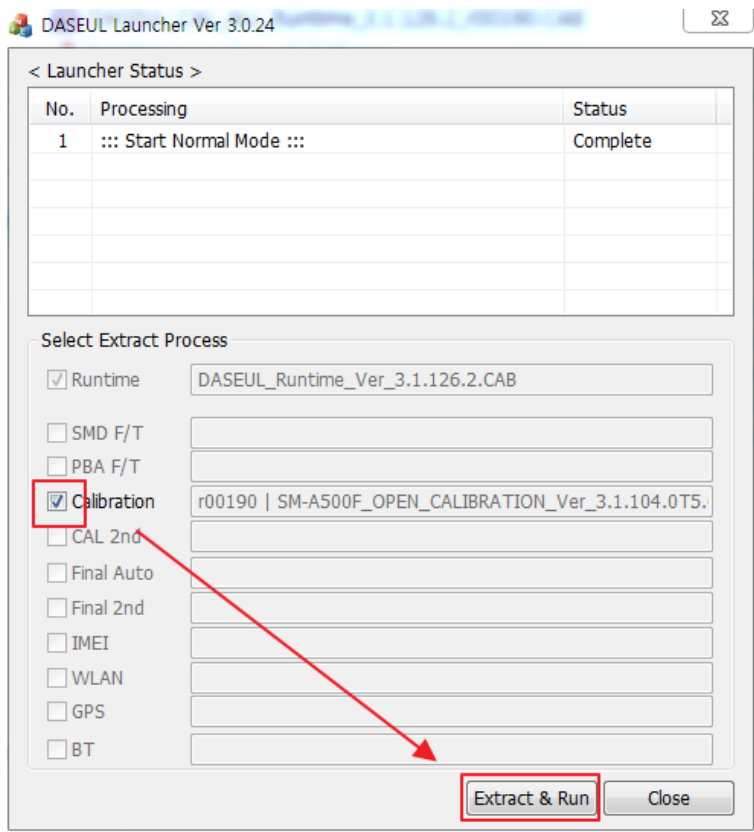
IF Cable	GH81-10631A	GH81-10952A	GH81-11171A	
	11 pin	7 pin (New)	7 pin (Old)	
RF Cable	GH81-11962D	GH81-11962G	GH81-11962C	GH81-11456A
	1.35T, Short	1.35T, Long	1.6T, Short	1.6T, Long
4 Port Divider	GH81-11962A			
	Use / No use			

6-1-2. RF Calibration Program

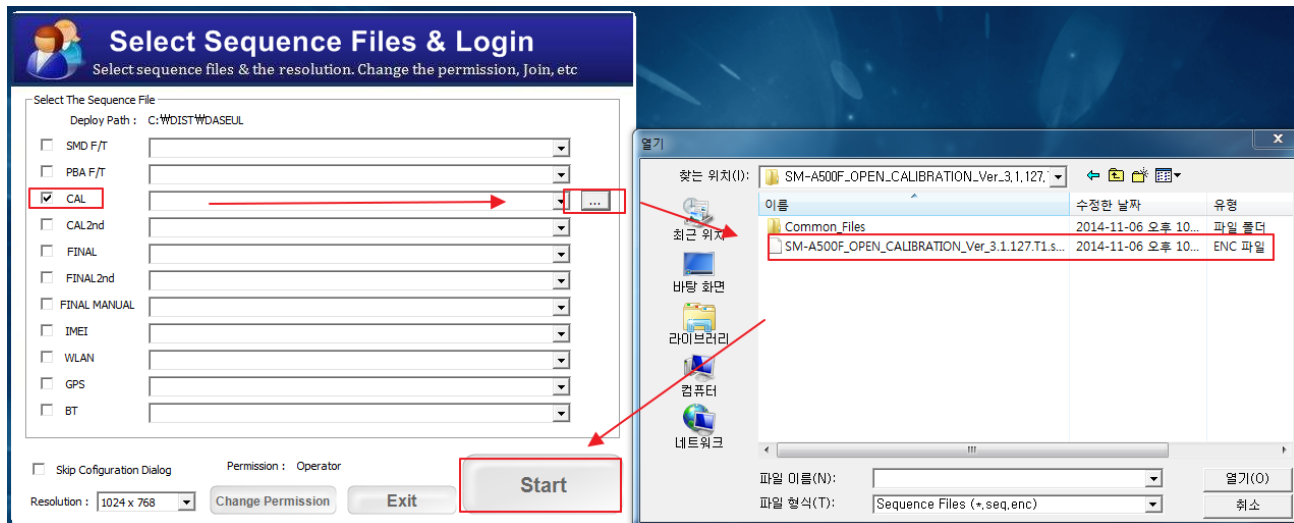
- Run the RF Calibration Program Launcher, '[DASEUL_Launcher_vx.x.xx.exe](#)'.



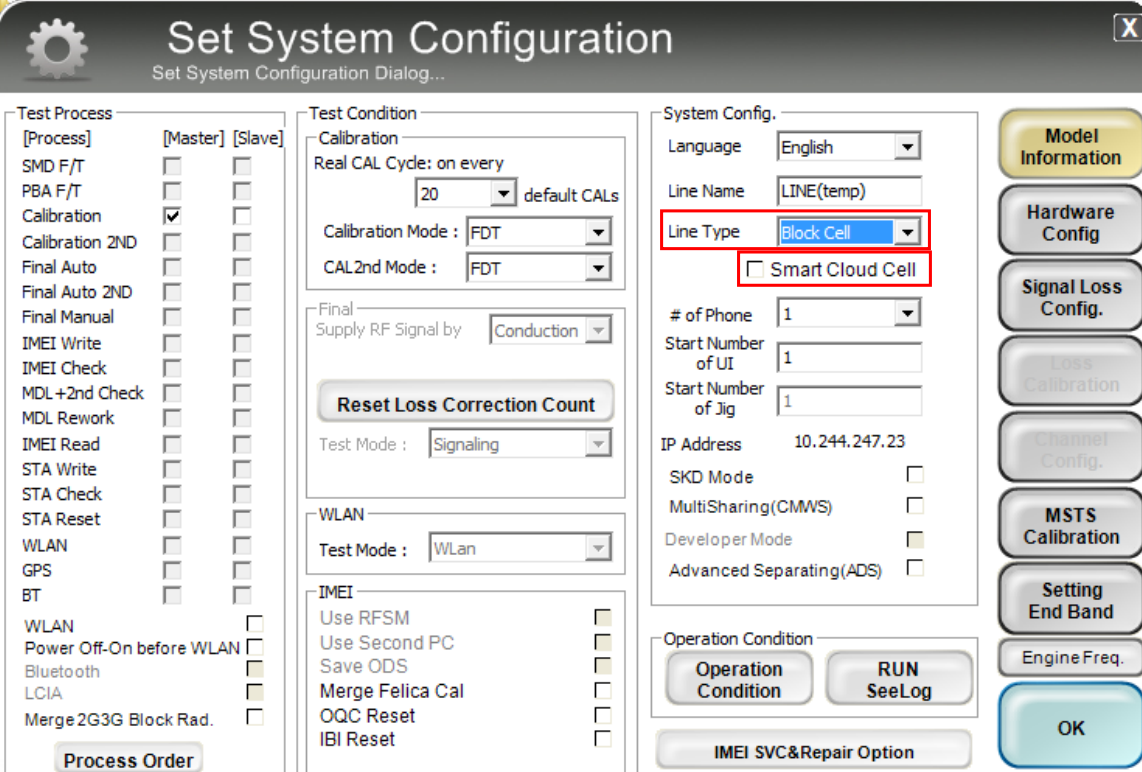
- Check the '[Calibration](#)' menu, and select '[Extract & Run](#)'.



3. Check the 'CAL' and open the [model file](#), then select 'Start' button.



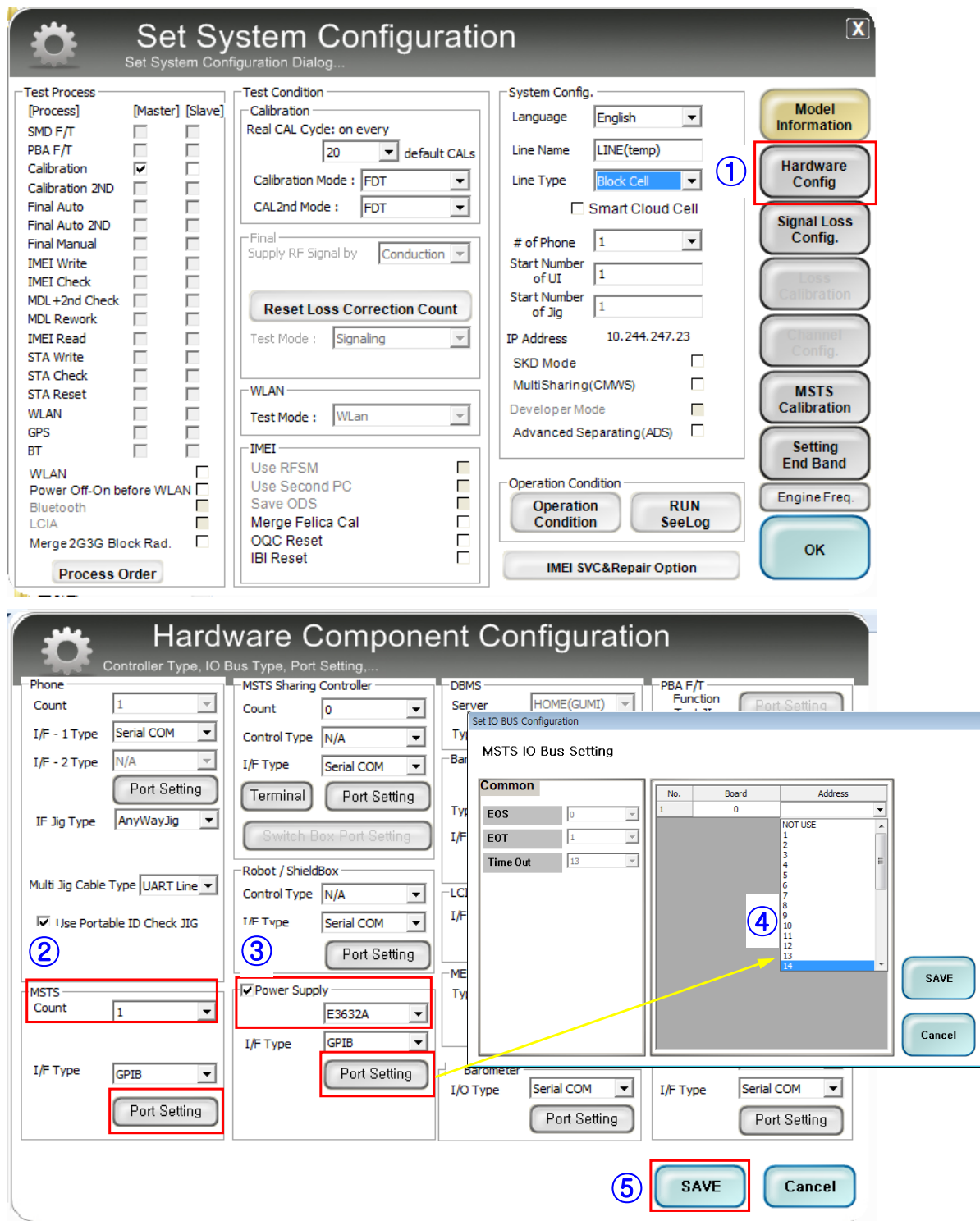
4. Change the Line Type to 'Block Cell' and disable 'Smart Cloud Cell'.



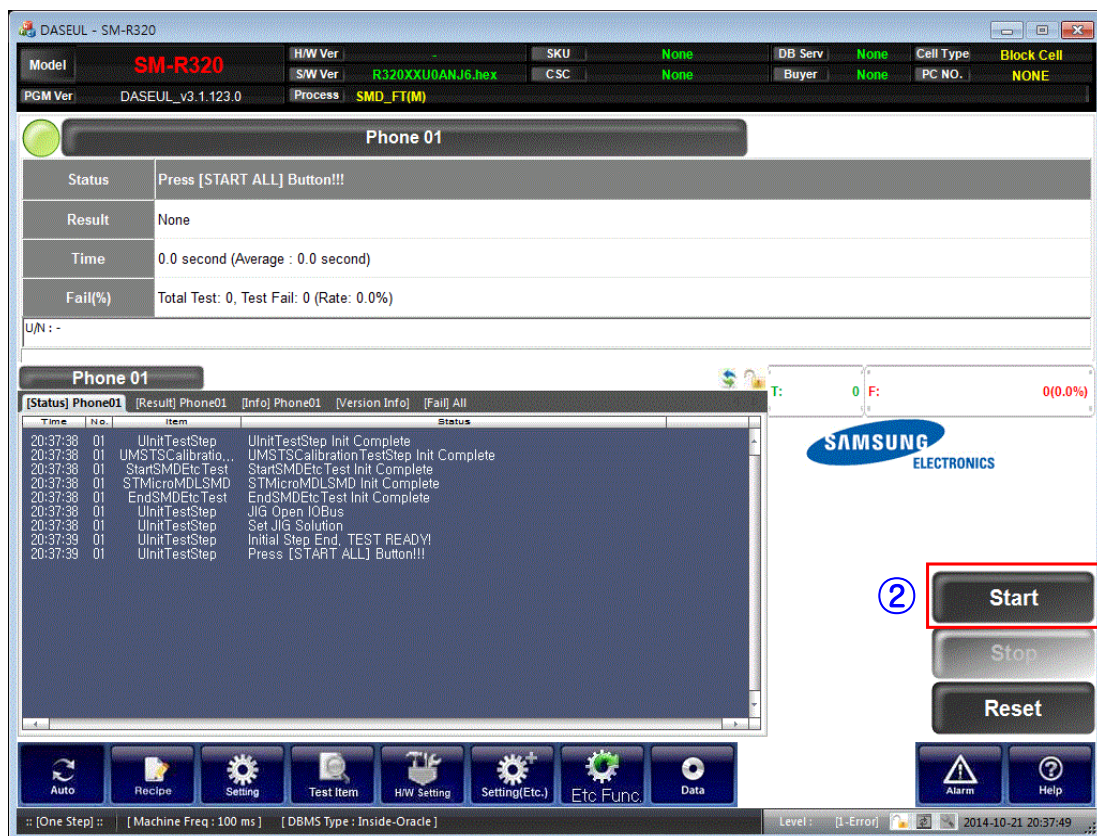
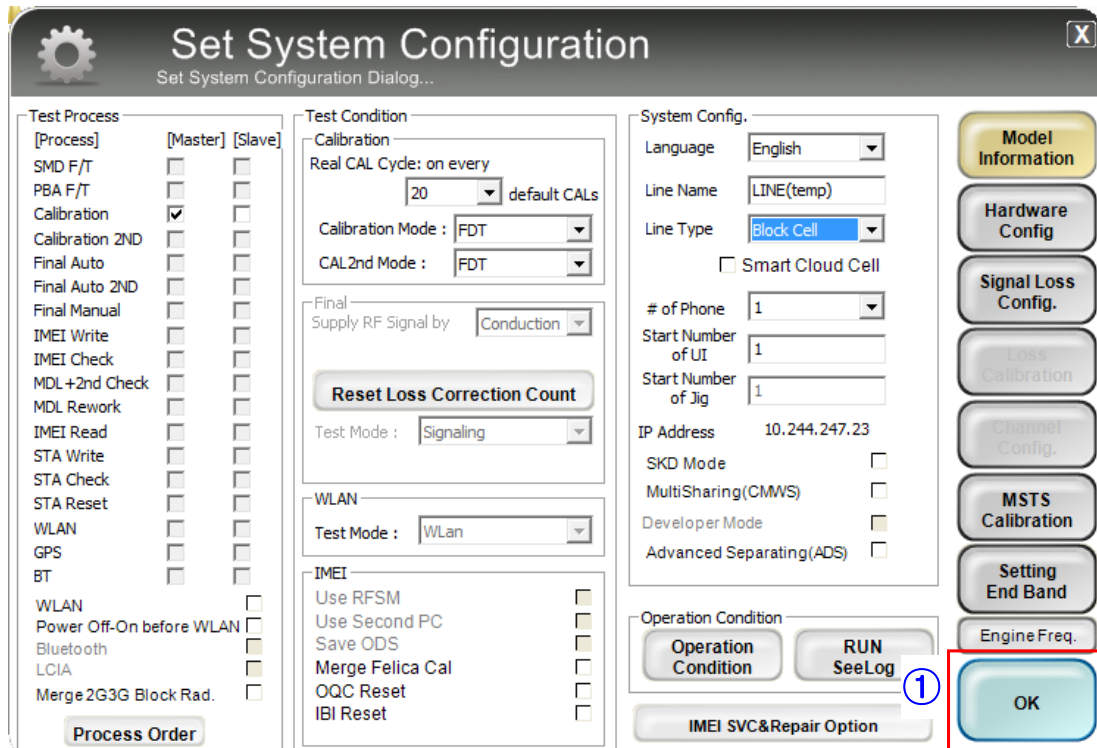
The image shows a 'Set System Configuration' dialog box with a title bar and a close button (X). The dialog is divided into several sections:

- Test Process:** A list of test processes with checkboxes for [Process], [Master], and [Slave]. The 'Calibration' checkbox is checked under [Process].
- Test Condition:** Includes 'Calibration' settings (Real CAL Cycle: on every 20, default CALs), 'Calibration Mode' (FDT), 'CAL2nd Mode' (FDT), 'Final Supply RF Signal by' (Conduction), 'Reset Loss Correction Count' button, 'Test Mode' (Signaling), 'WLAN Test Mode' (Wlan), and 'IMEI' settings (Use RFSM, Use Second PC, Save ODS, Merge Felica Cal, OQC Reset, IBI Reset).
- System Config.:** Includes 'Language' (English), 'Line Name' (LINE(temp)), 'Line Type' (Block Cell), 'Smart Cloud Cell' (unchecked), '# of Phone' (1), 'Start Number of UI' (1), 'Start Number of Jig' (1), 'IP Address' (10.244.247.23), 'SKD Mode' (unchecked), 'MultiSharing(CMWS)' (unchecked), 'Developer Mode' (unchecked), and 'Advanced Separating(ADS)' (unchecked).
- Operation Condition:** Includes 'Operation Condition' button, 'RUN SeeLog' button, and 'IMEI SVC&Repair Option' button.
- Model Information:** A vertical stack of buttons: Model Information, Hardware Config, Signal Loss Config., Loss Calibration, Channel Config., MSTs Calibration, Setting End Band, Engine Freq., and OK.

5. Set the GPIB address of MSTS(CMW500) and Power Supply(E3632A) to enter 'Hardware Config' and 'Save'. (Check the GPIB address of equipments in advance)



6. Press 'OK' to start RF Calibration after completing all settings.



8. Level 3 Repair

9-1. Battery Replacement

→ Whenever the battery should be changed from broken one to new one, "Battery accumulation usage-amount initialization" should be done like below.

9-1-1. Required items in order to repair battery

- SM-A500F/G/H Mobile Phone
- SM-A500F/G/H Battery
- PC
- JIG BOX (GH81-11888A)
- JIG Cable (GH81-10952A)
- Serial Cable

※ Settings



Connect ANYWAY JIG
with JIG CABLE (Phone to JIG)
and PC to Anyway JIG Using Serial cable



9-1-2. Battery replacement procedure.

- To Be Determined soon.

9-1. Speaker module Replacement

→ Whenever speaker module should be changed from broken one to new one, "SPK calibration" should be done like below.

9-1-1. Required items in order to repair speaker module

- SM-A500F/G/H Mobile Phone
- SM-A500F/G/H Speaker module
- PC
- Earphone
- JIG BOX (GH81-11888A)
- JIG Cable (GH81-10952A)
- Serial Cable



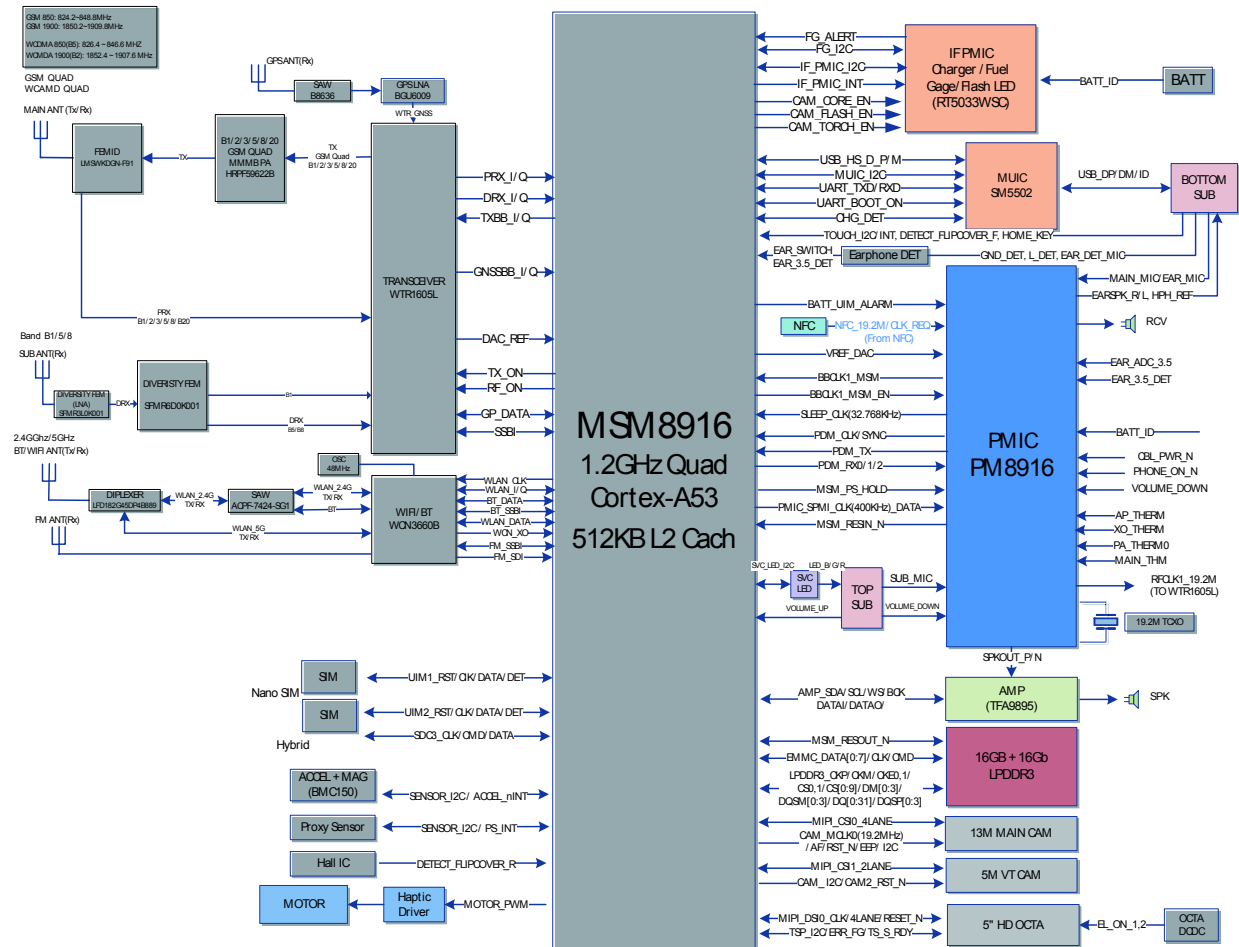
Connect ANYWAY JIG
with JIG CABLE (Phone to JIG)
and PC to Anyway JIG Using Serial cable



9-1-2. Speaker module replacement procedure.

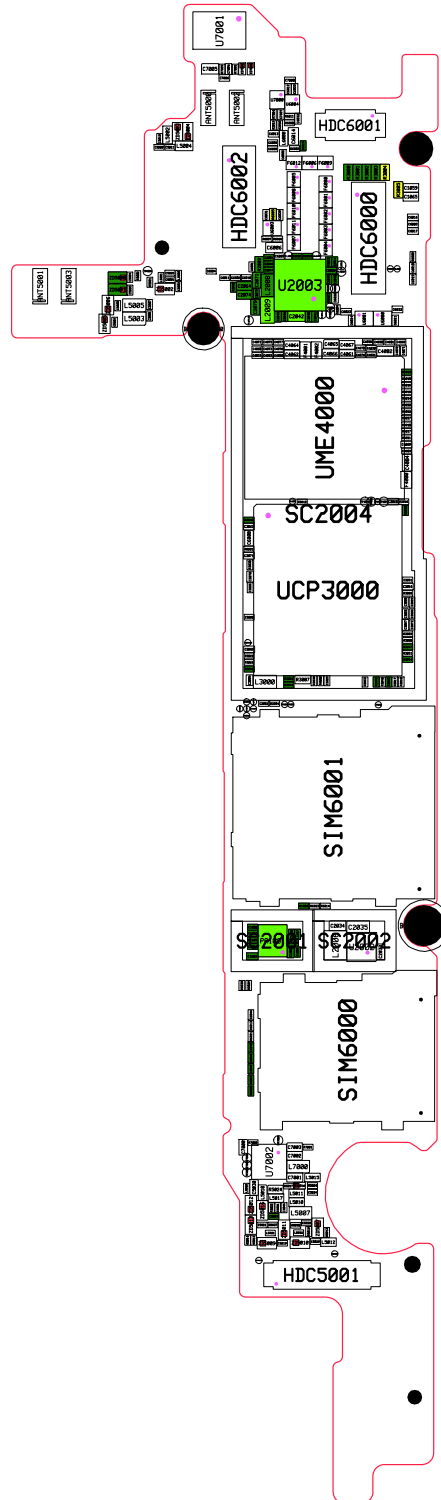
- To Be Determined soon.

8-1. Block Diagram

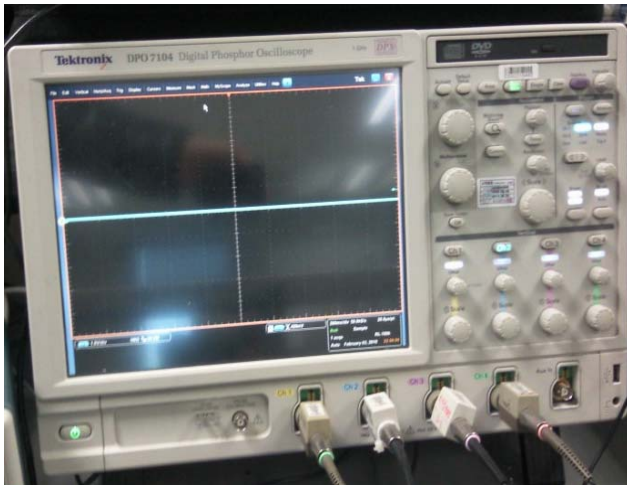


8-2. PCB Diagrams

8-2-1. Main PCB Top



8-2-3. Equipments



↑ Oscilloscope



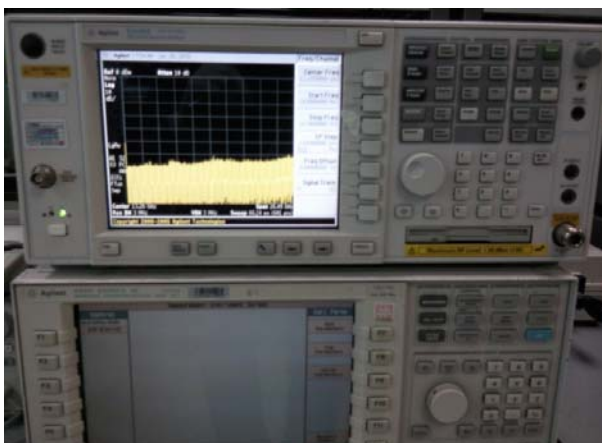
↑ Digital Multimeter



↑ Power Supply



↑ + driver, ESD Safe Tweezer



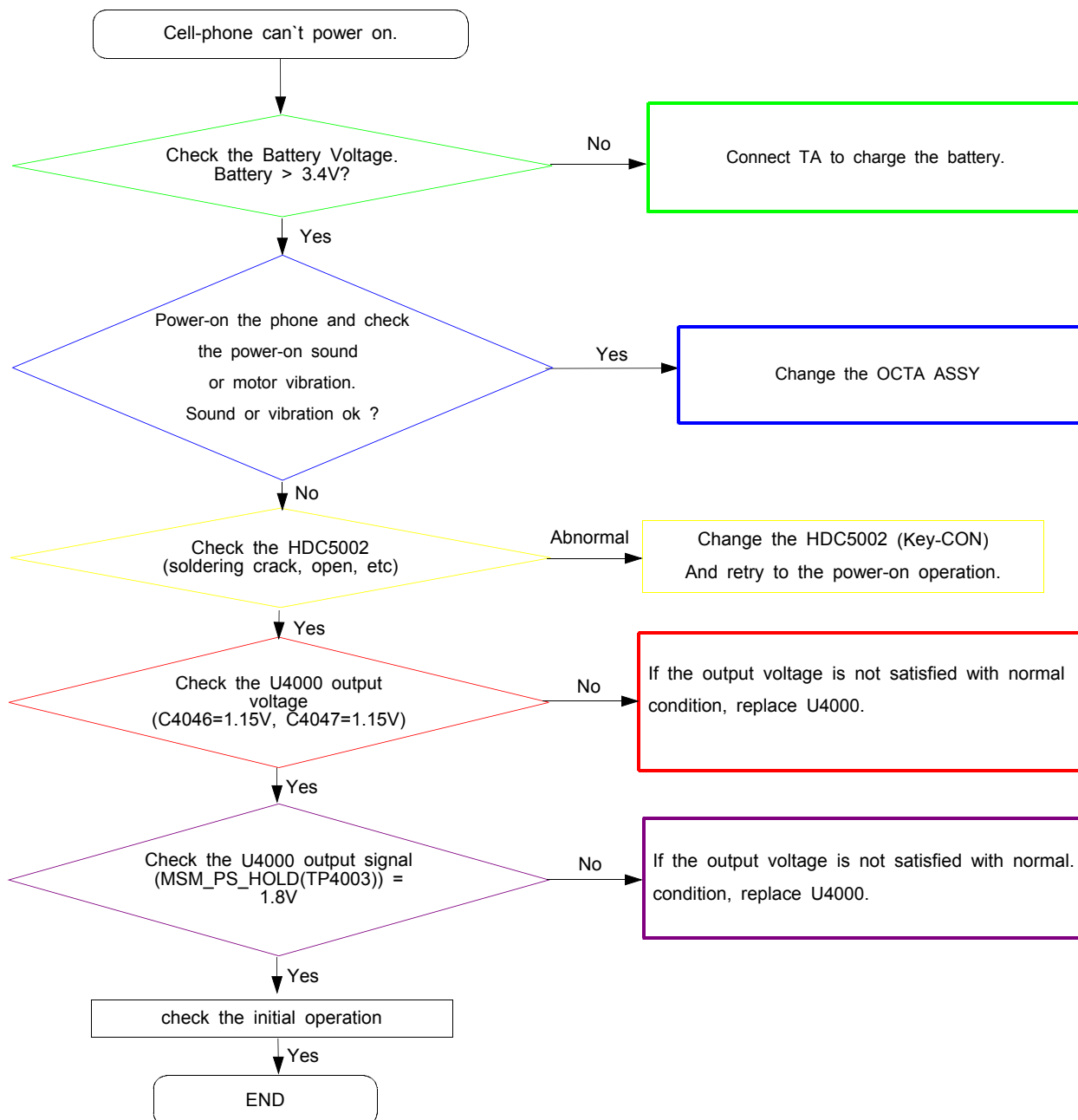
↑ 8960 & Spectrum Analyzer

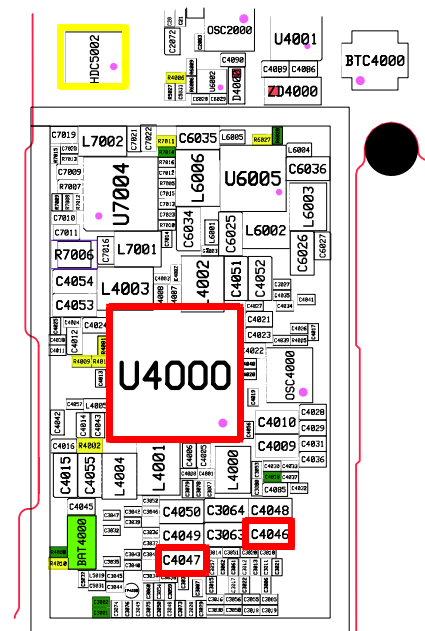


↑ Soldering iron

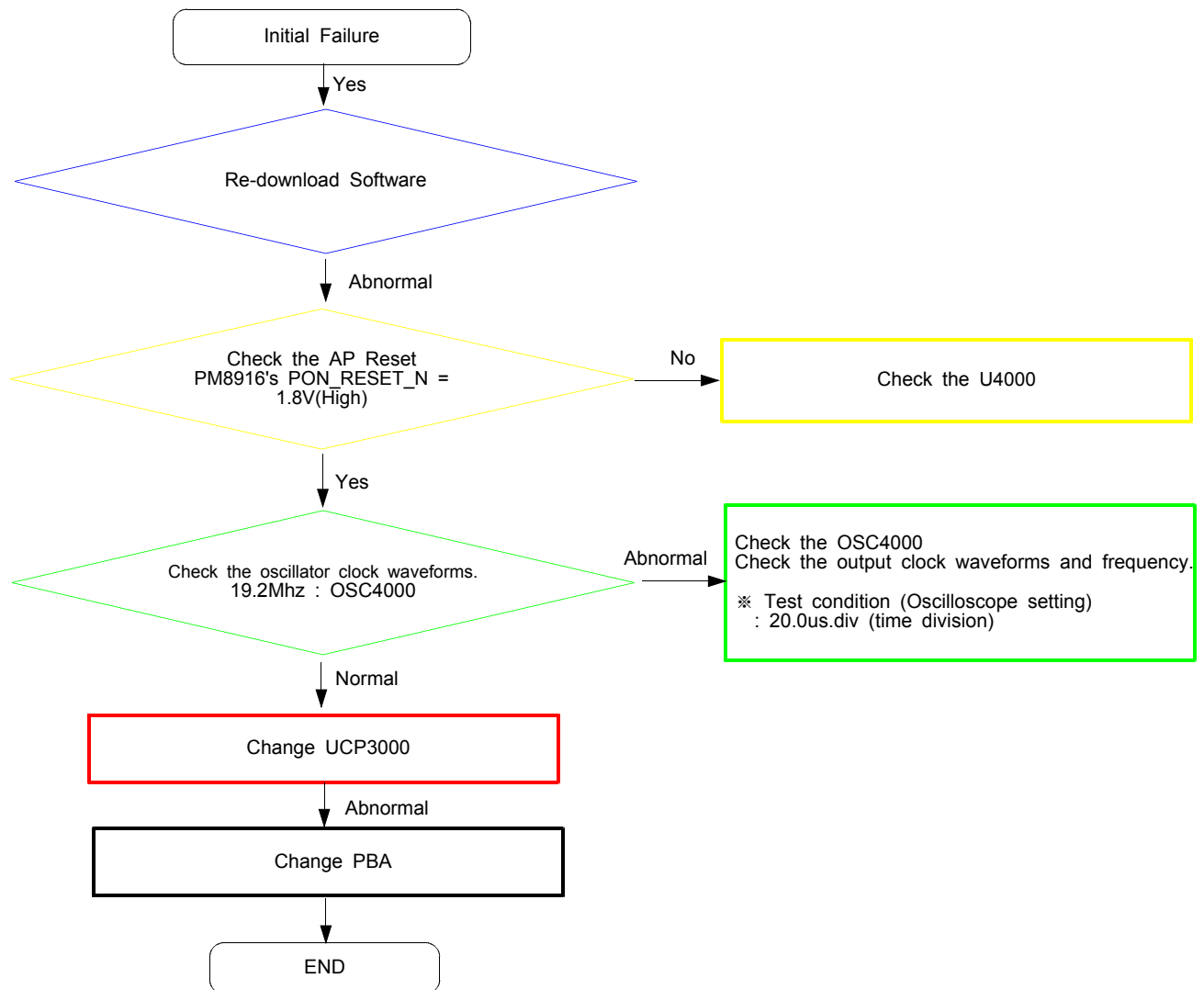
8-3. Flow Chart of Troubleshooting

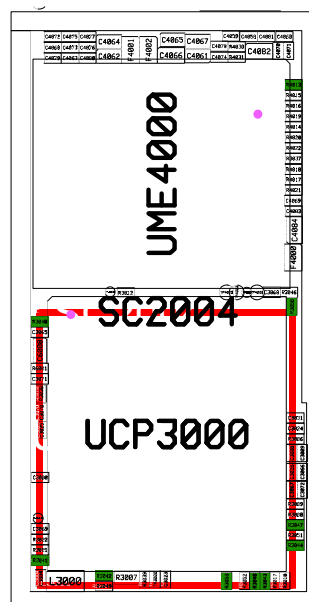
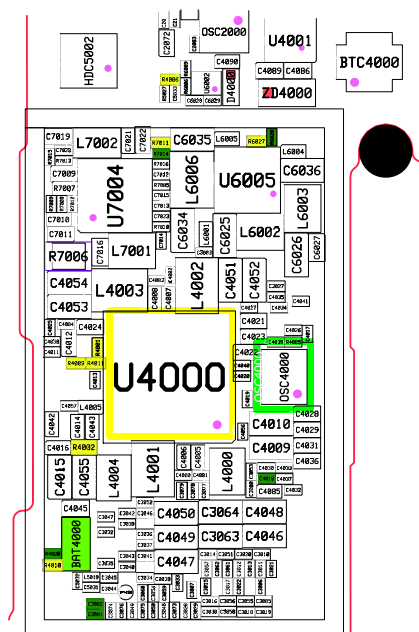
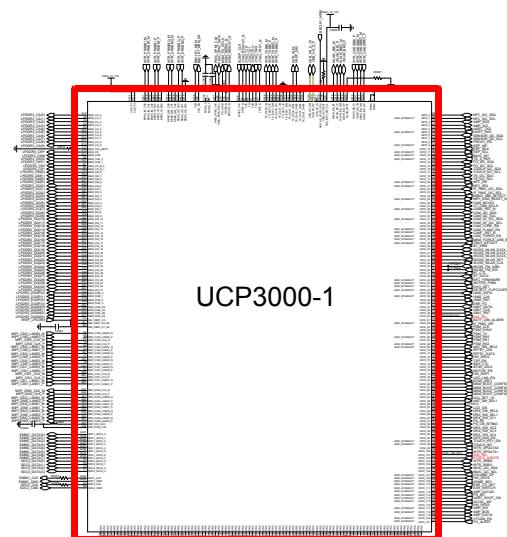
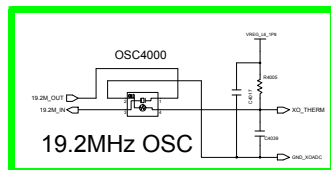
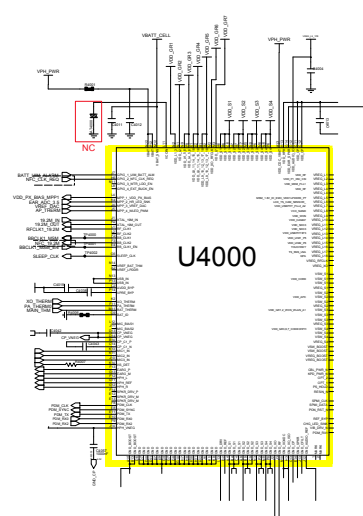
8-3-1. Power On



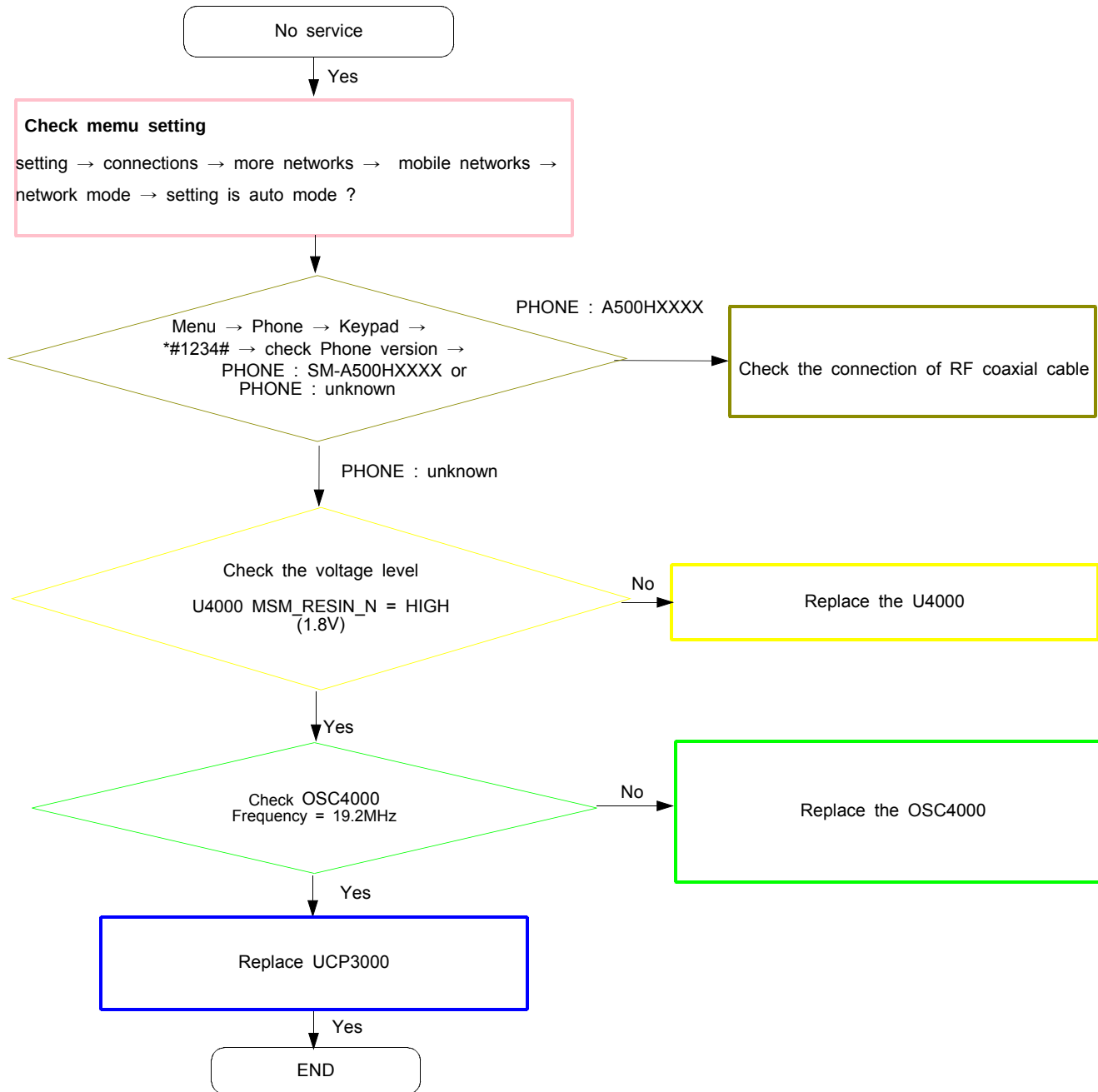


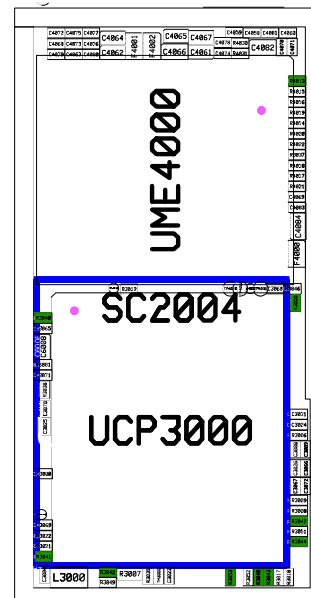
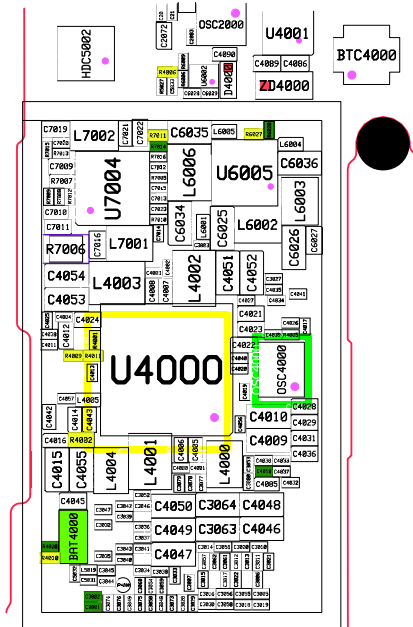
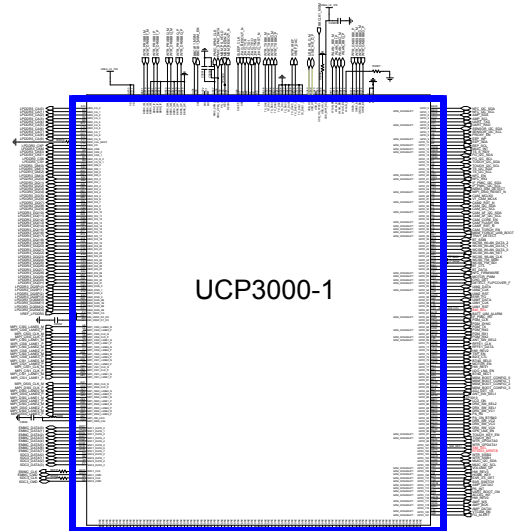
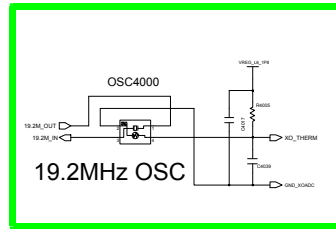
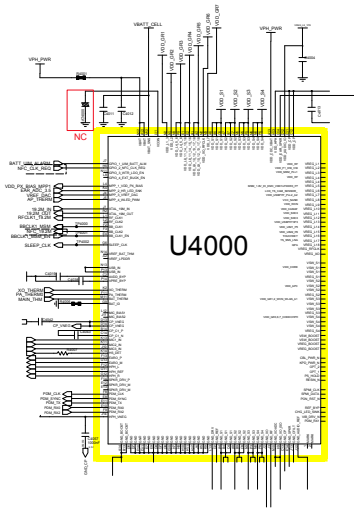
8-3-2. Initial



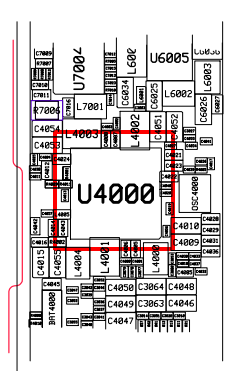
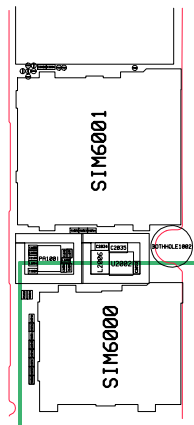
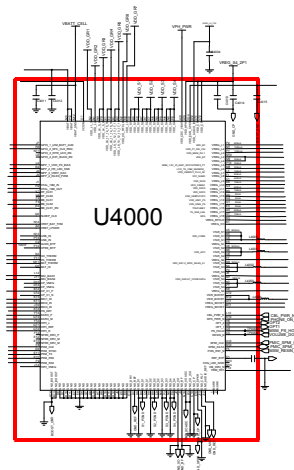
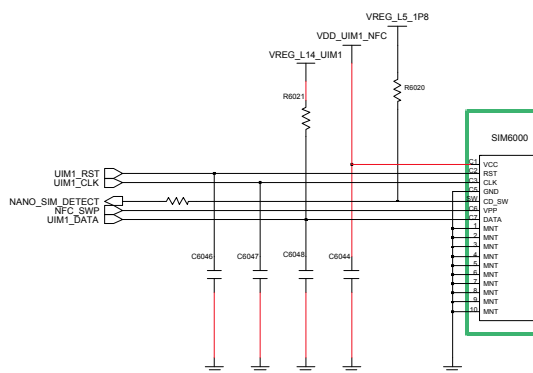
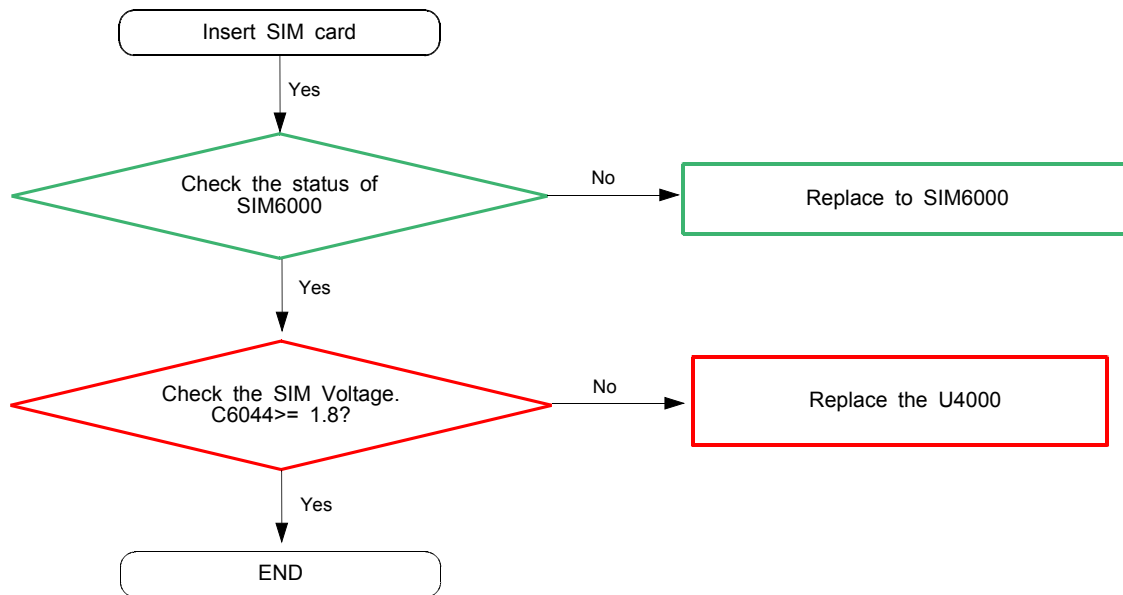


8-3-3. No Service

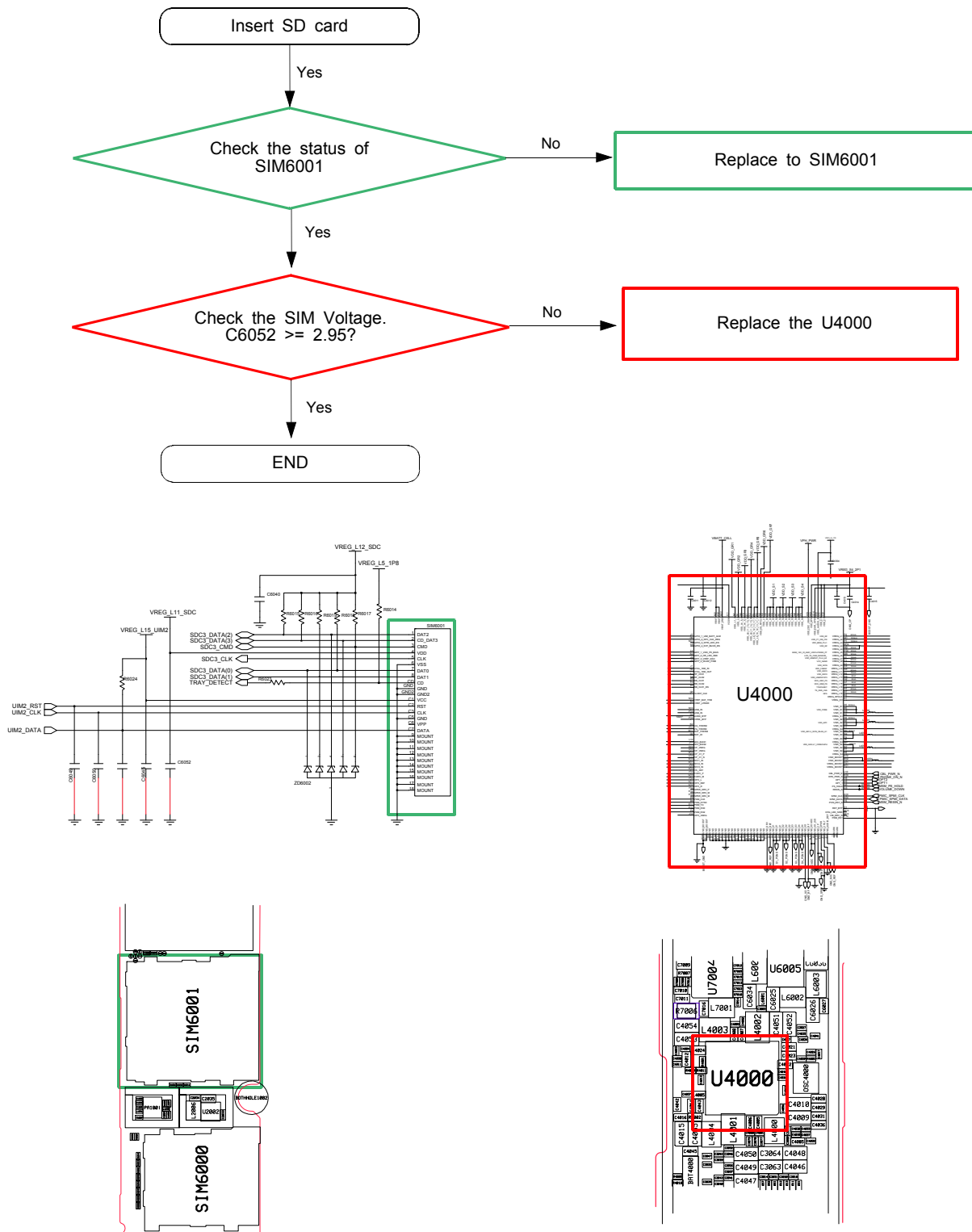




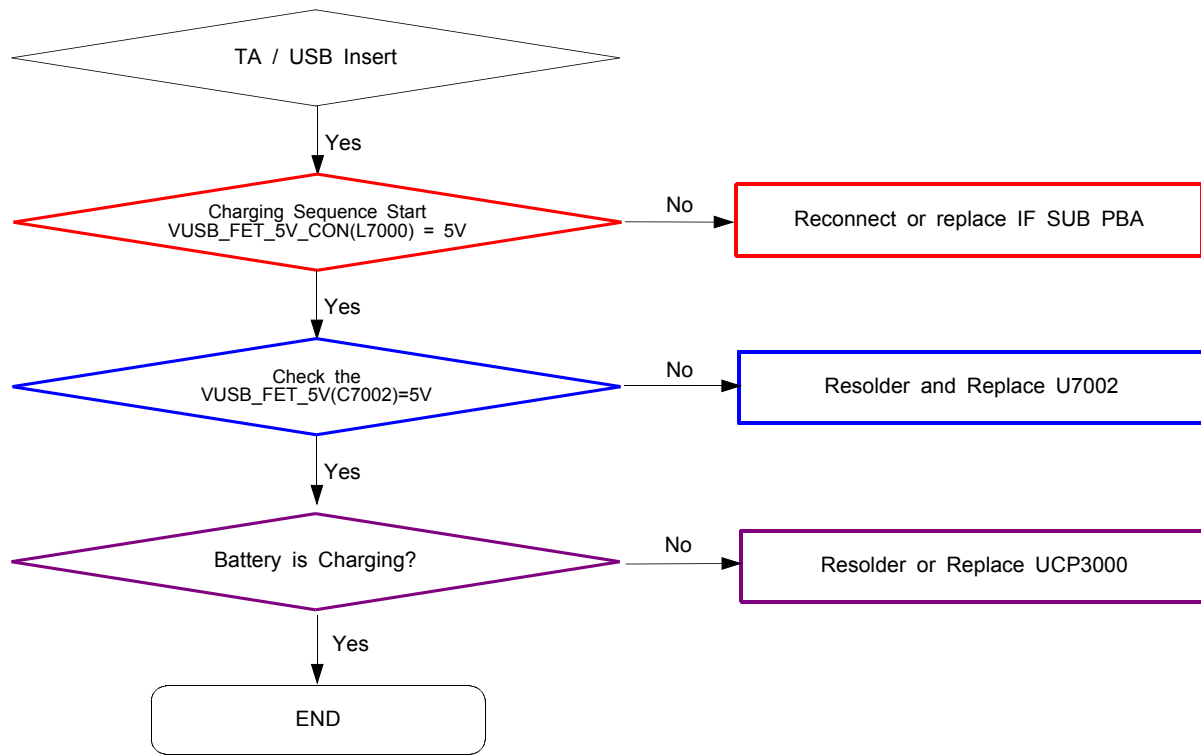
8-3-4. SIM Part

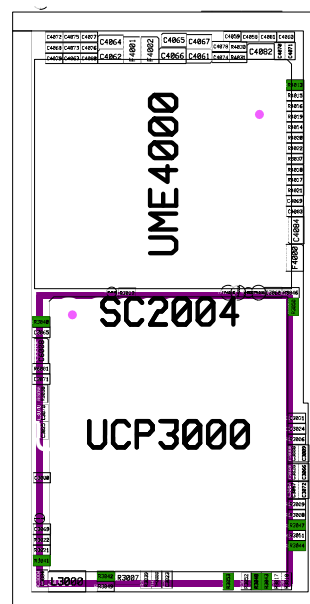
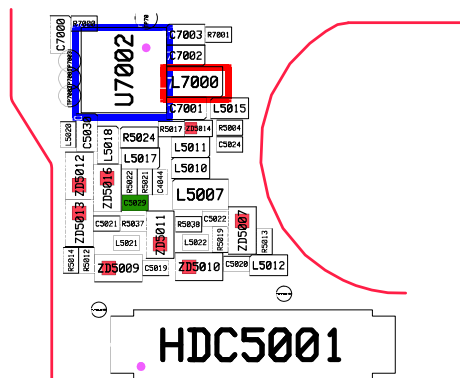
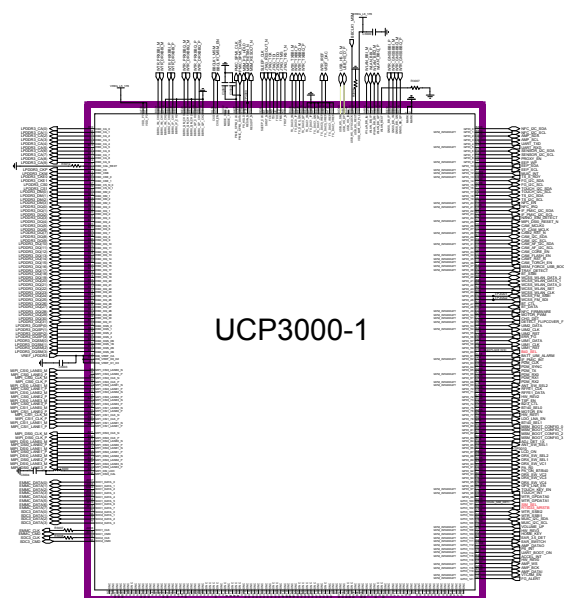
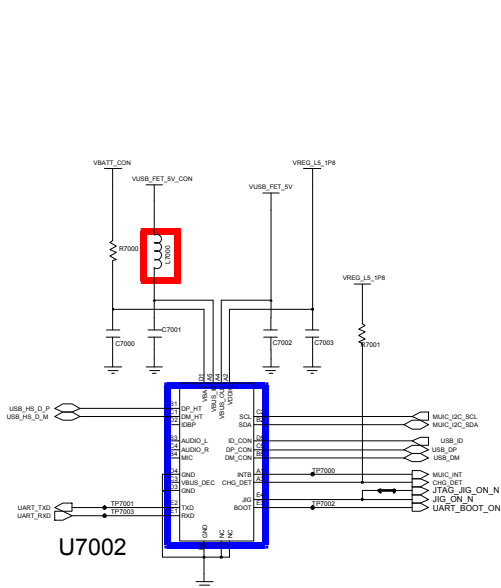


8-3-5. Micro SD Socket Part

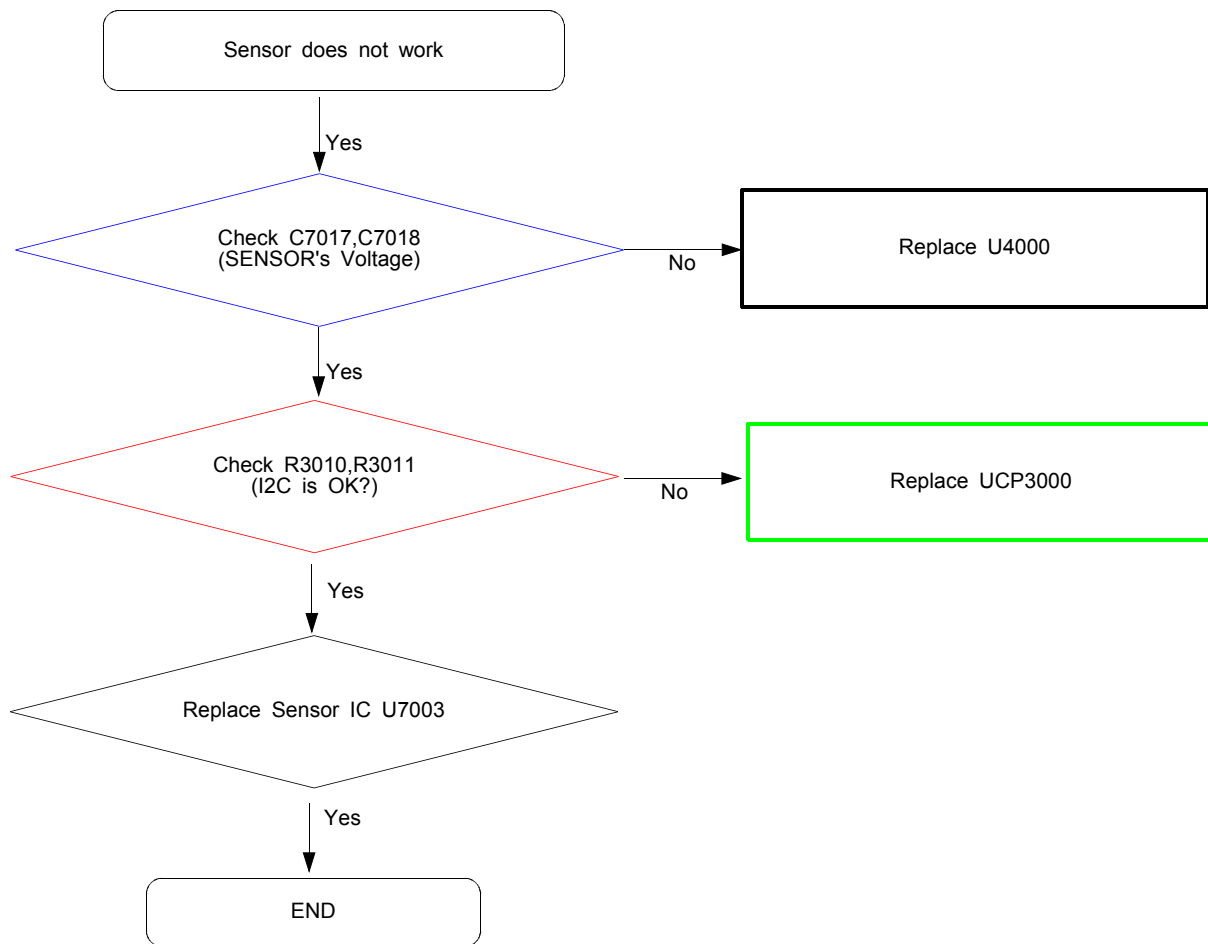


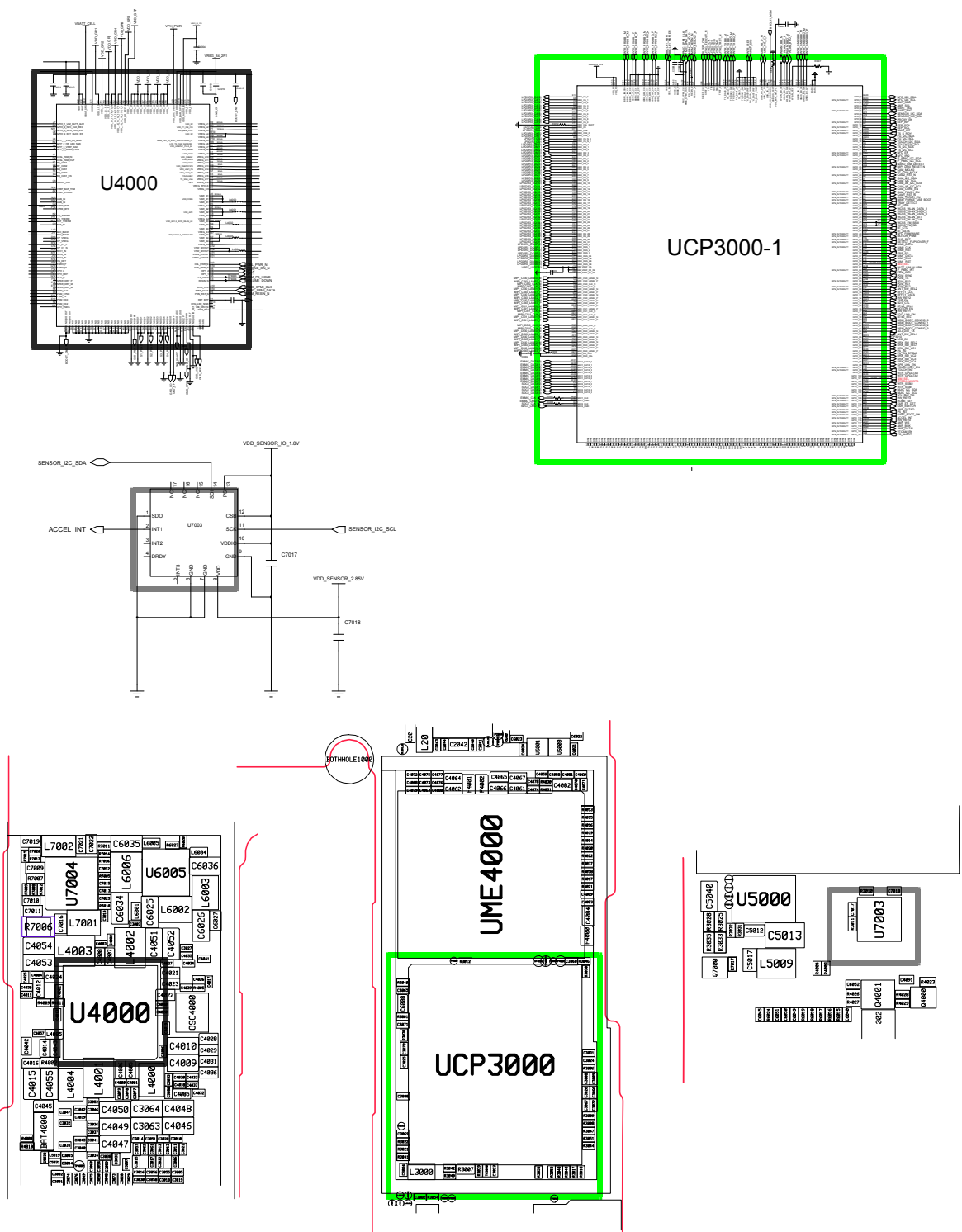
8-3-6. Charging Part



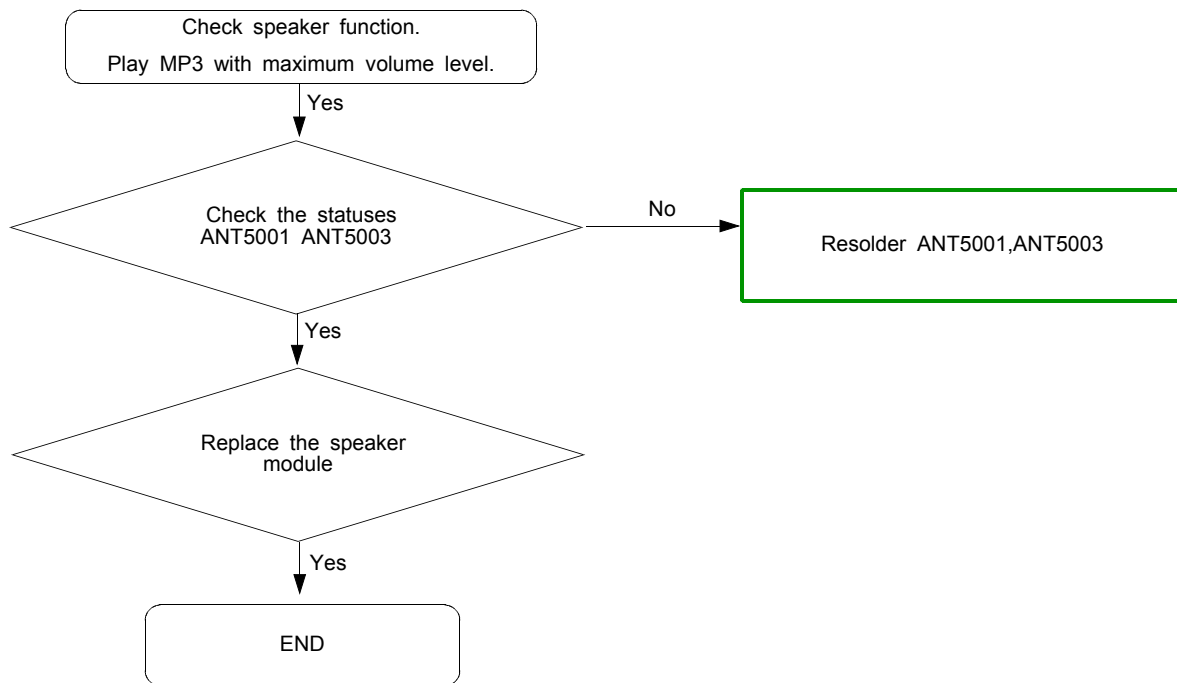


8-3-7. 6Axes Sensor

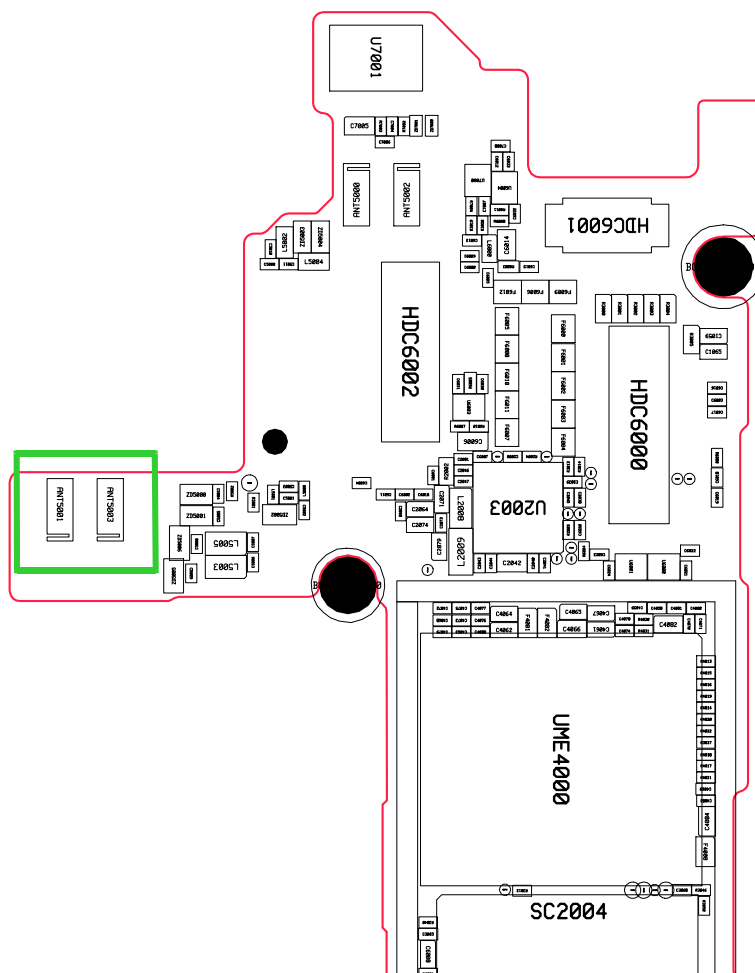
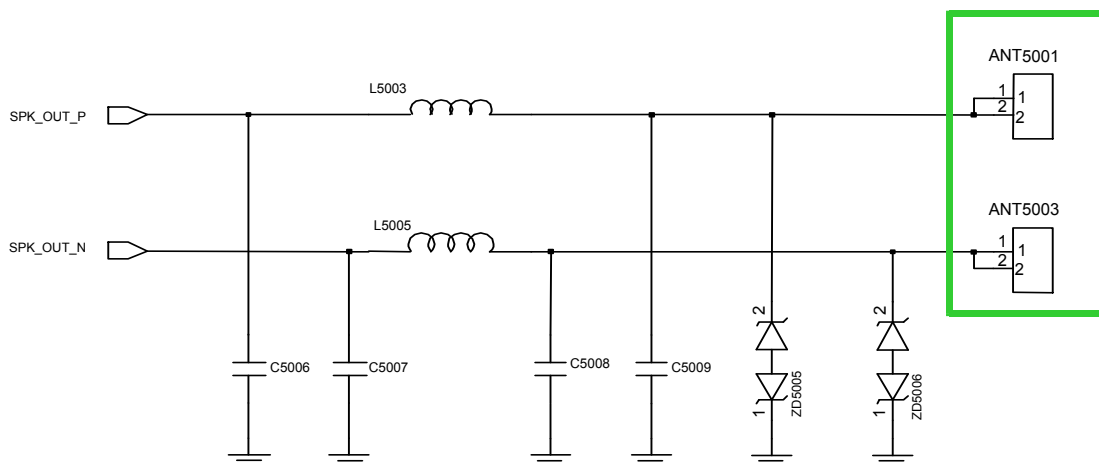




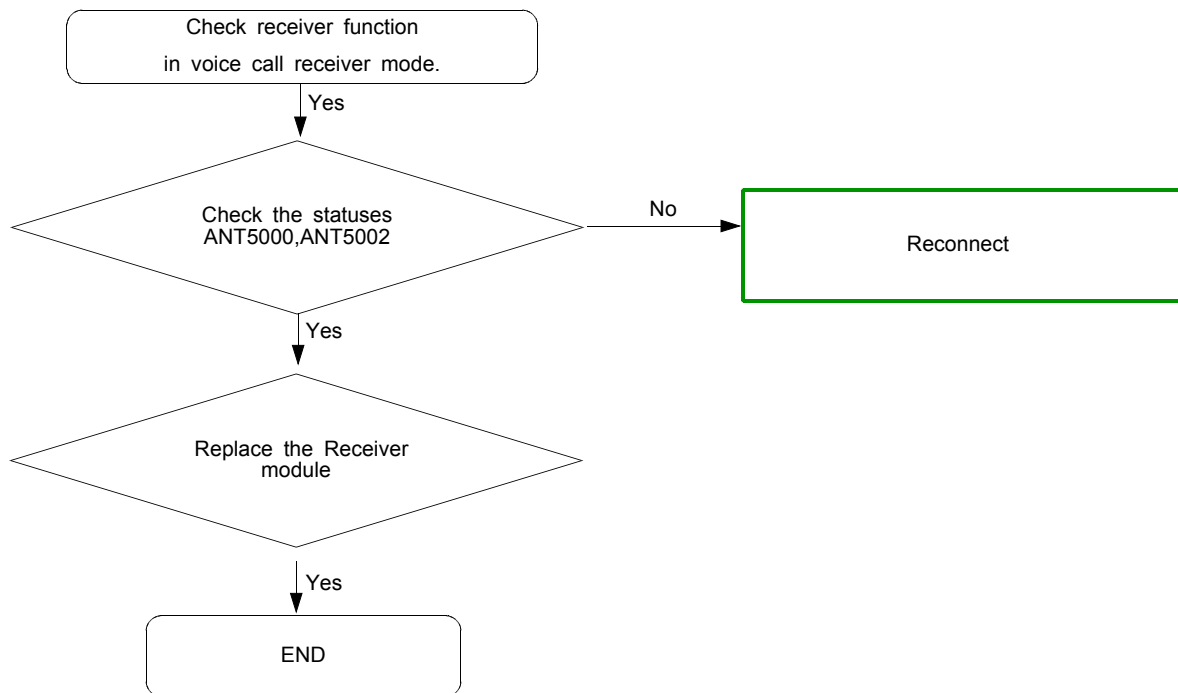
8-3-8. Speaker Part

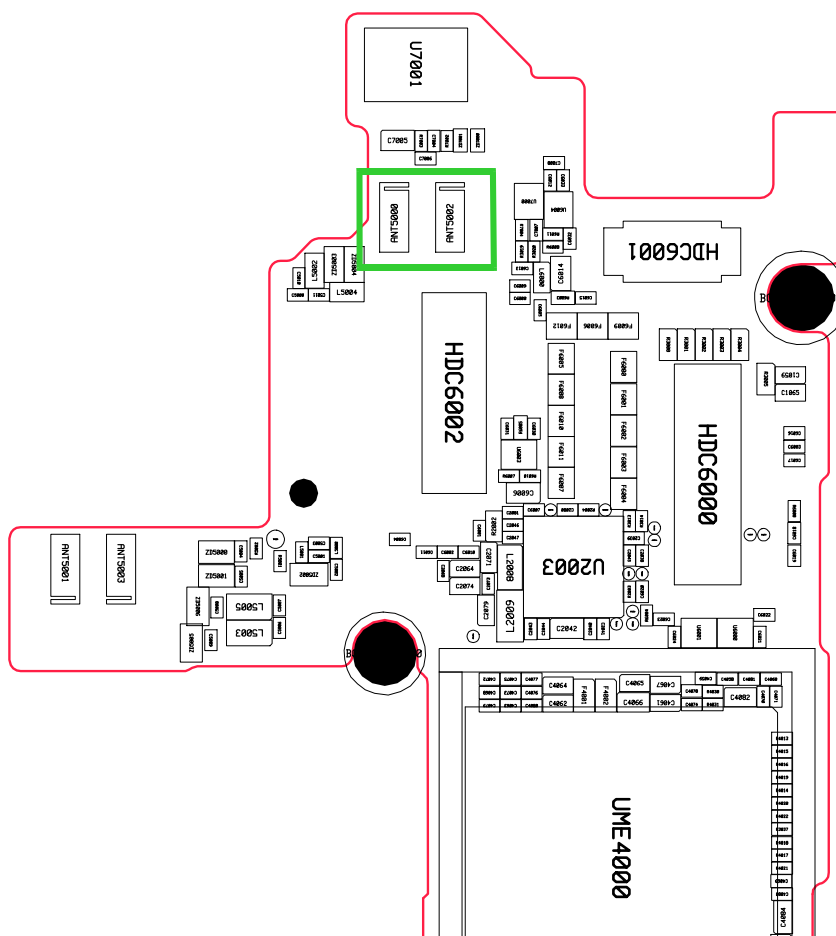
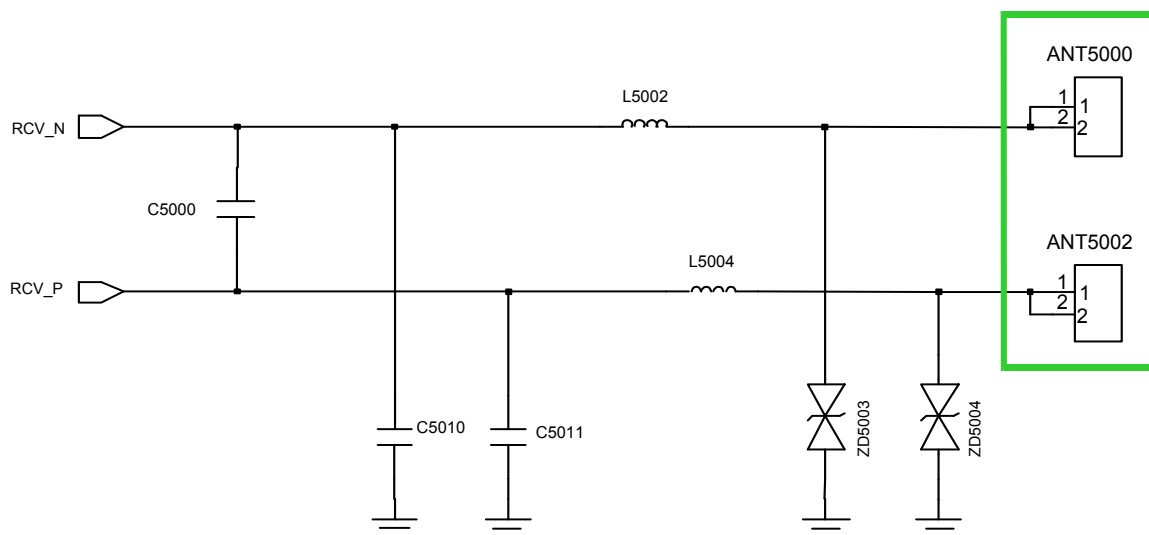


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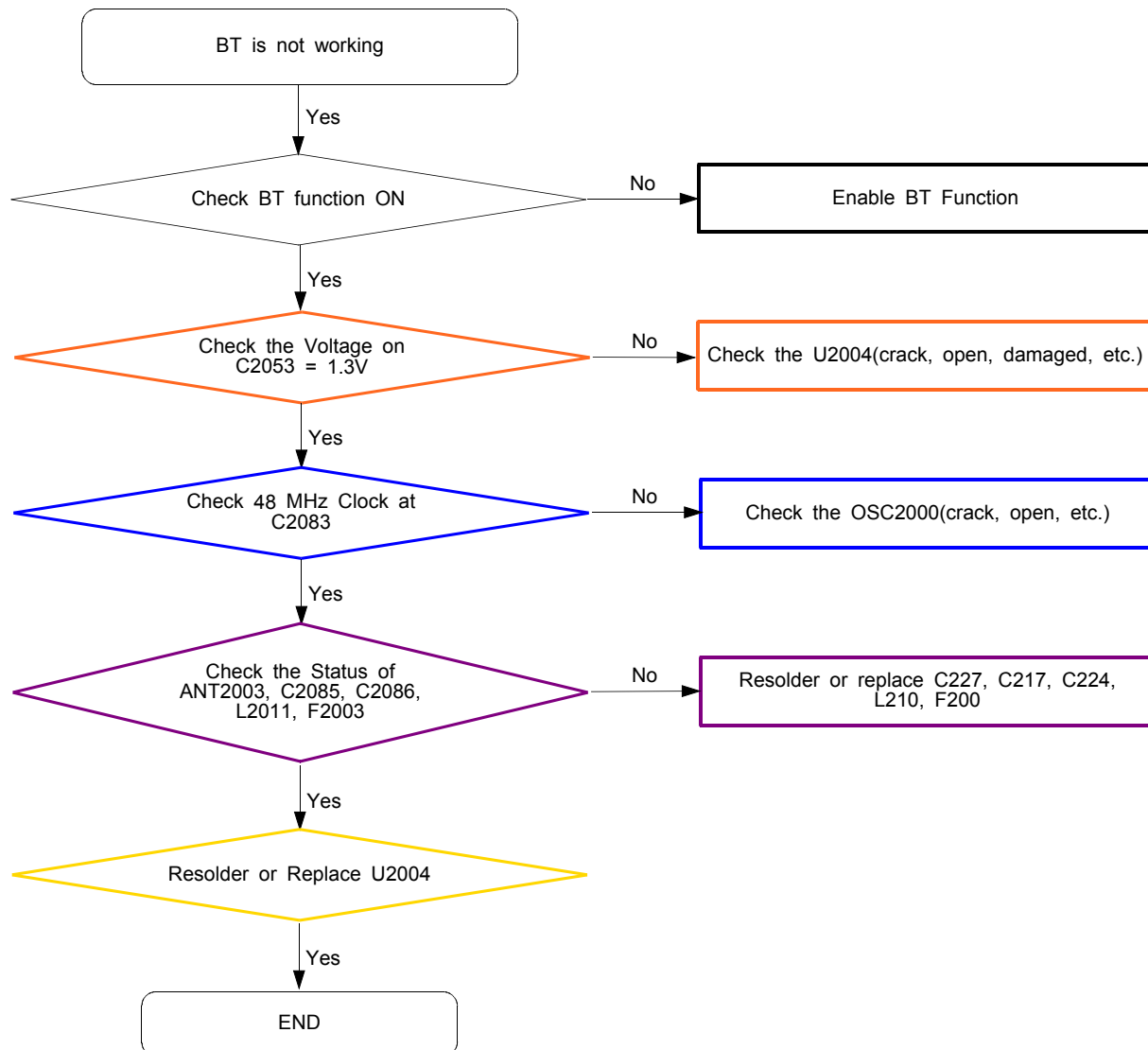


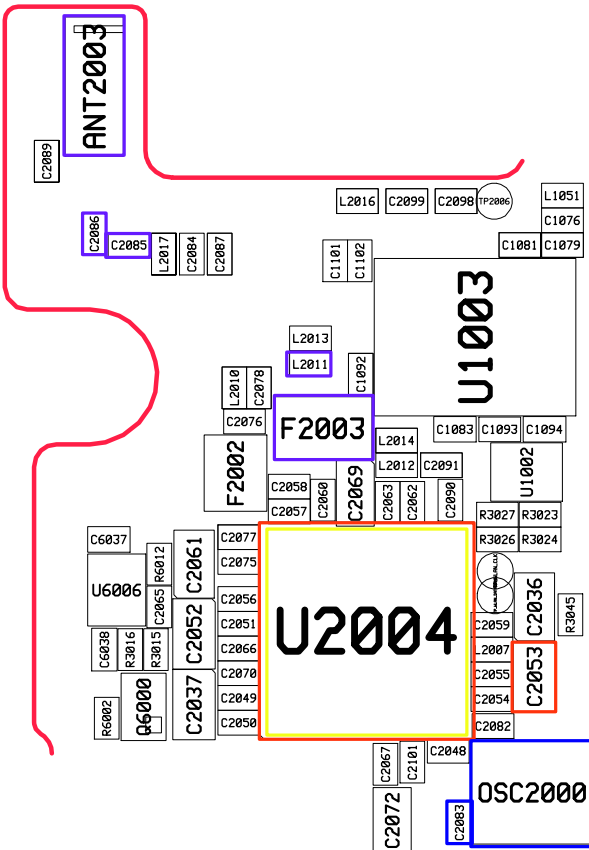
8-3-9. Receiver Part



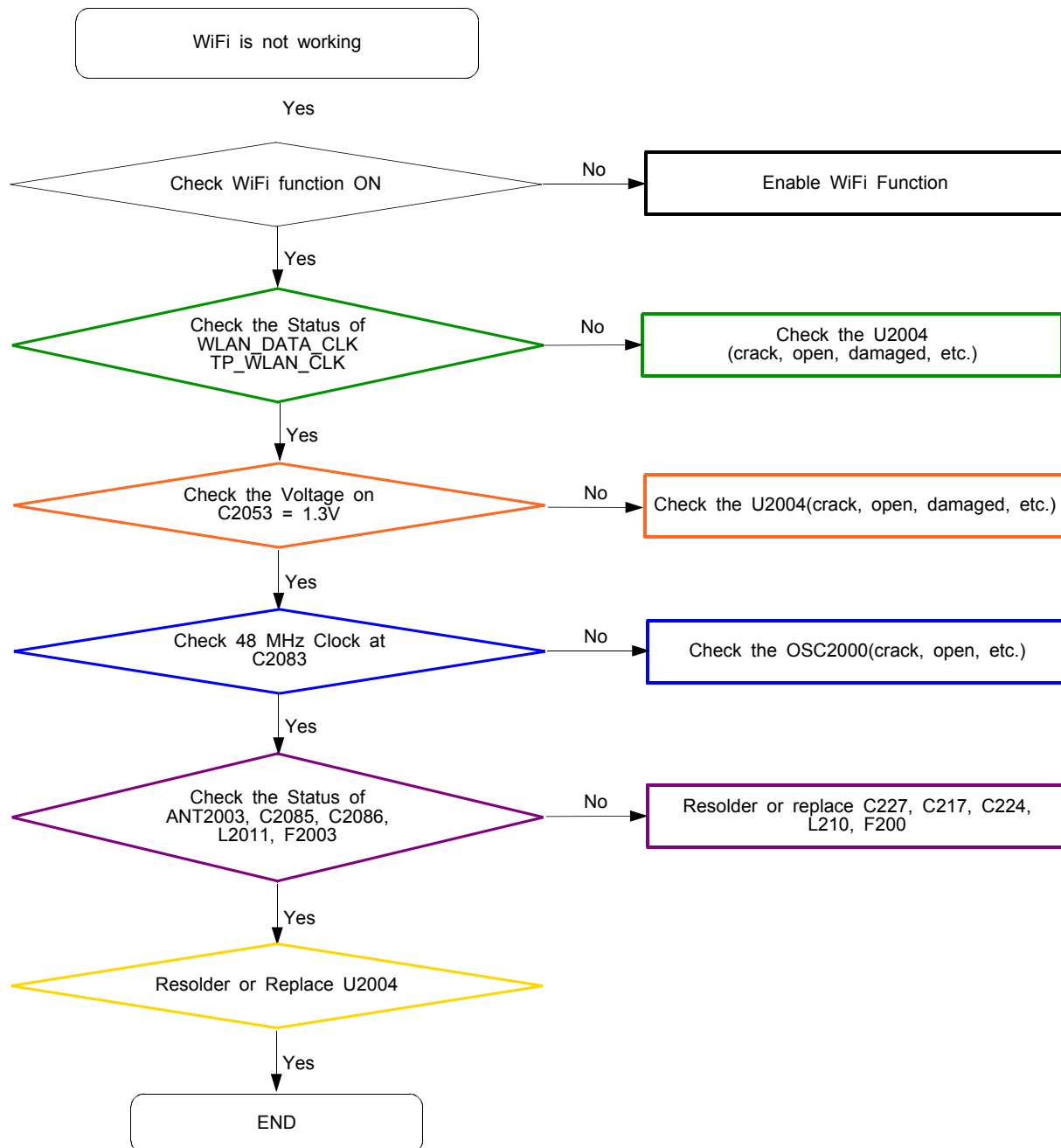


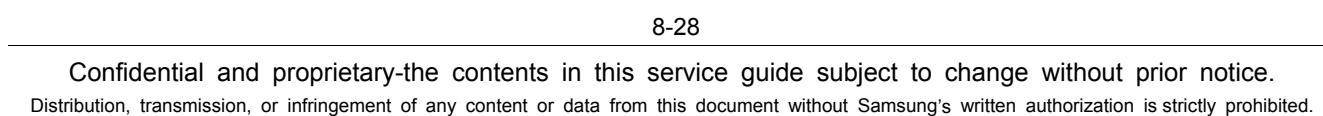
8-3-6. BT Part



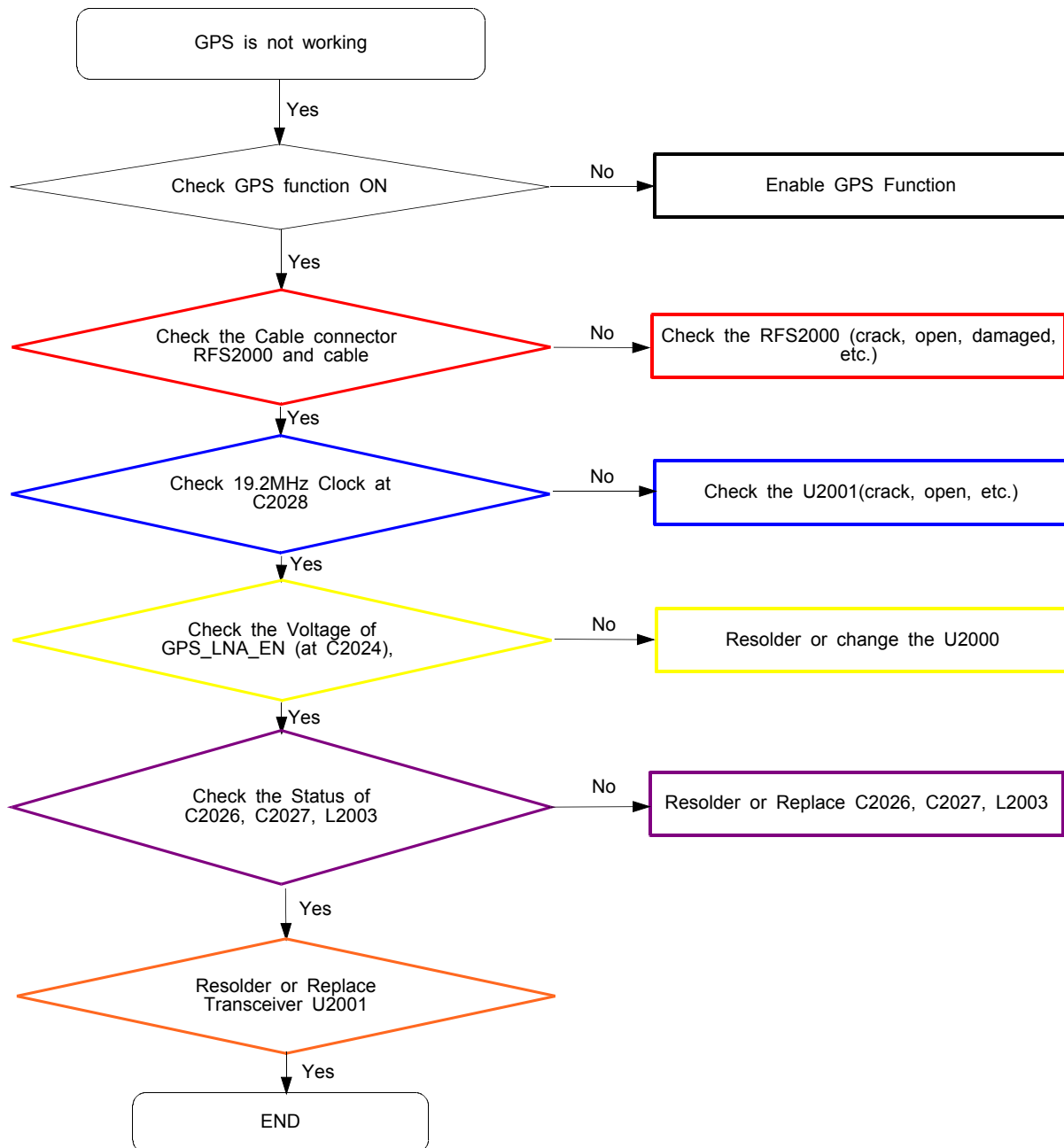


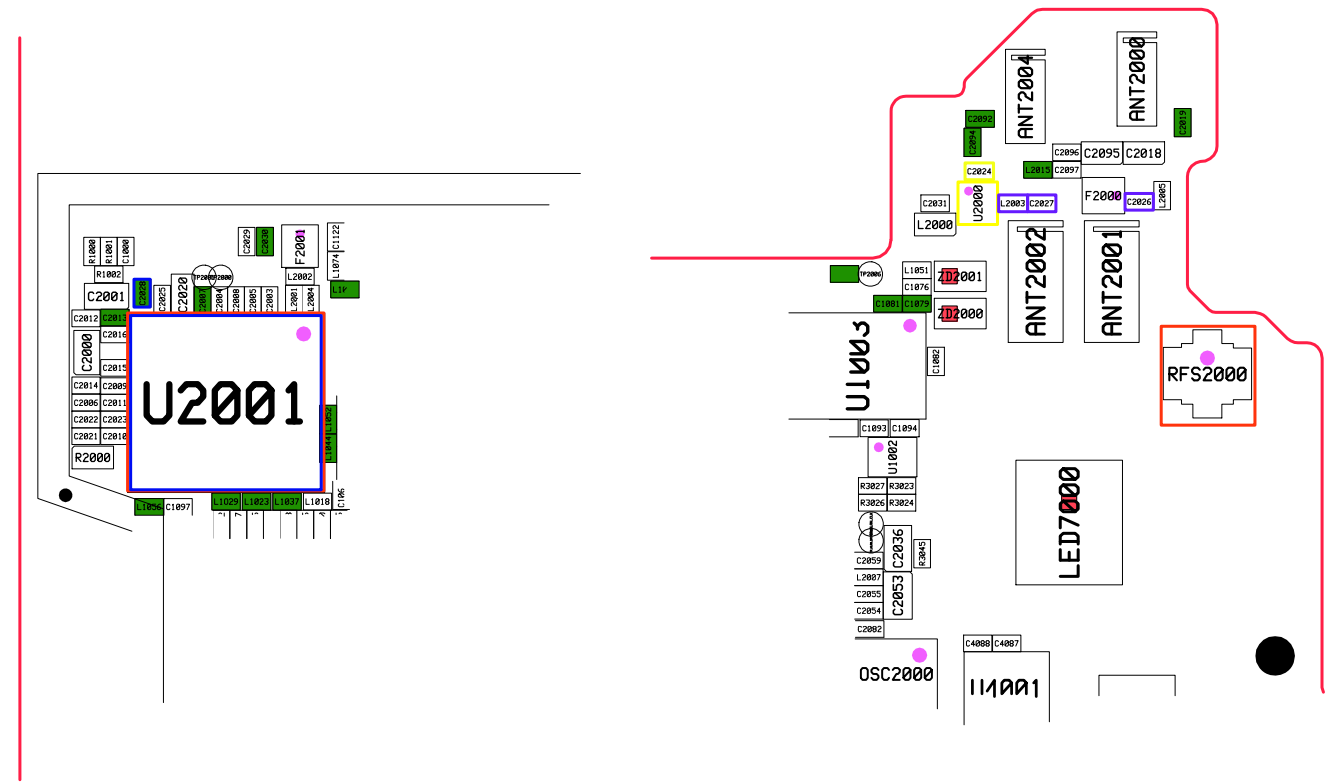
8-3-7. WIFI Part



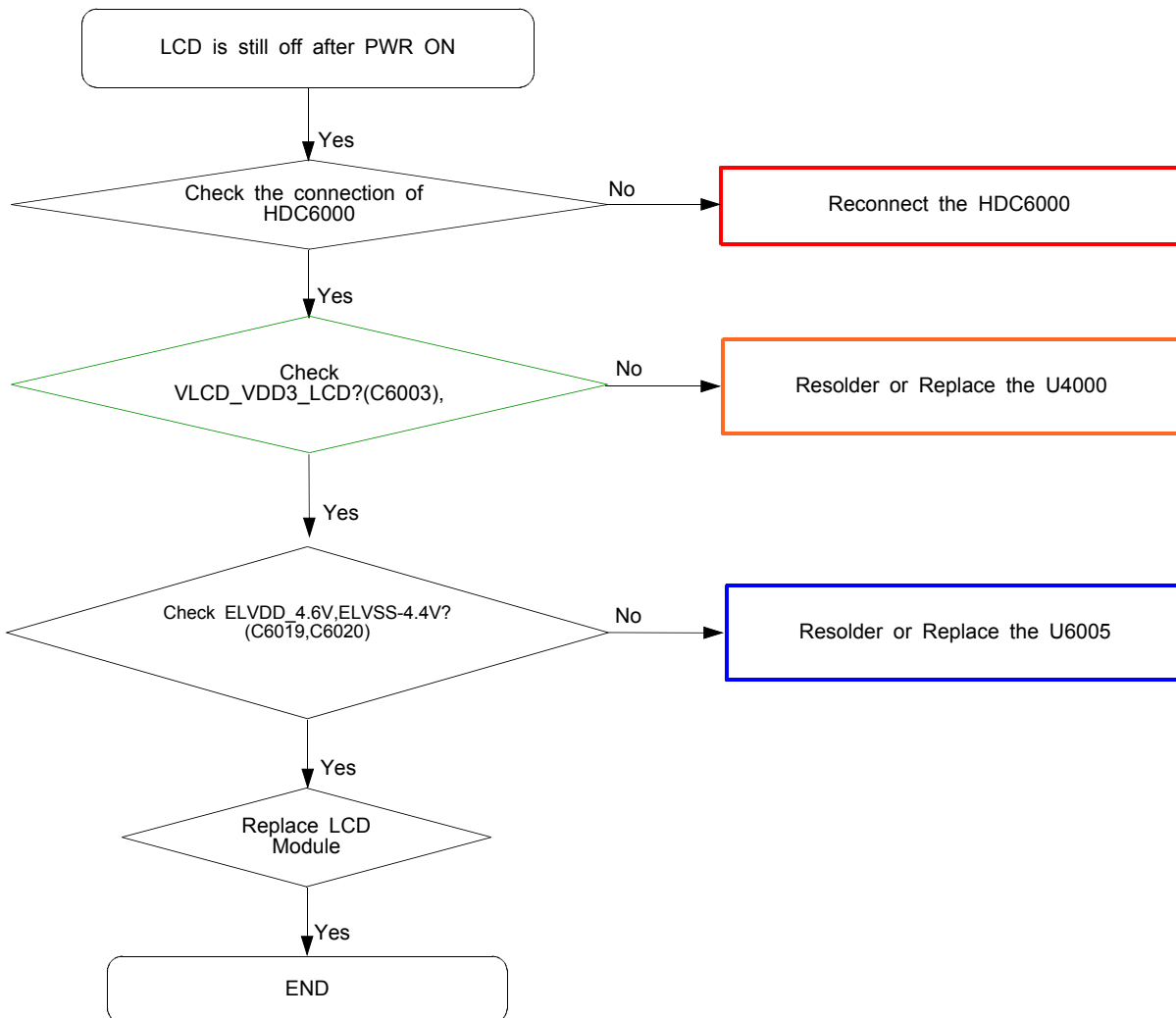


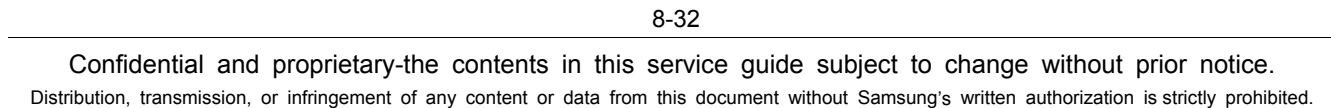
8-3-8. GPS Part

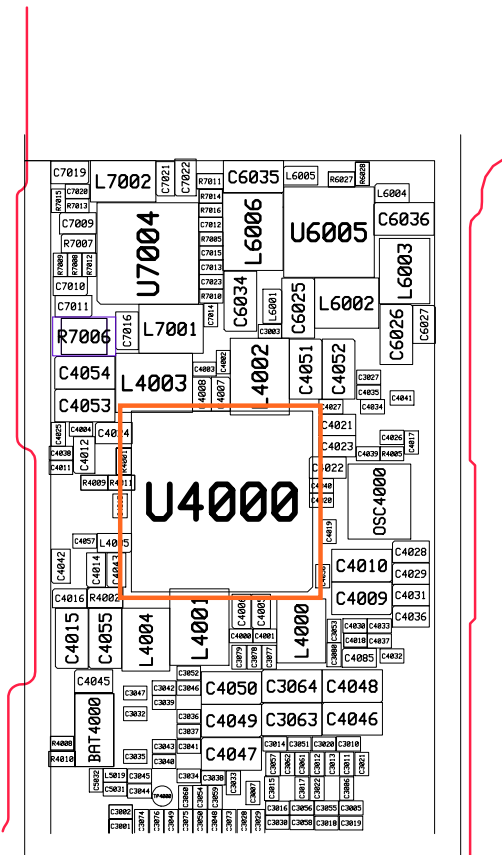
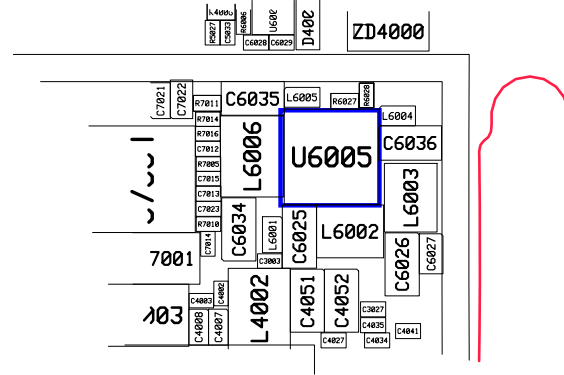
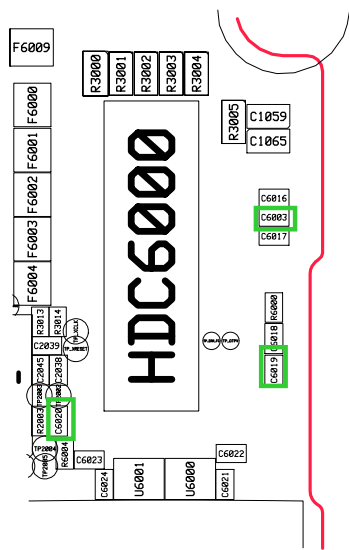




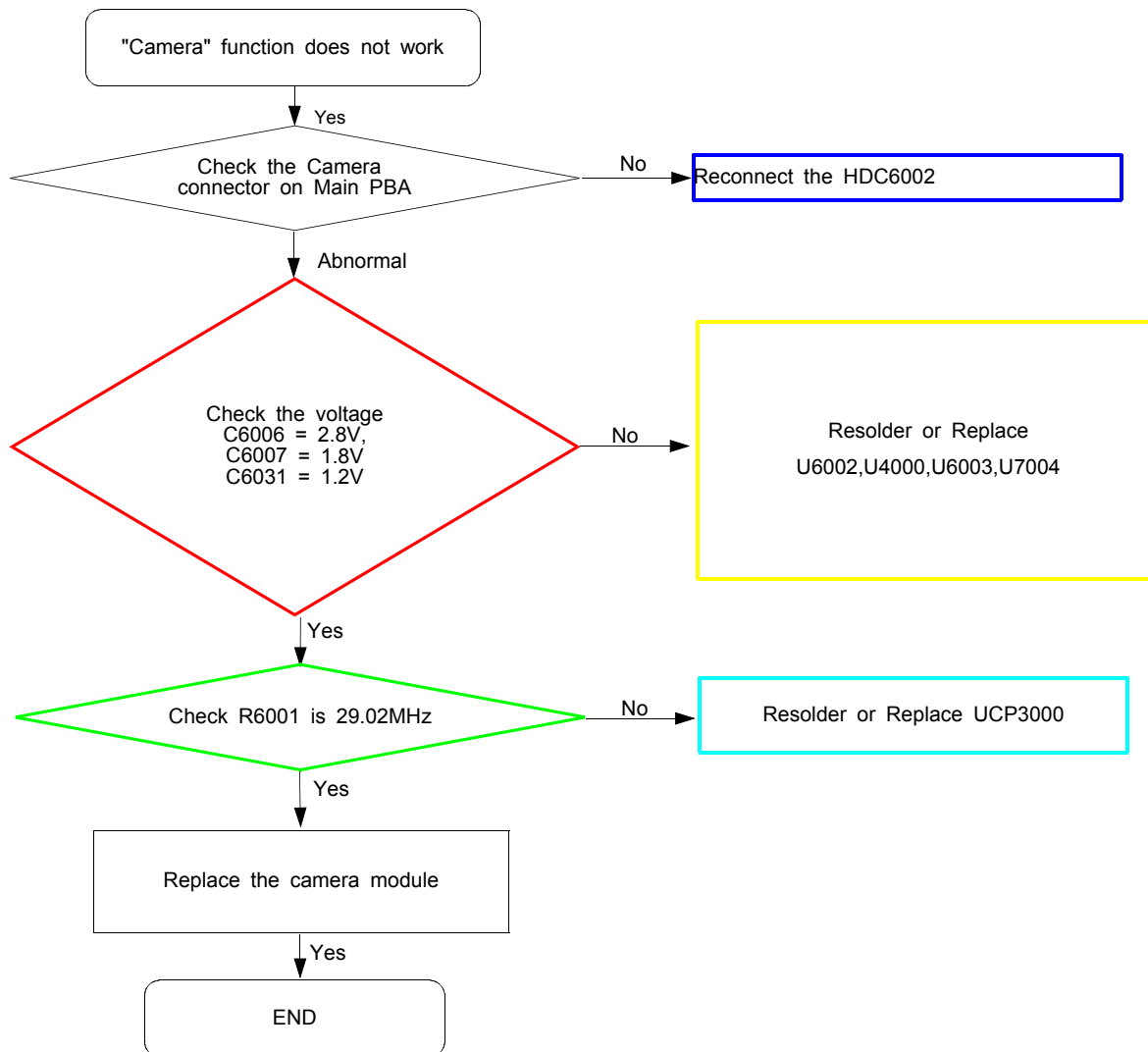
8-3-12. LCD

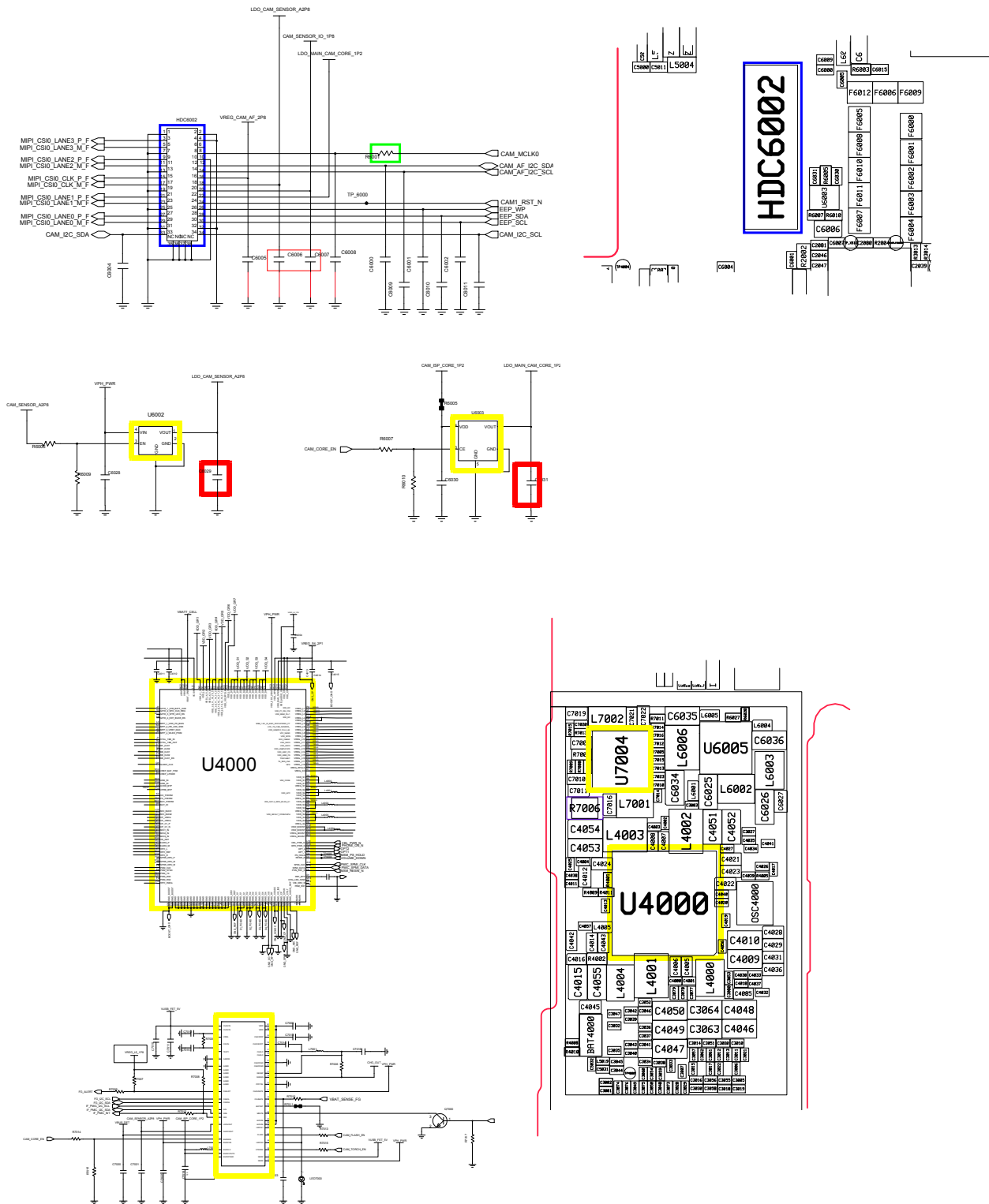


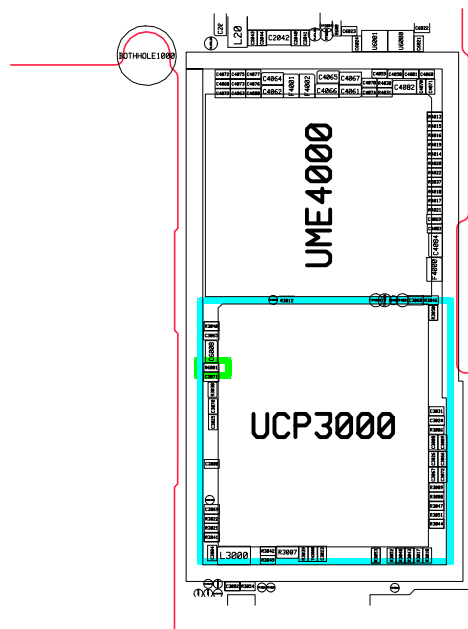
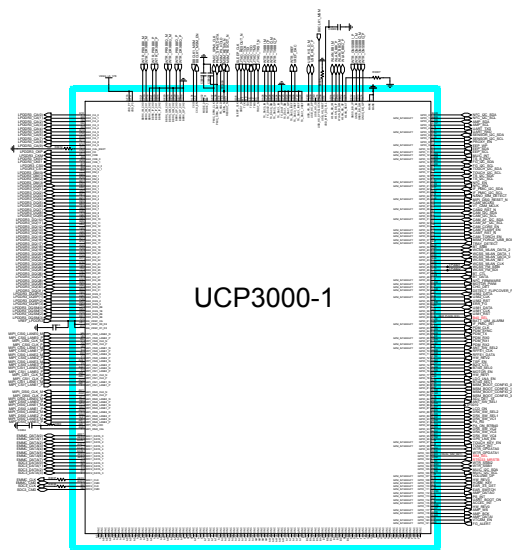




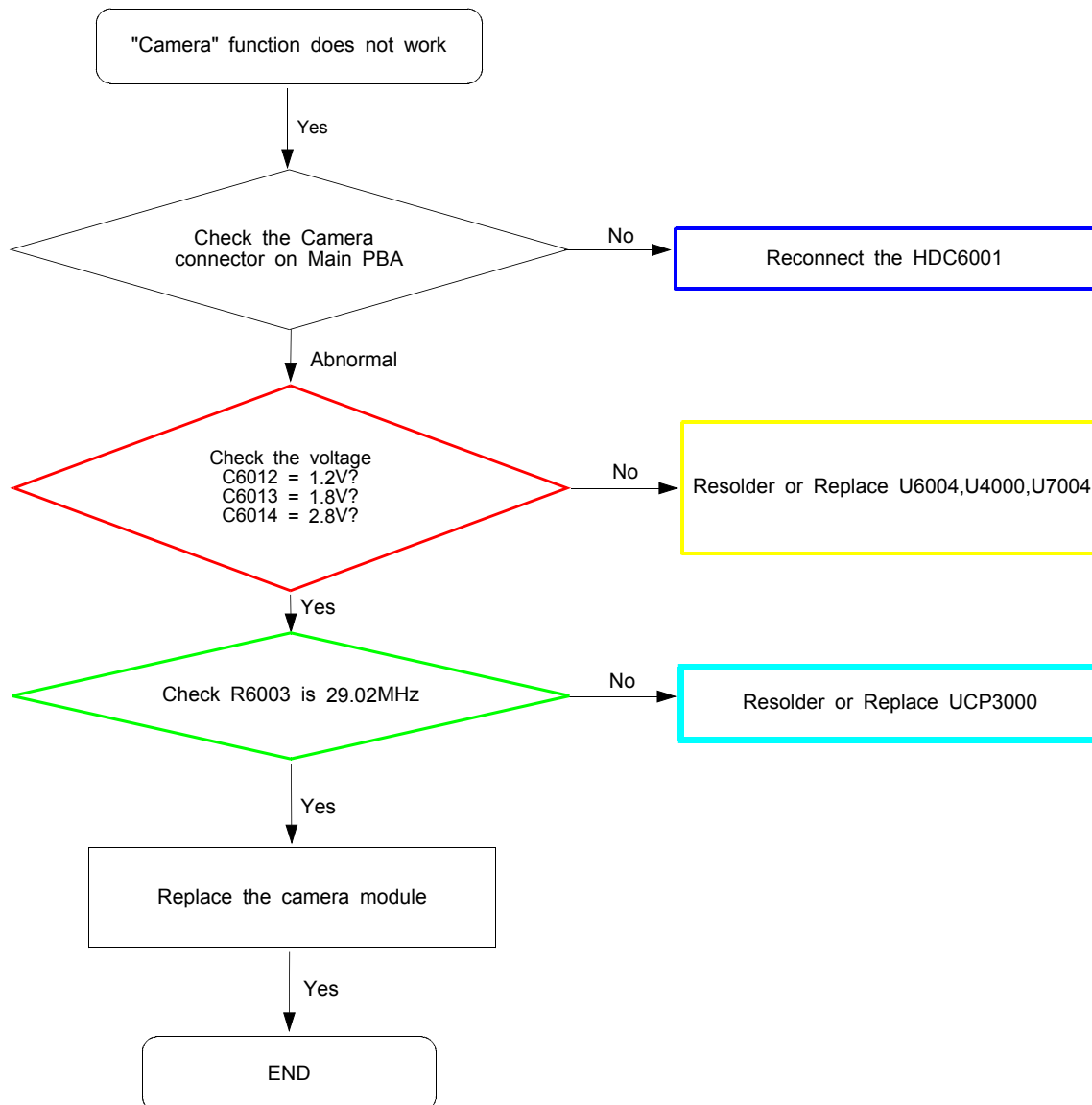
8-3-13. 13M CAM

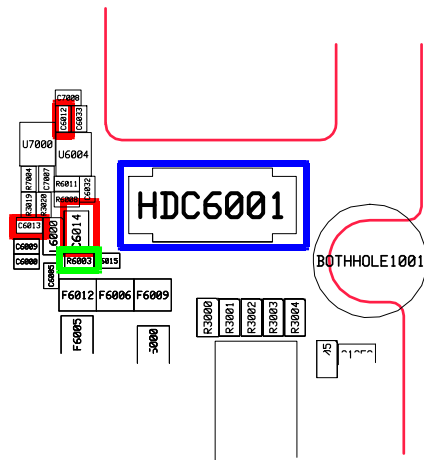
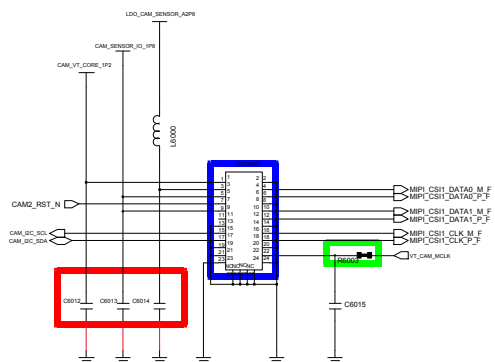


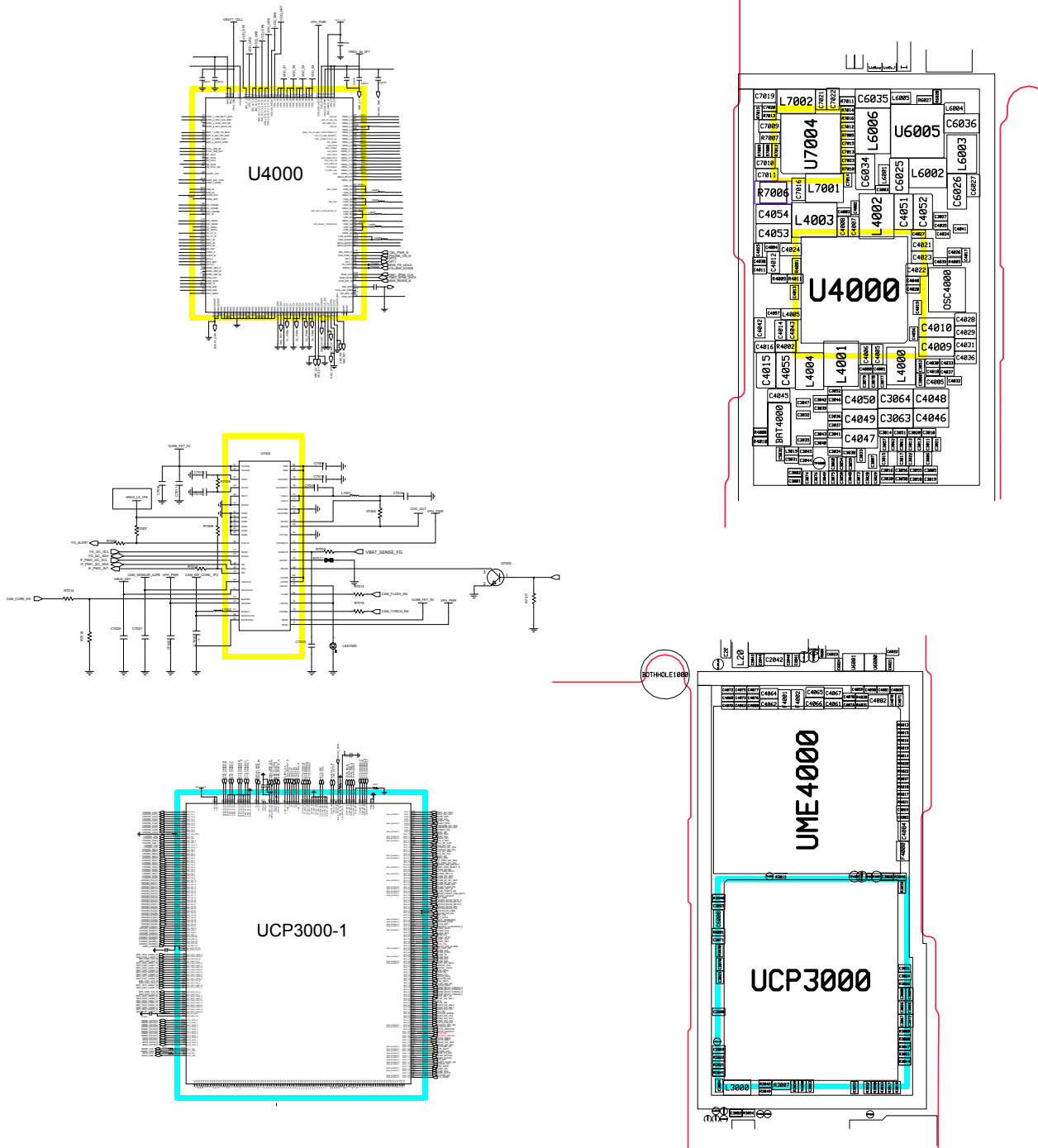




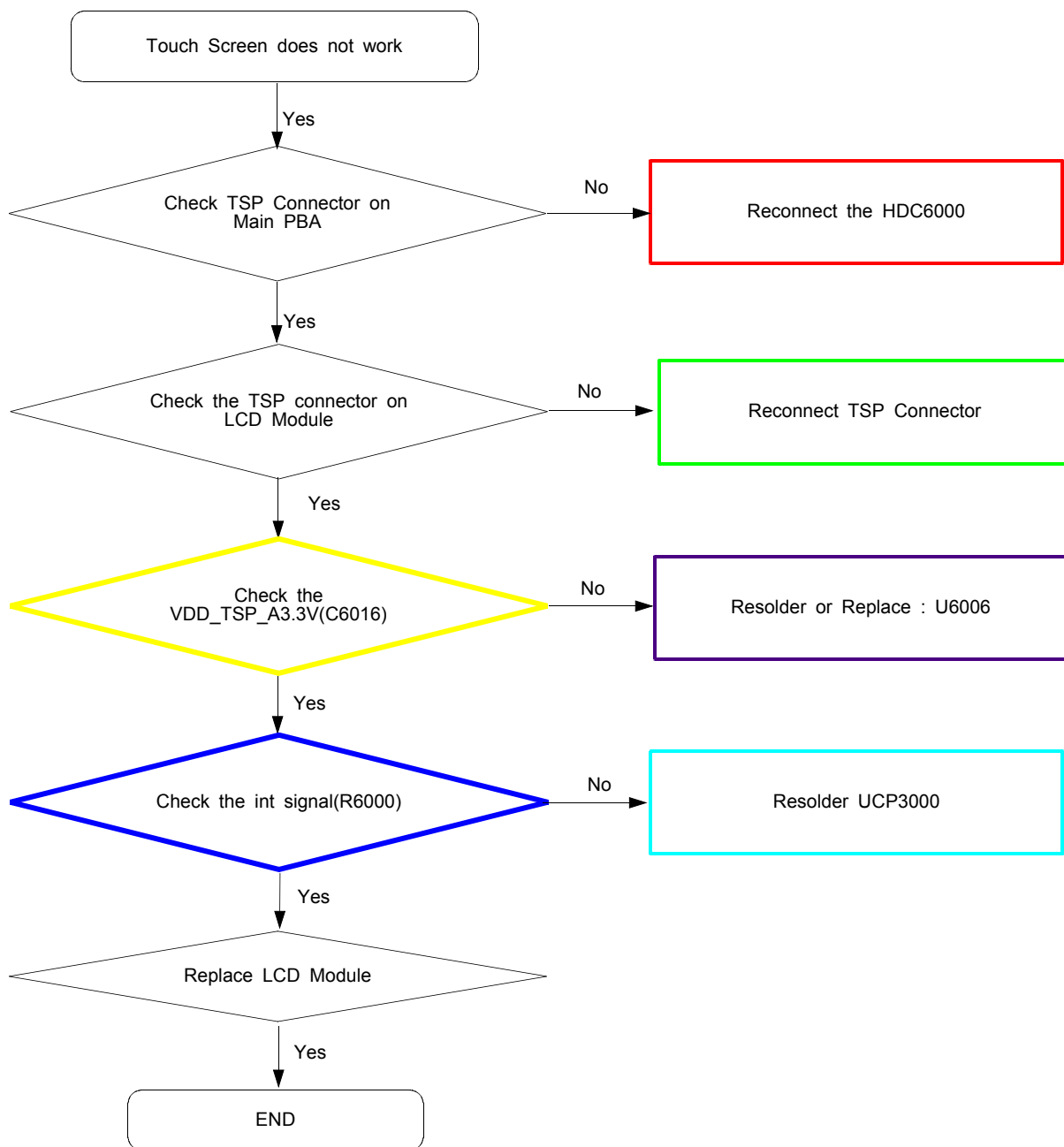
8-3-14. VT CAM

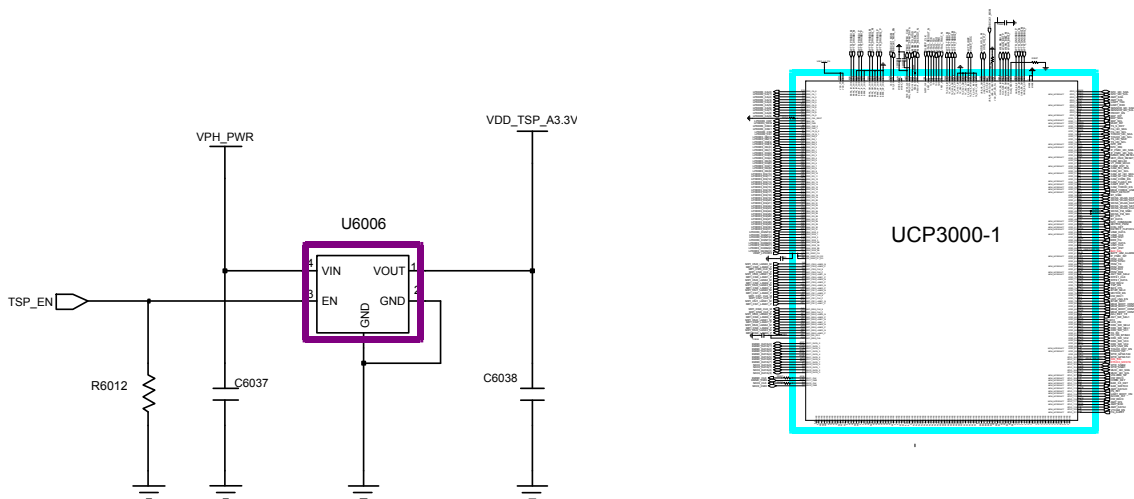
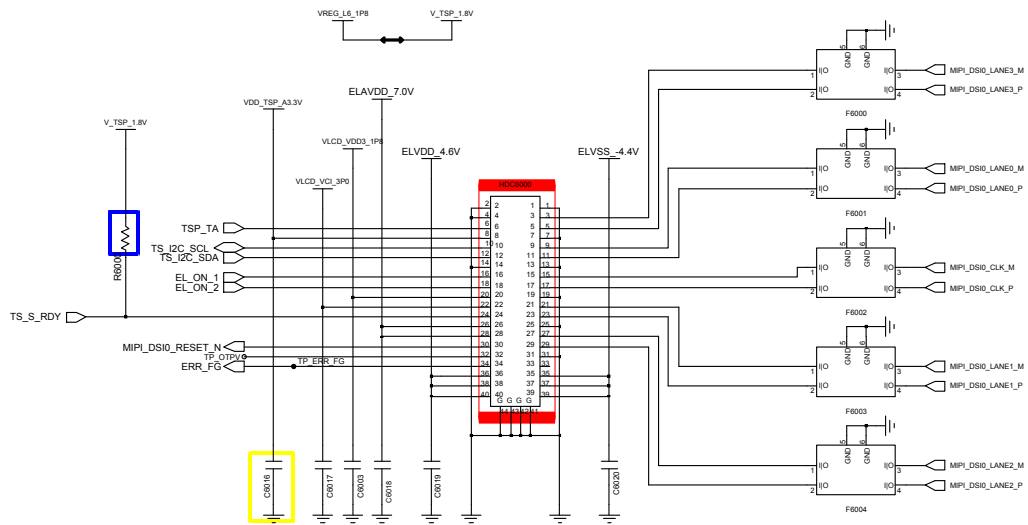


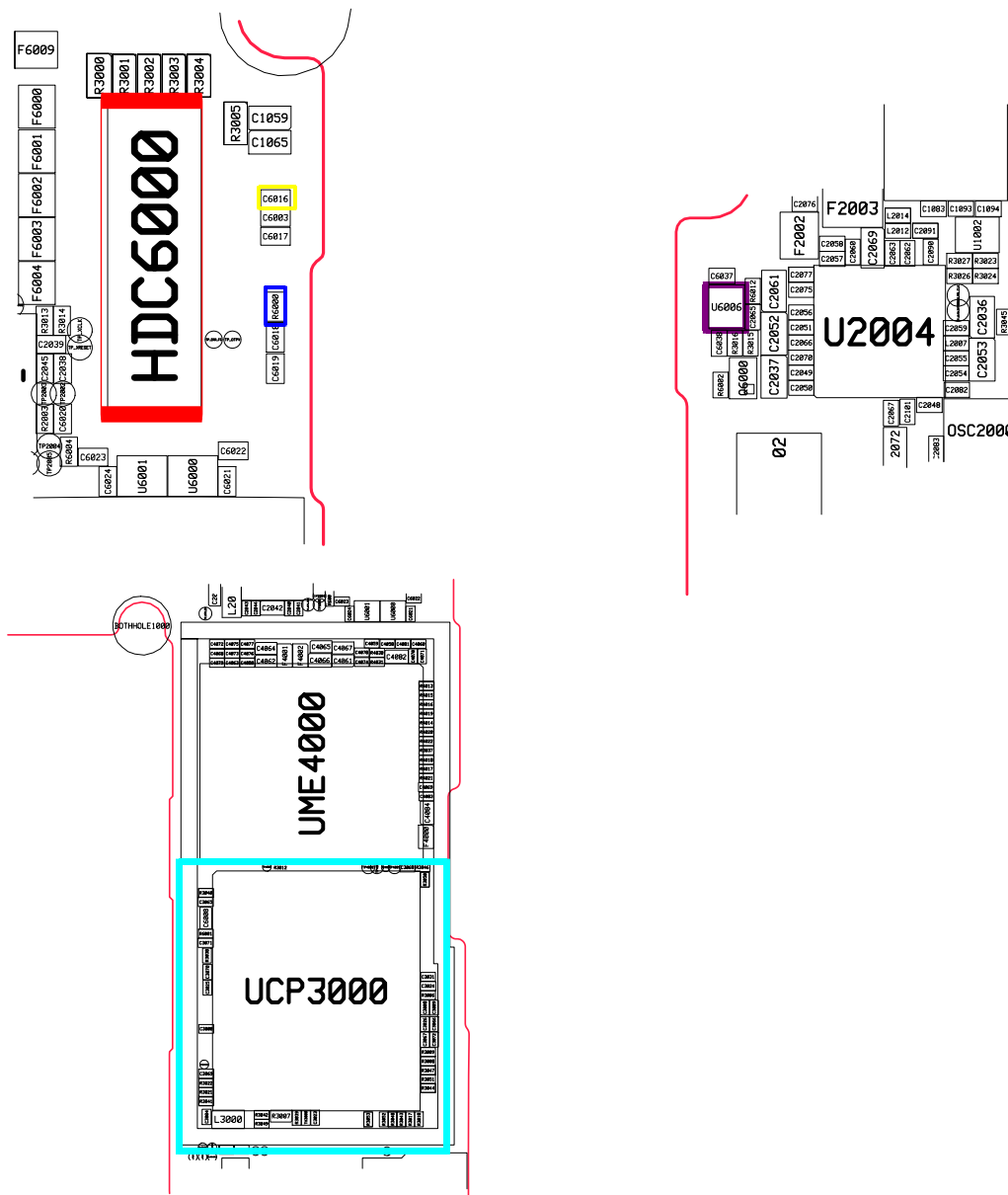




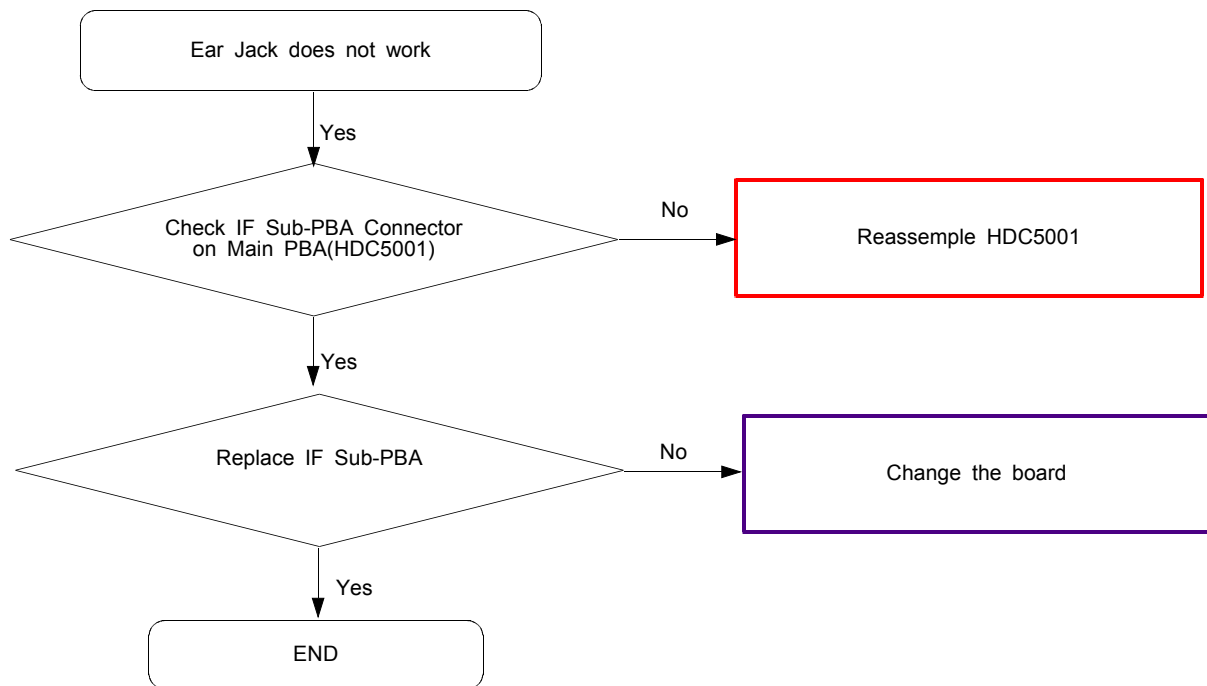
8-3-15. TSP

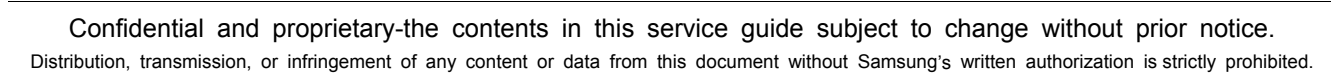




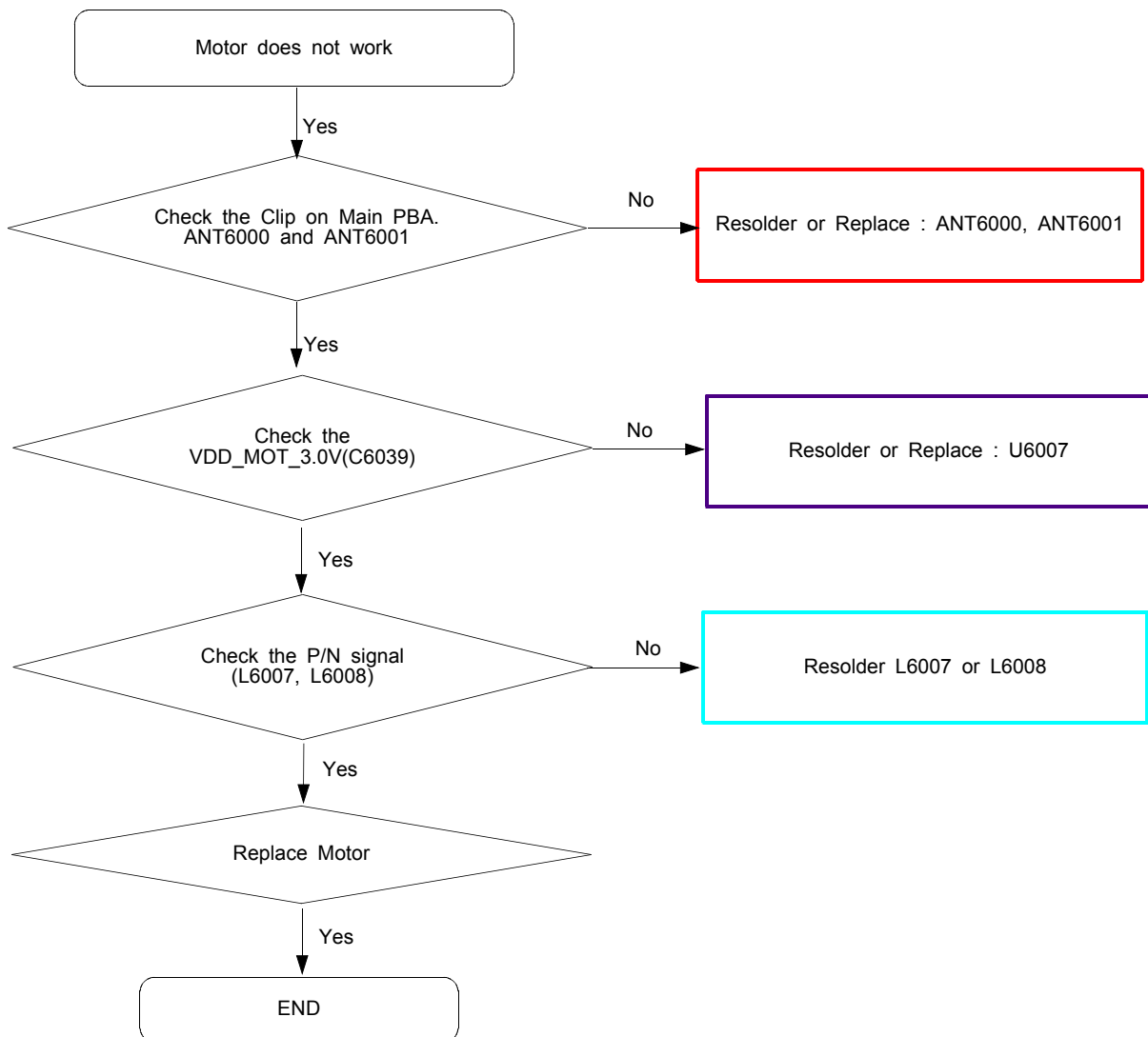


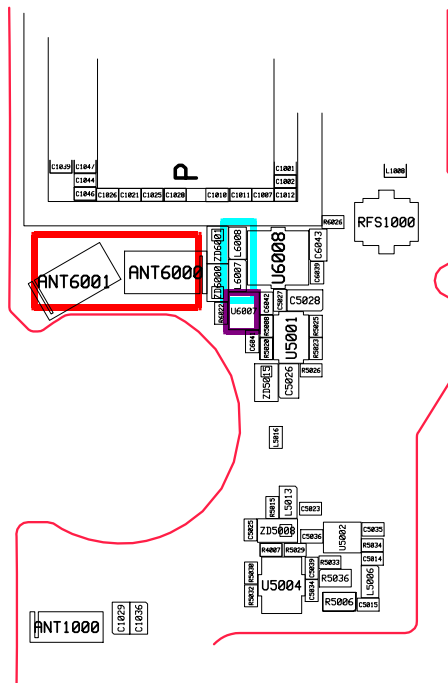
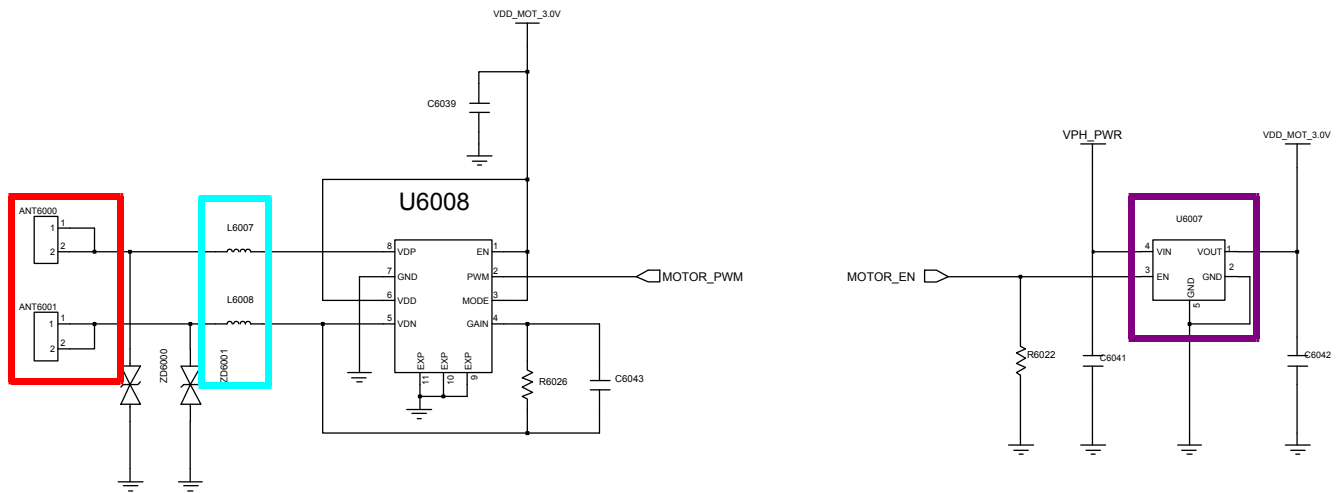
8-3-16. Ear Jack



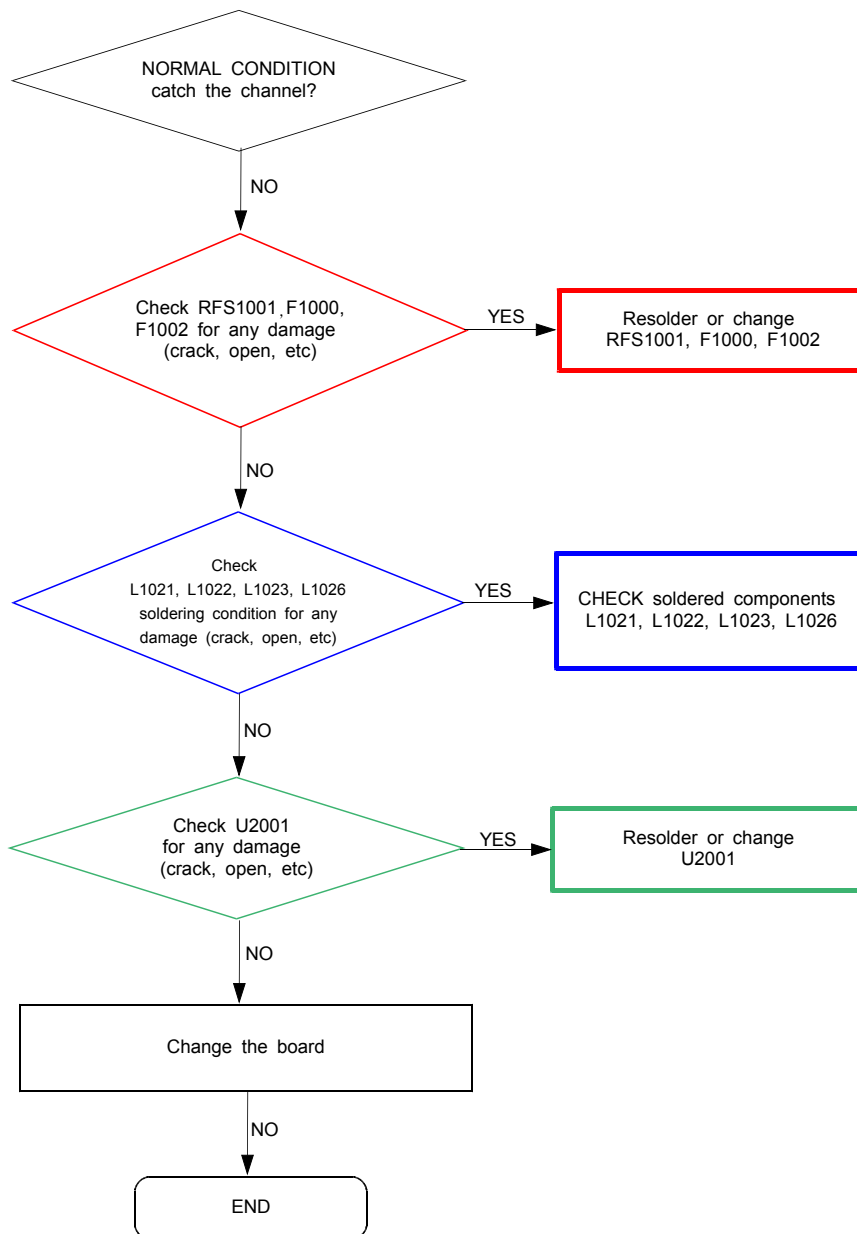


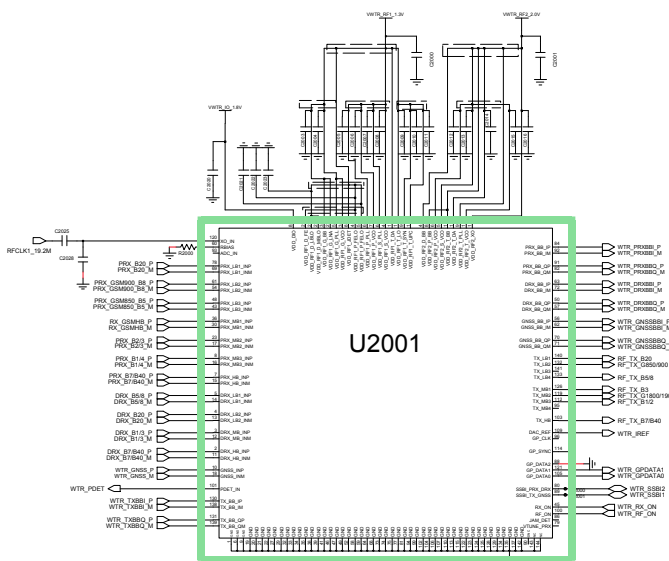
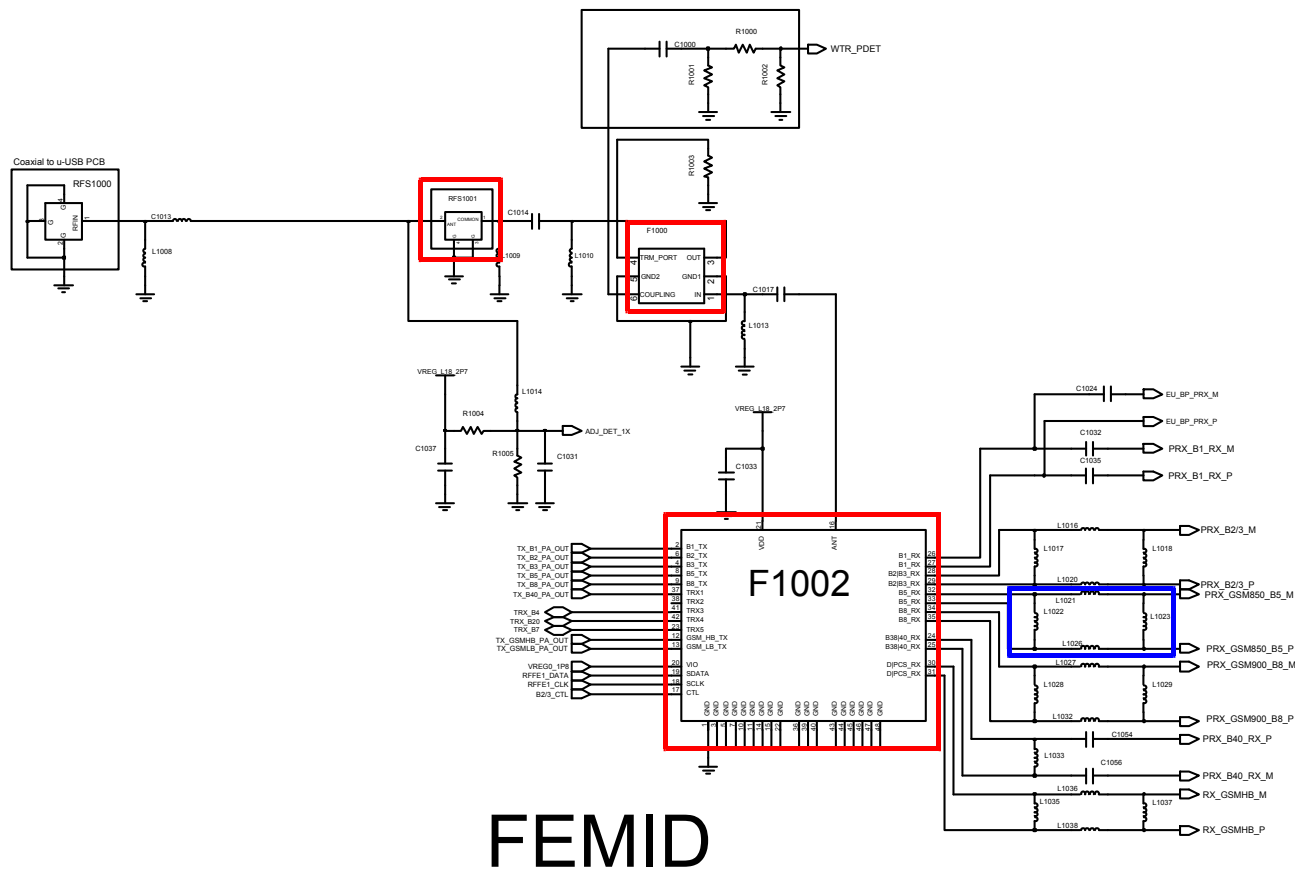
8-3-17. Motor

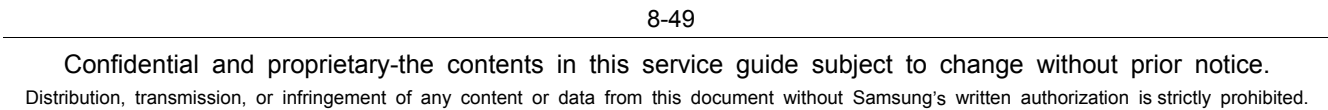




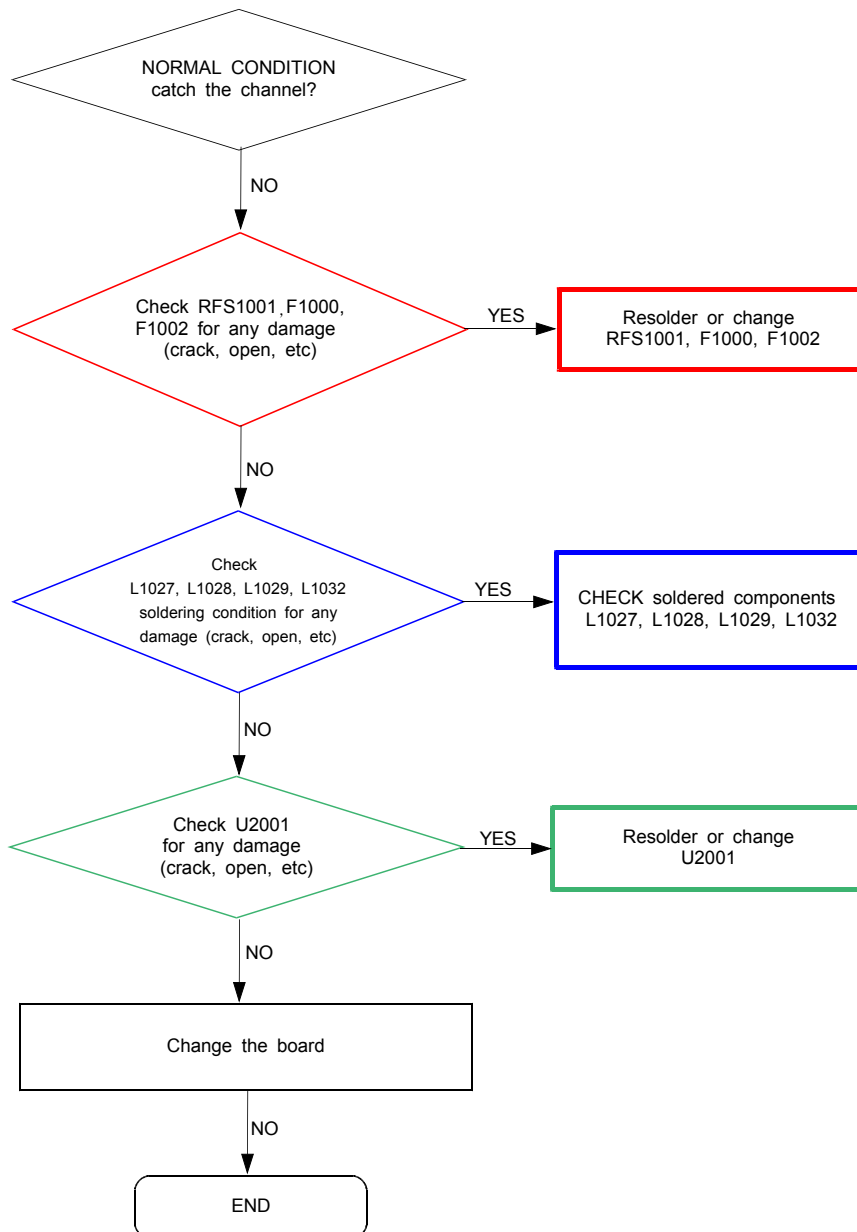
8-3-18. GSM850 / WCDMA B5 RX





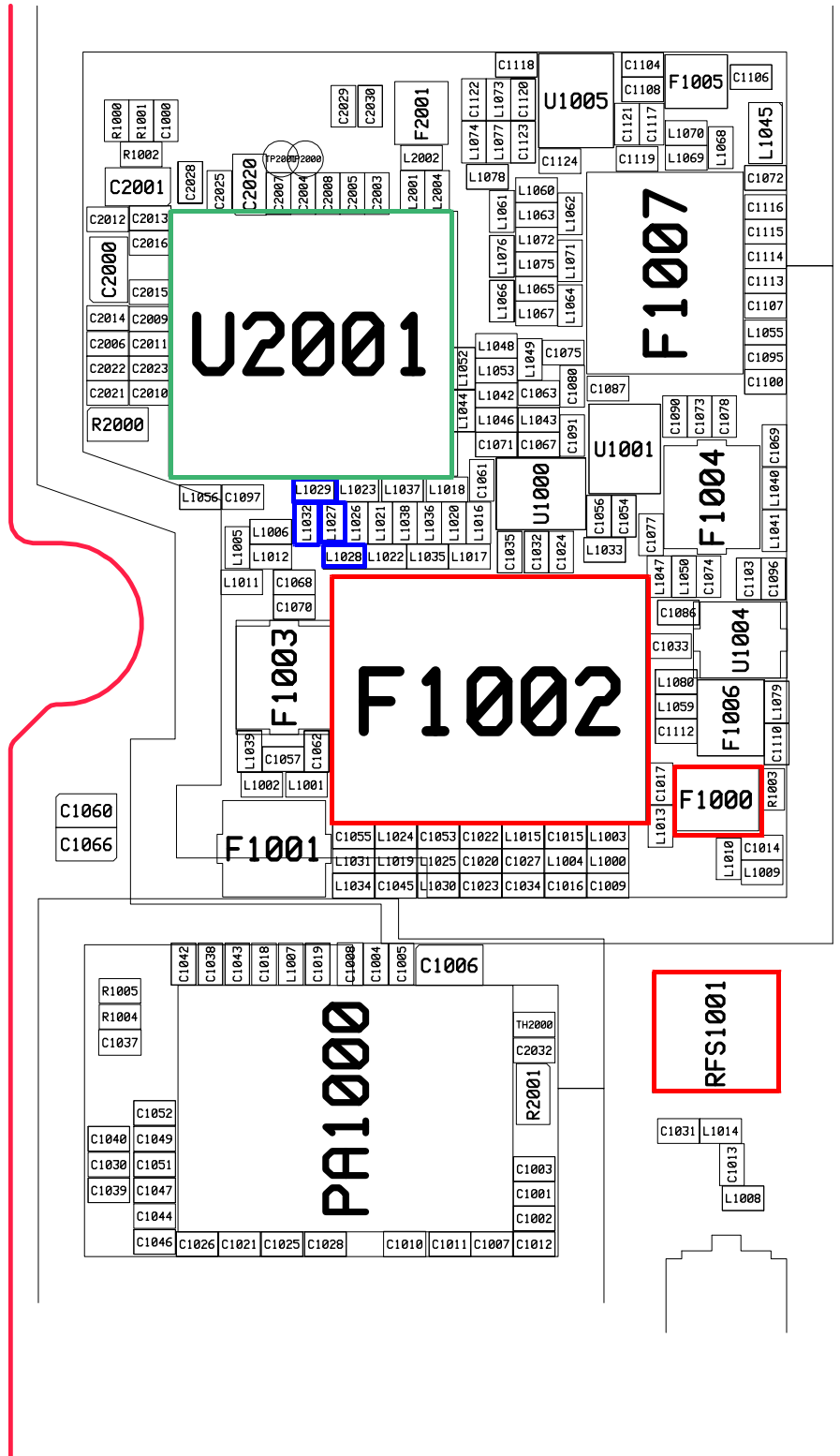


8-3-19. GSM900 / WCDMA B8 RX

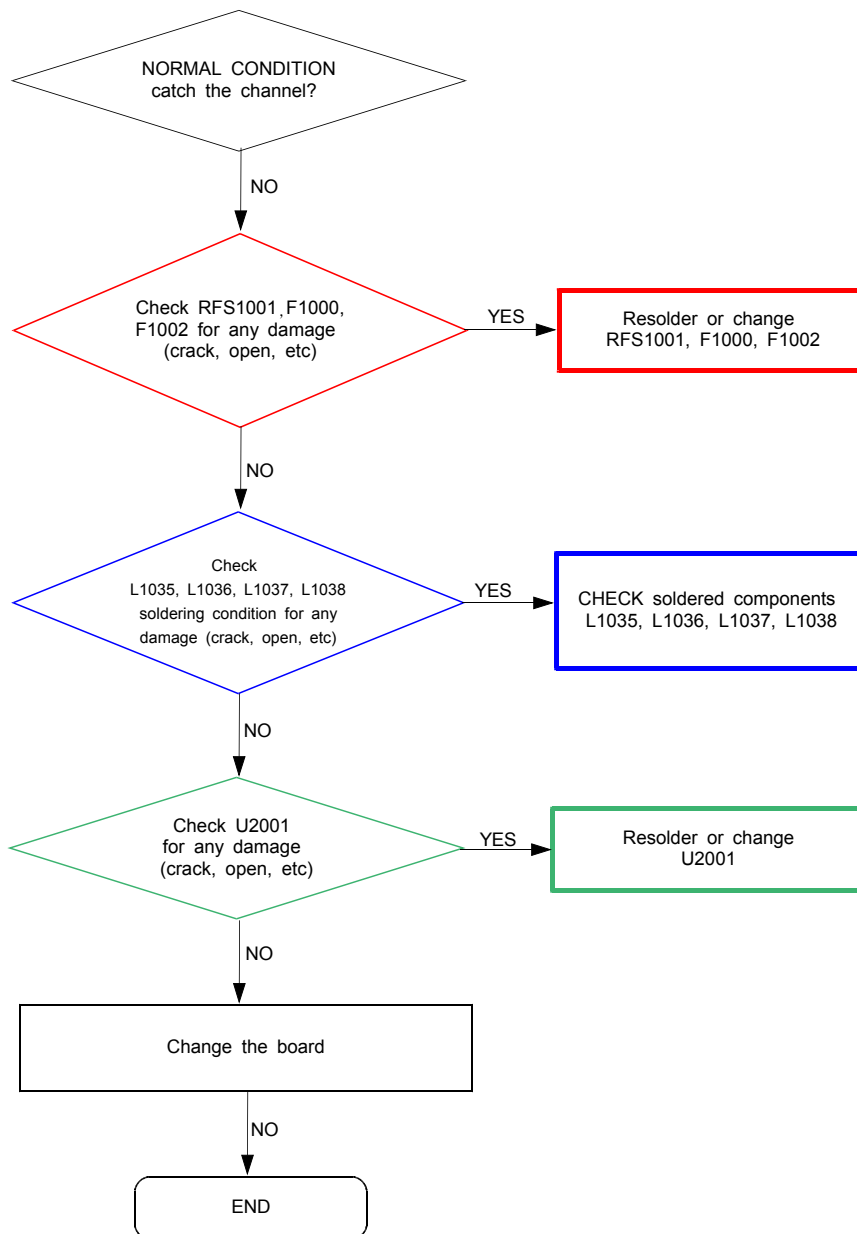


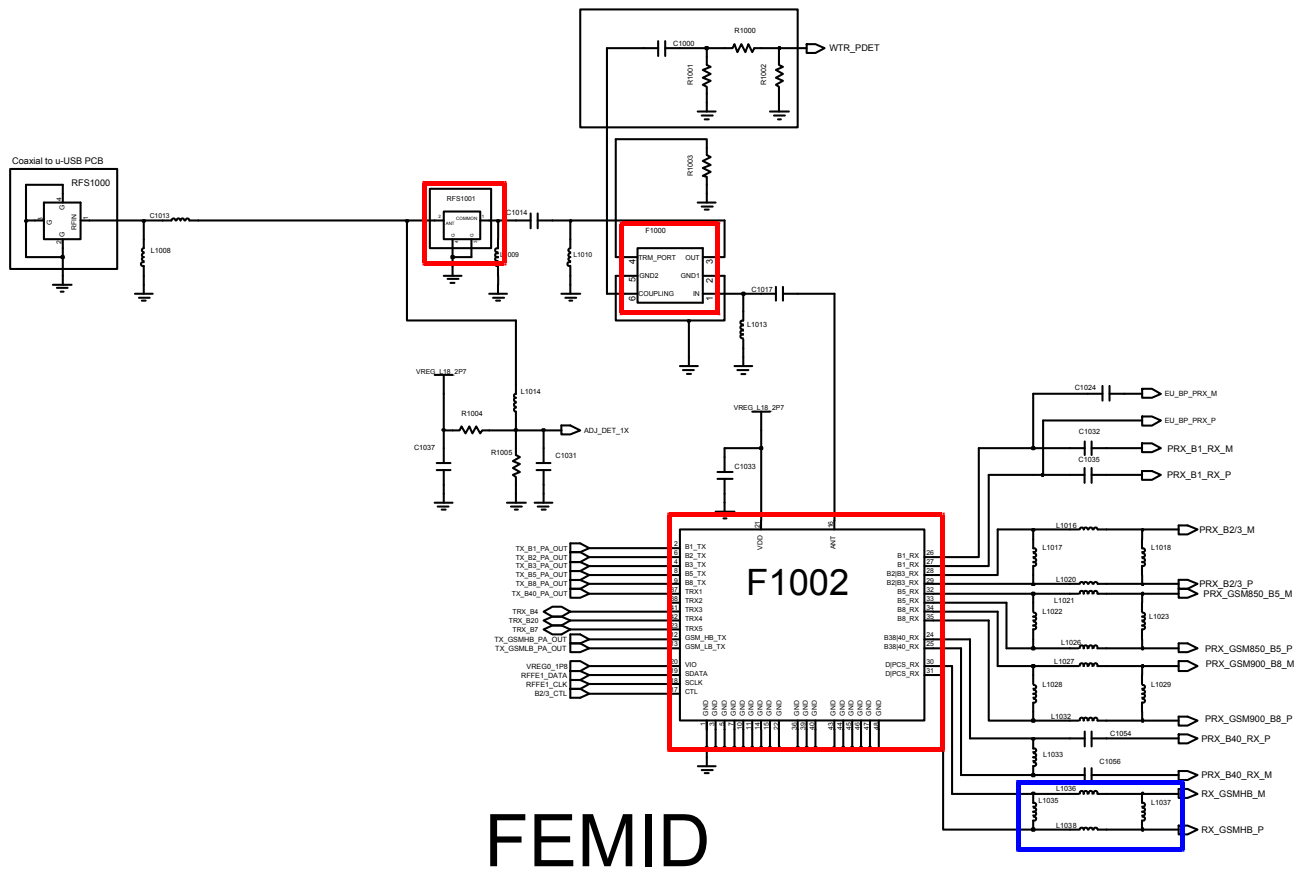


RF Transceiver

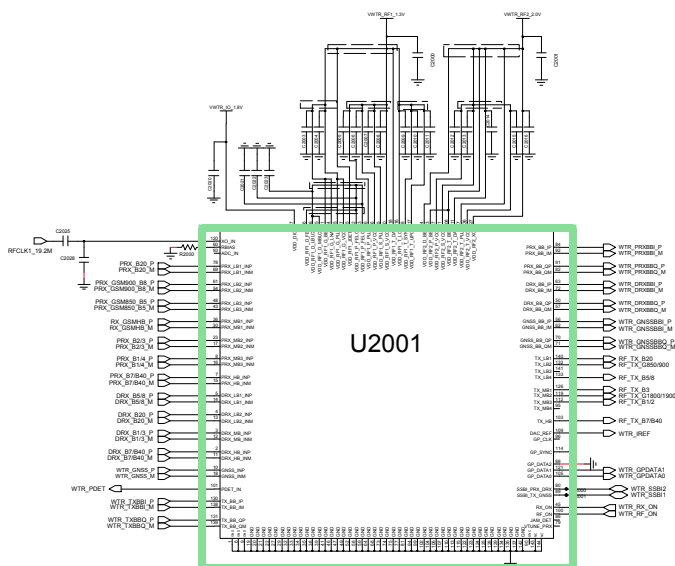


8-3-20. GSM1800 / GSM1900 RX

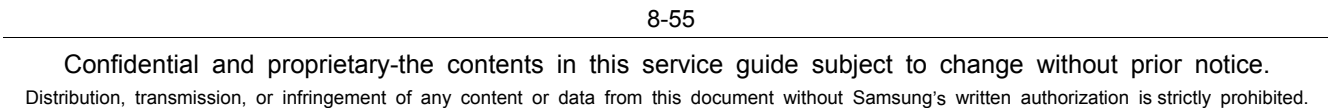




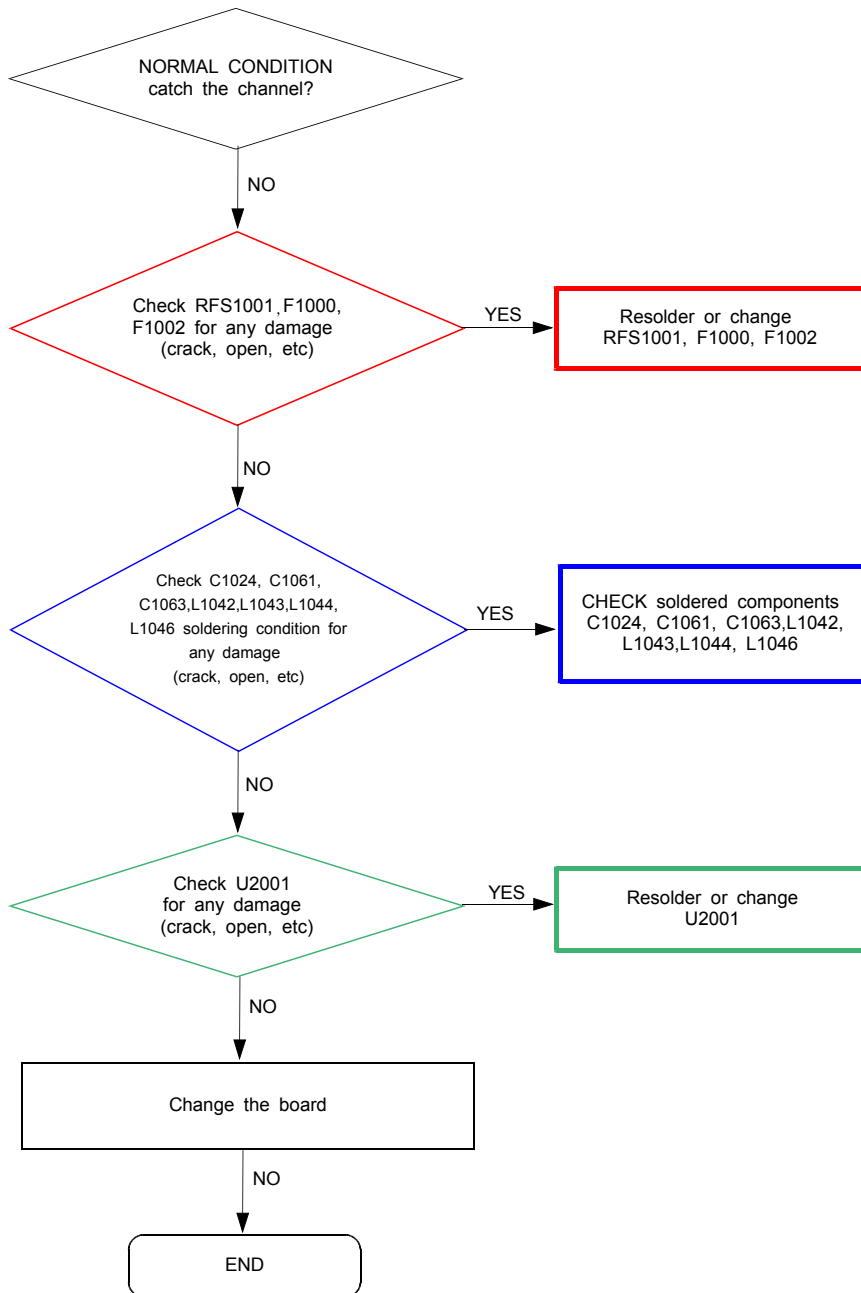
FEMID



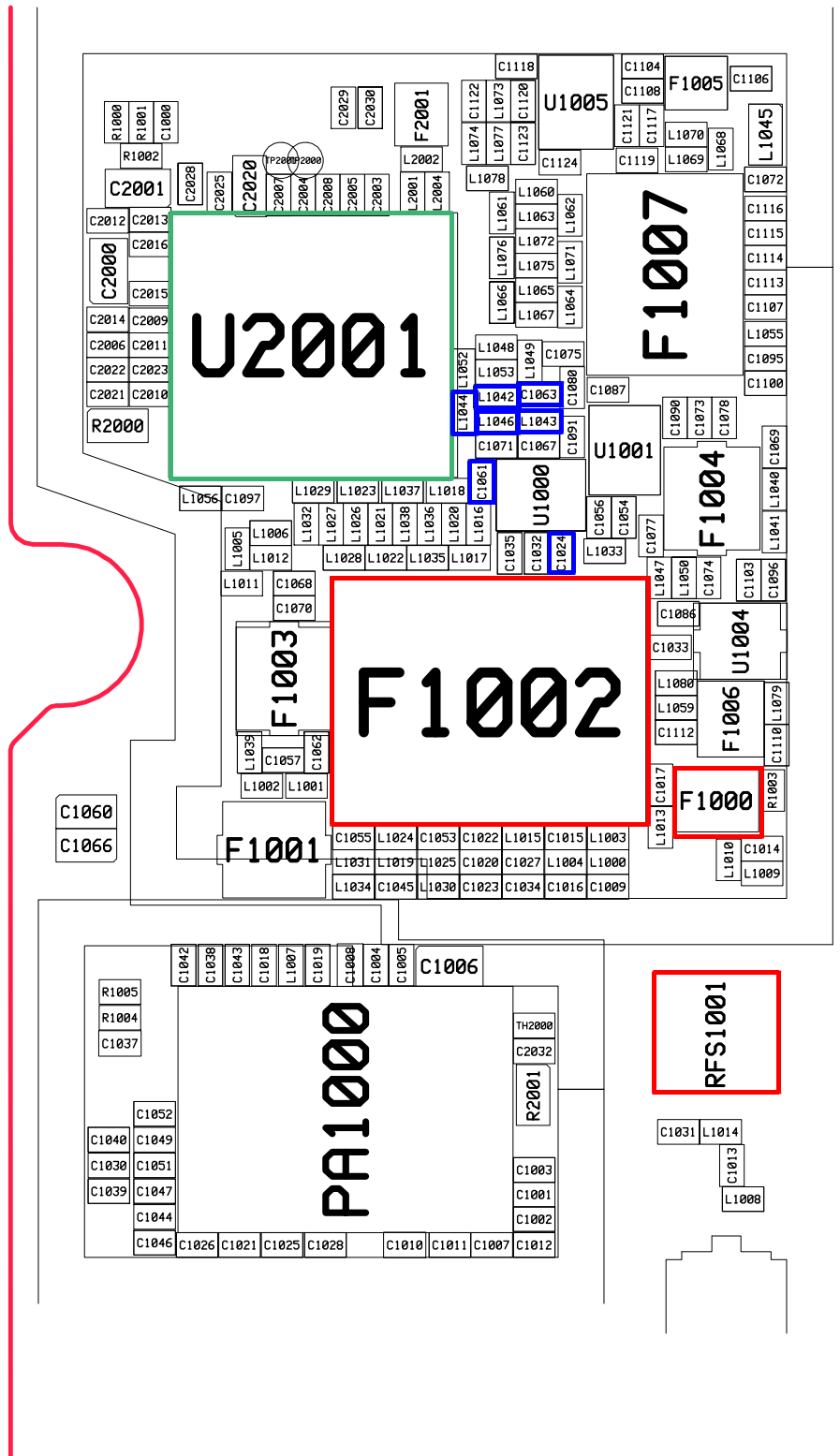
RF Transceiver



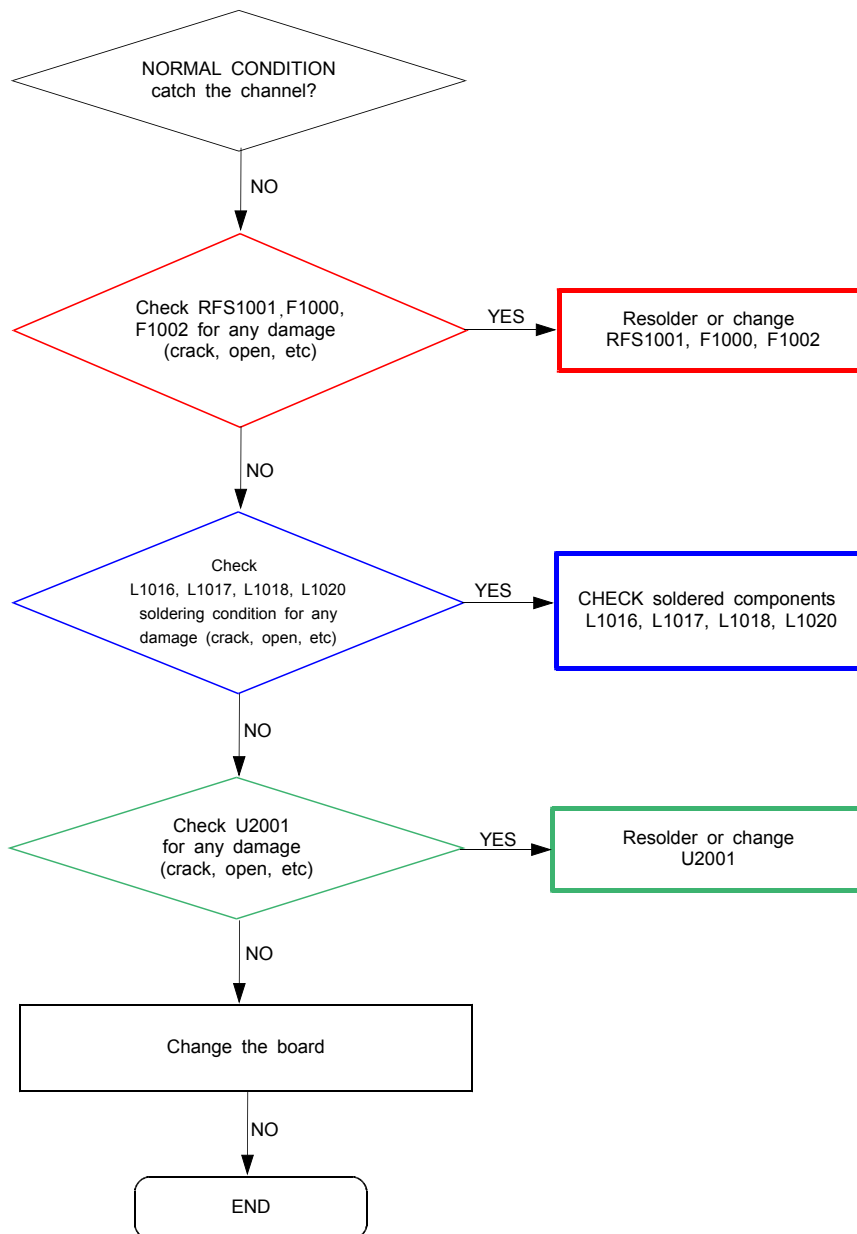
8-3-21. WCDMA B1 RX



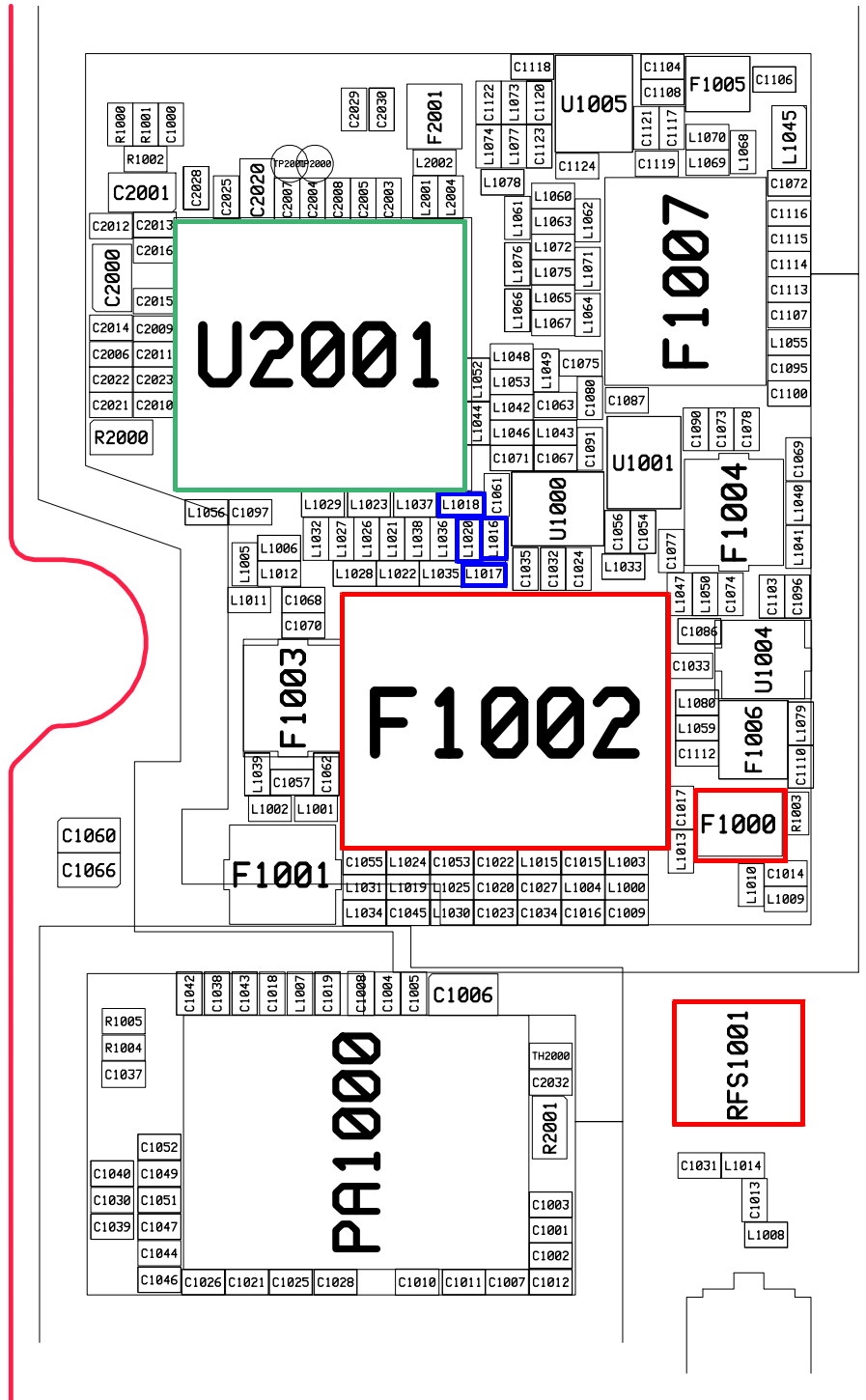




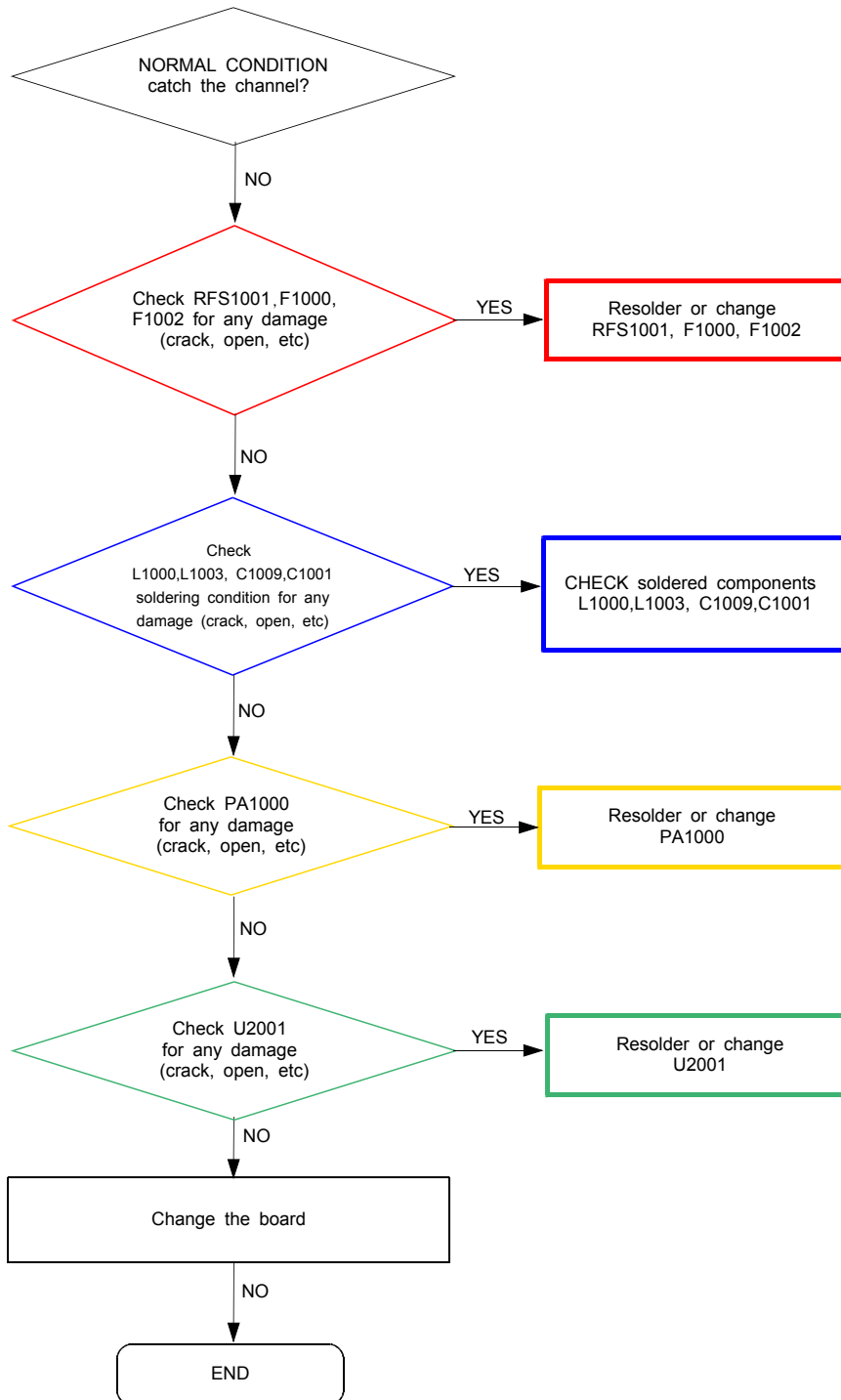
8-3-22. WCDMA B2 RX

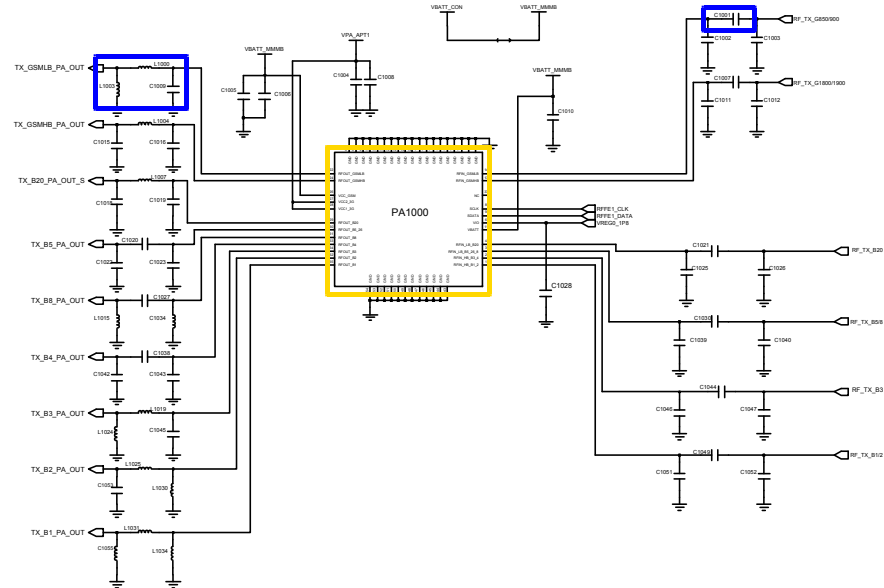






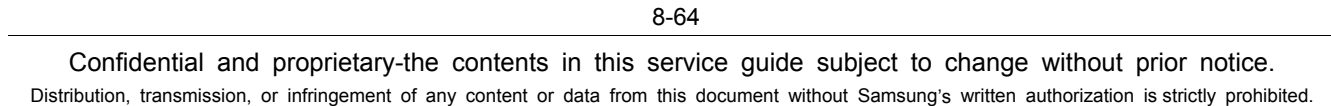
8-3-25. GSM850 / GSM900 TX



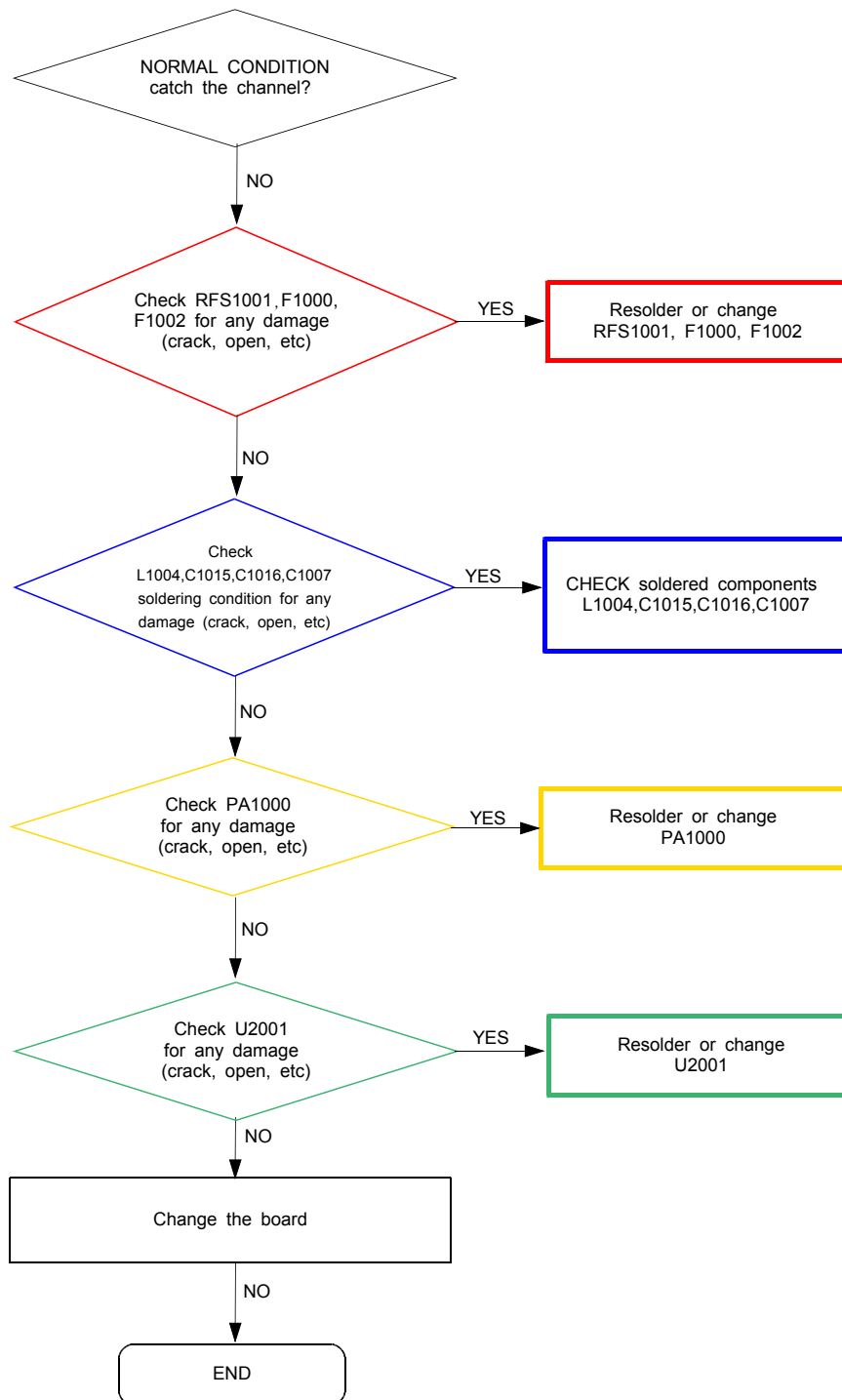


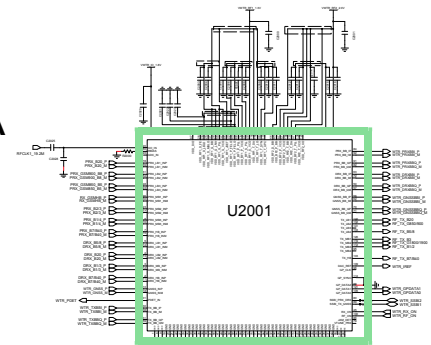
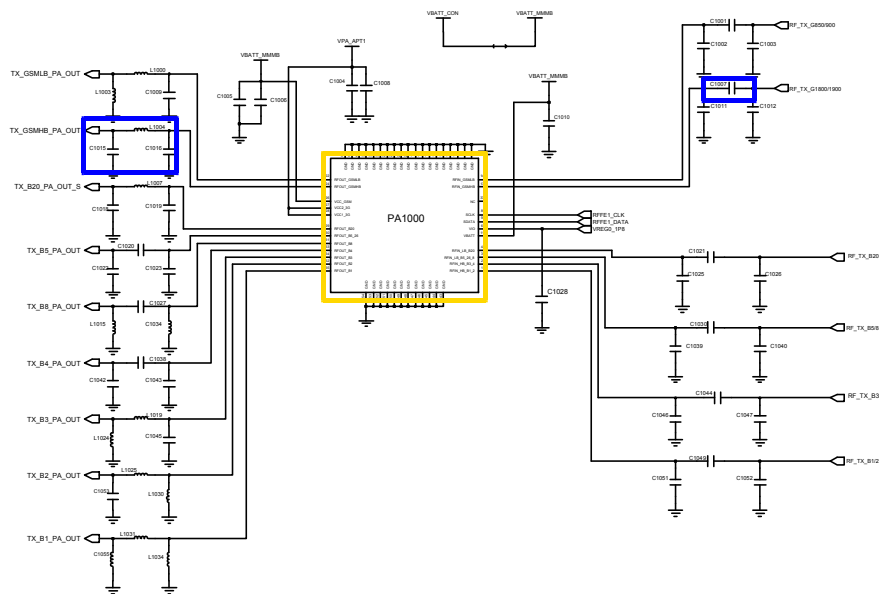
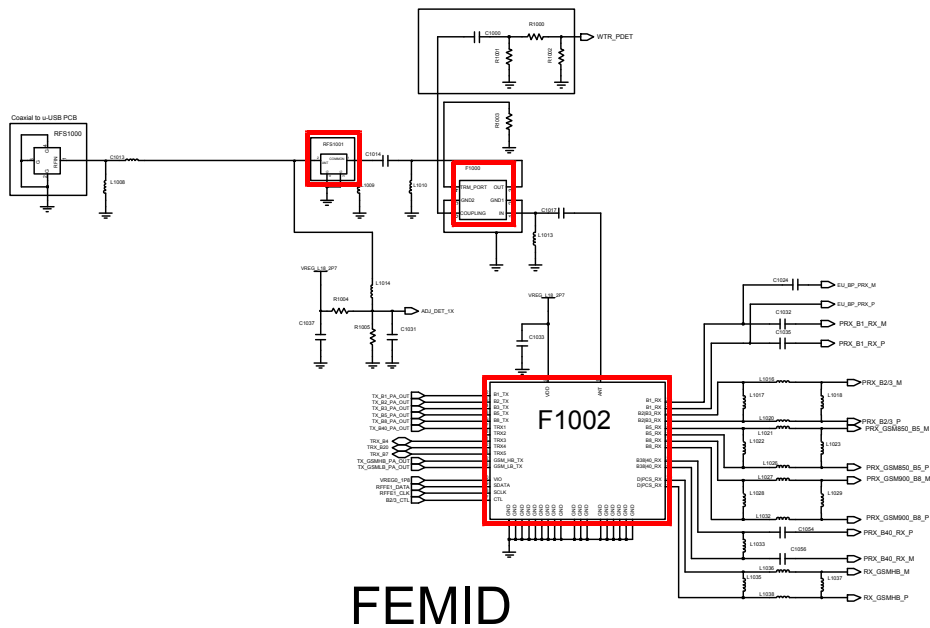
8-63

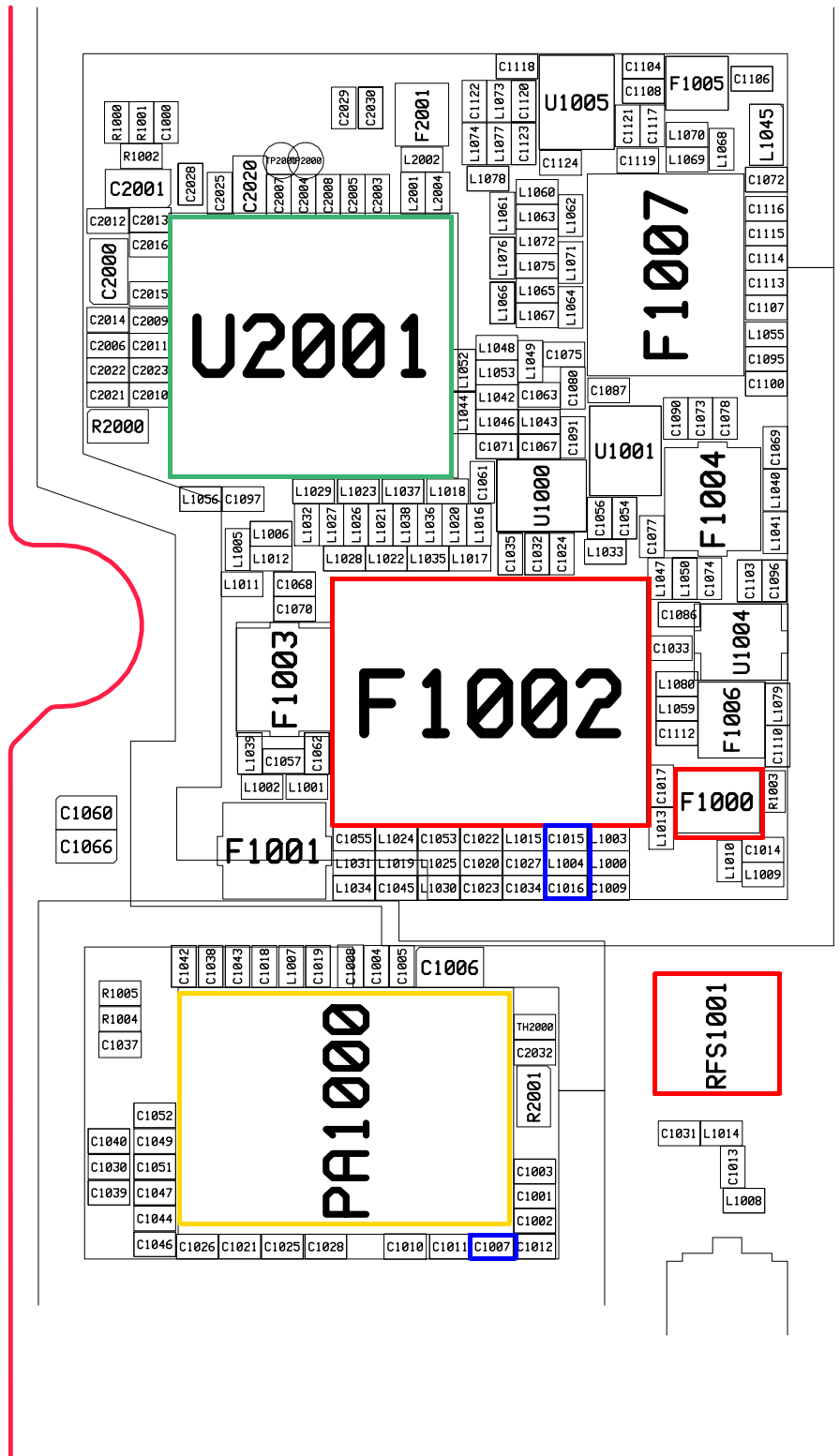
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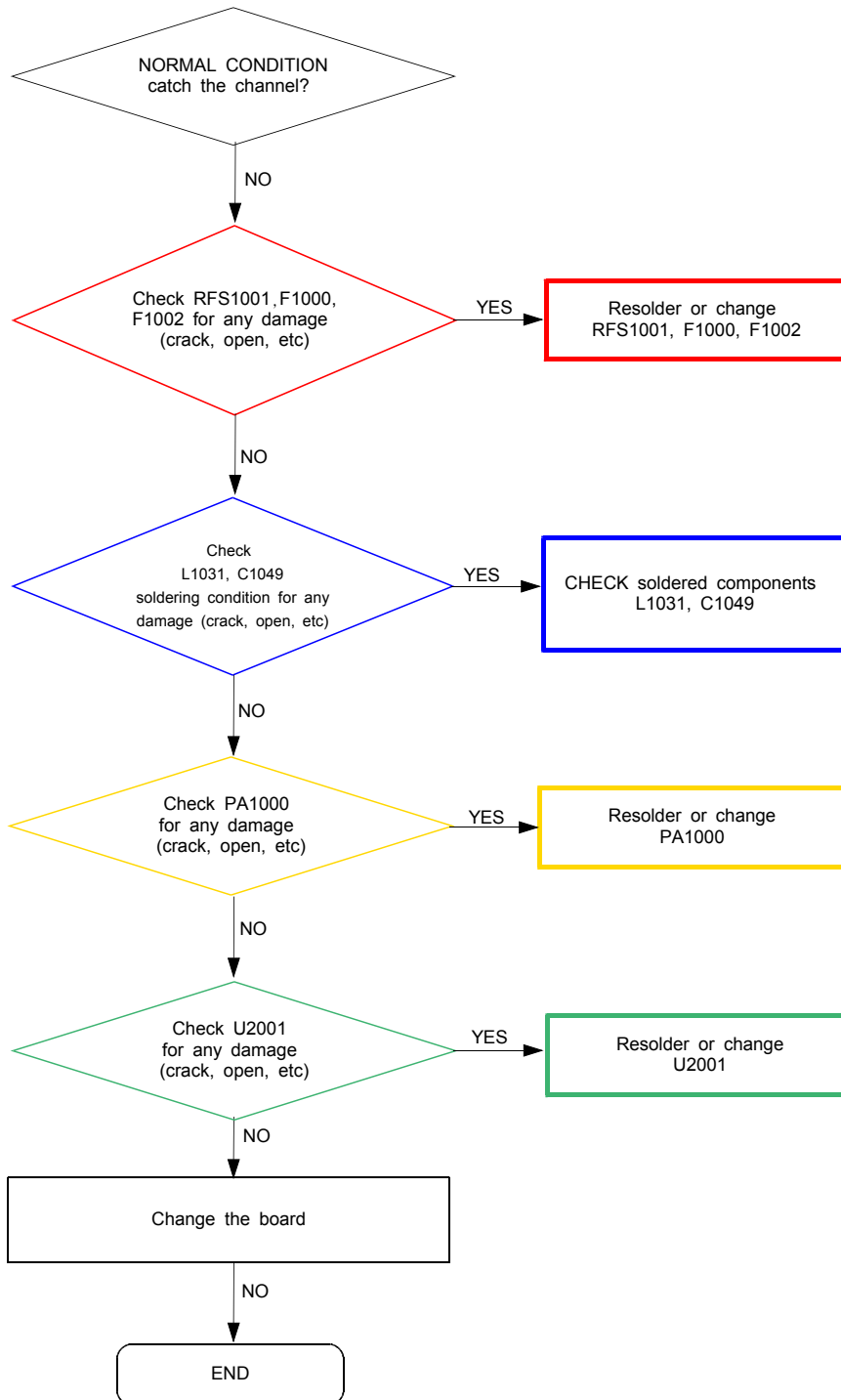
8-3-26. GSM1800 / GSM1900 TX



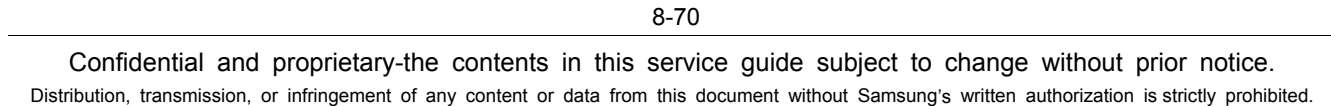




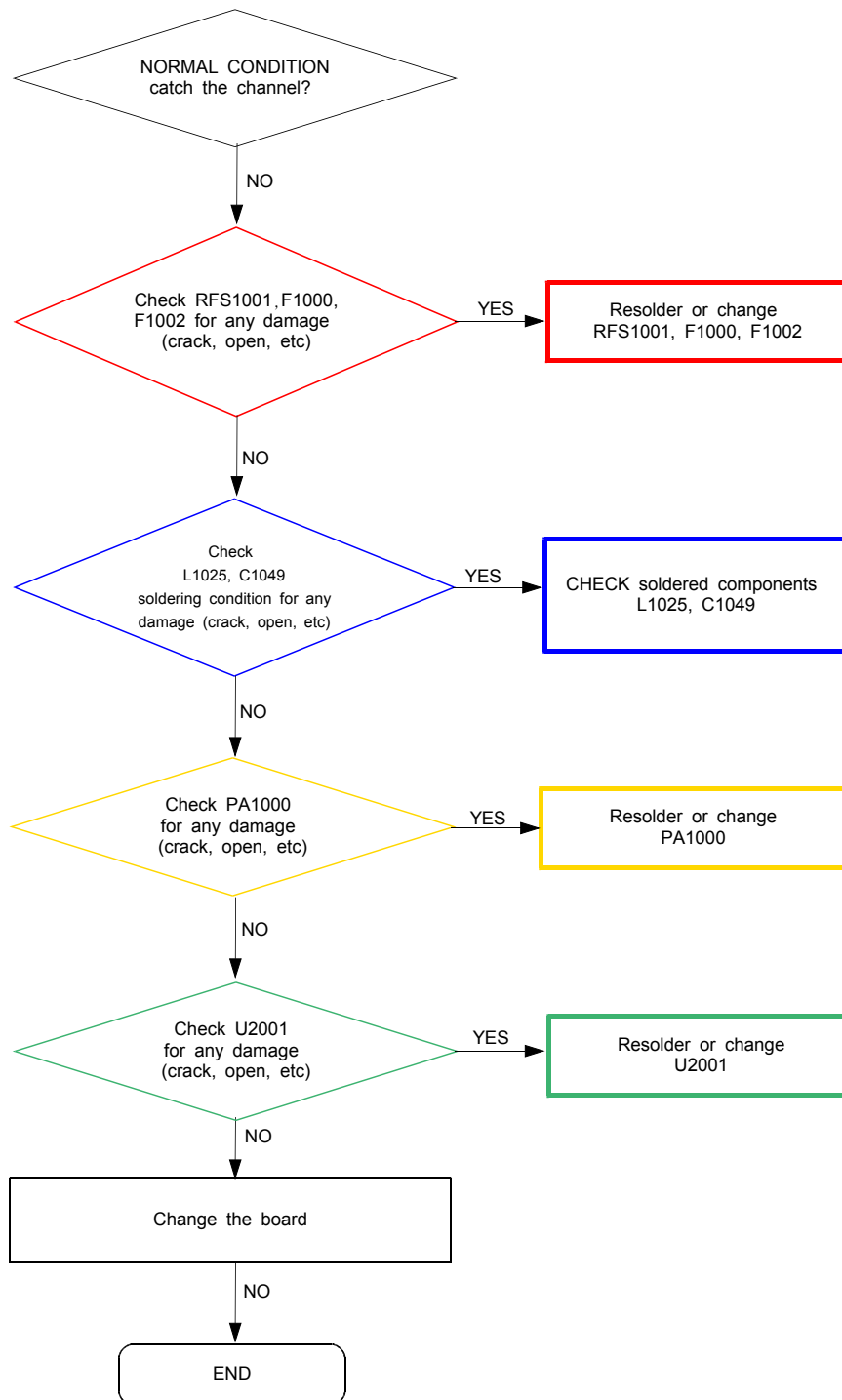
8-3-27. WCDMA B1 TX

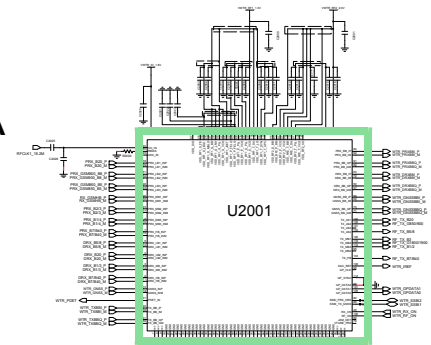
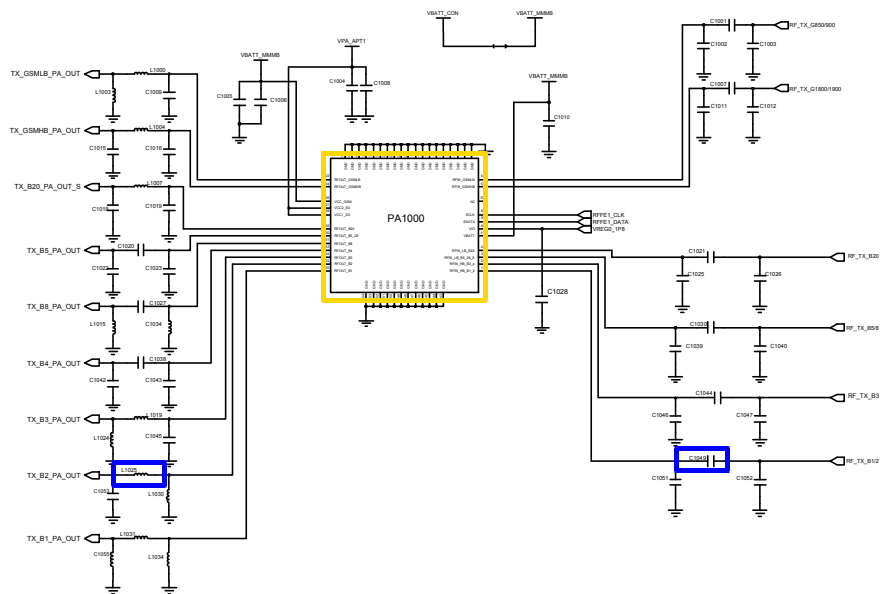
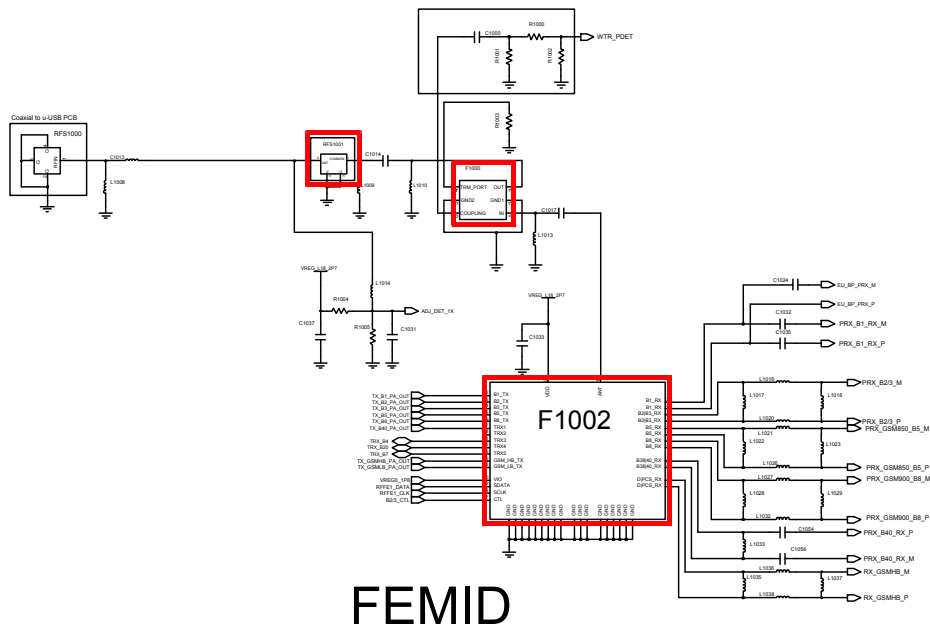




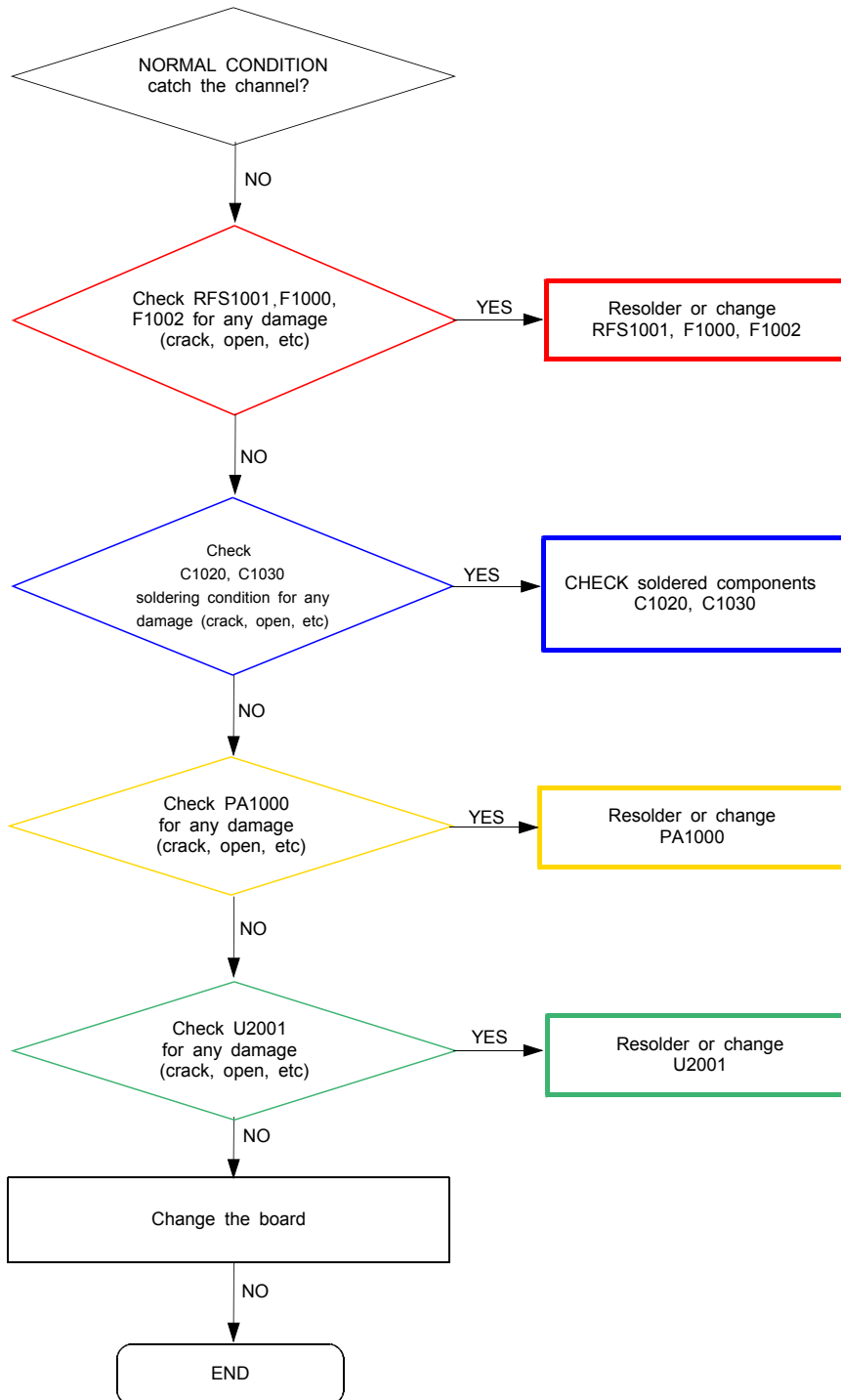


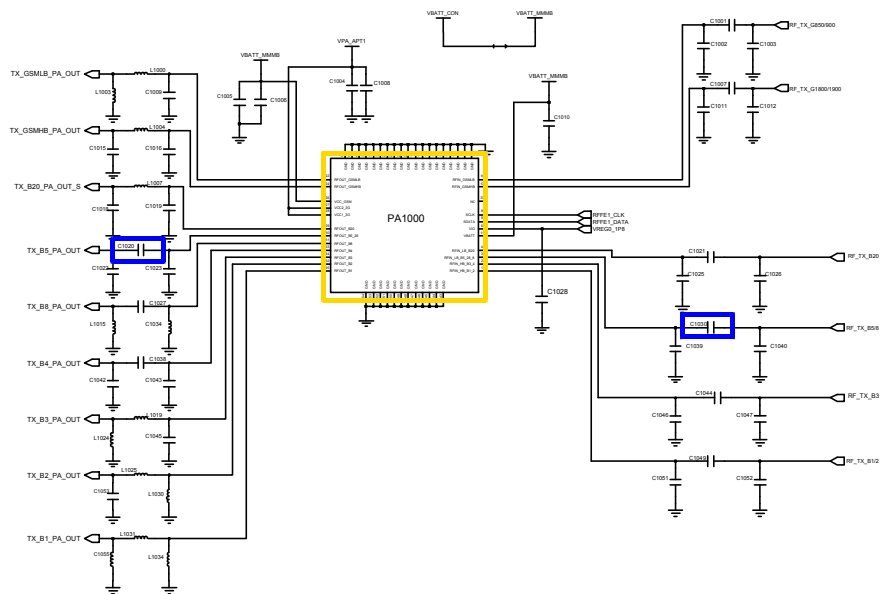
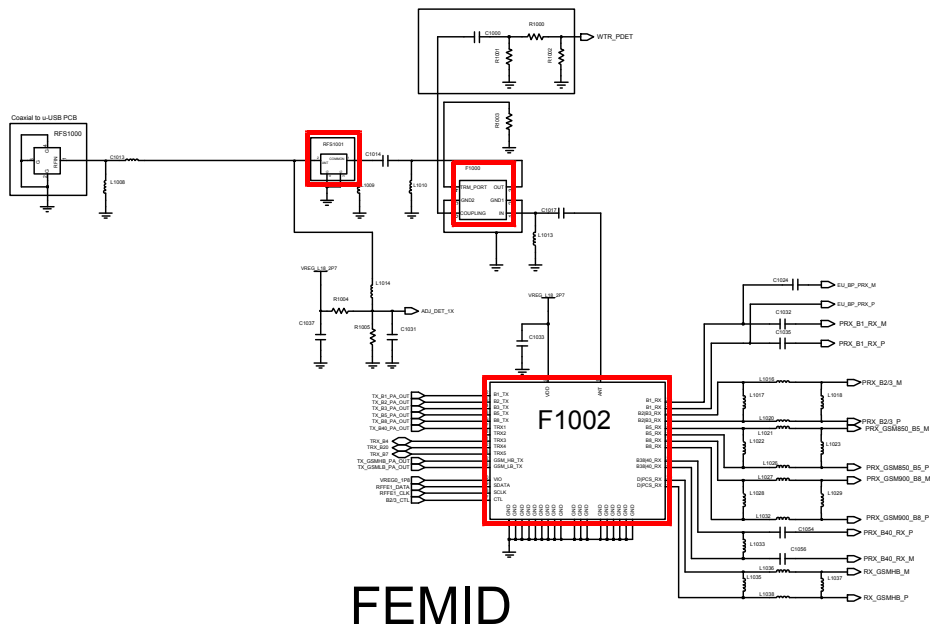
8-3-28. WCDMA B2 TX



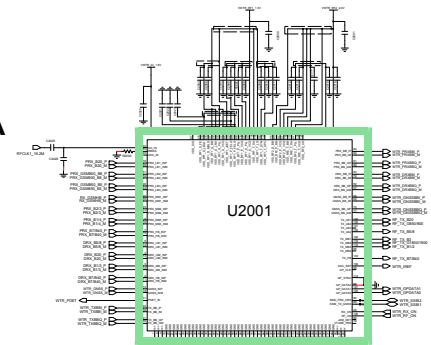


8-3-29. WCDMA B5 TX

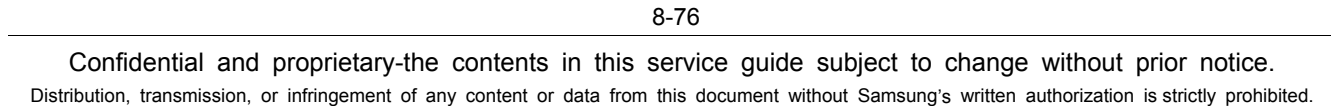




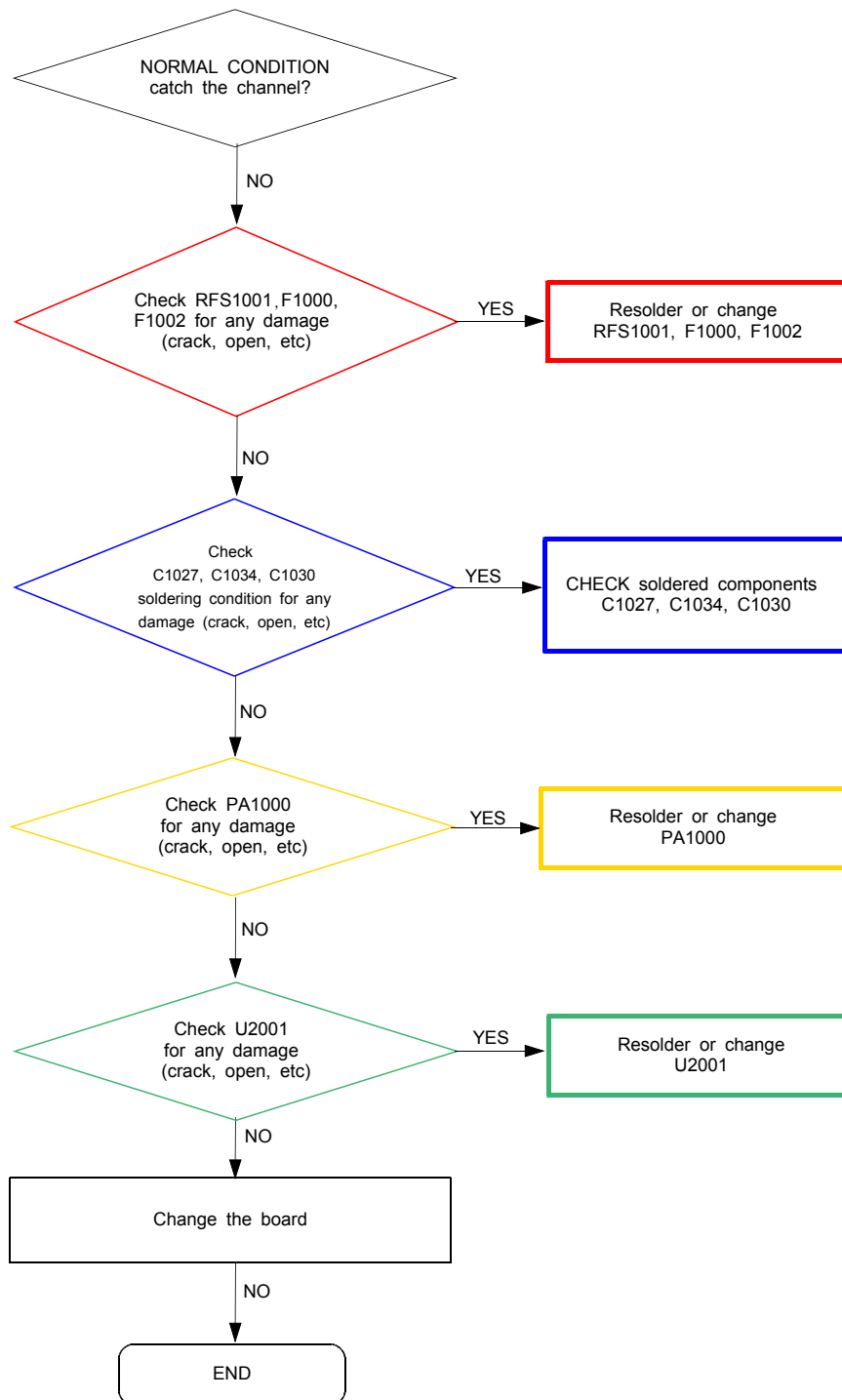
BAND1/2/3/5/8/20, GSM QUAD MMMB PA

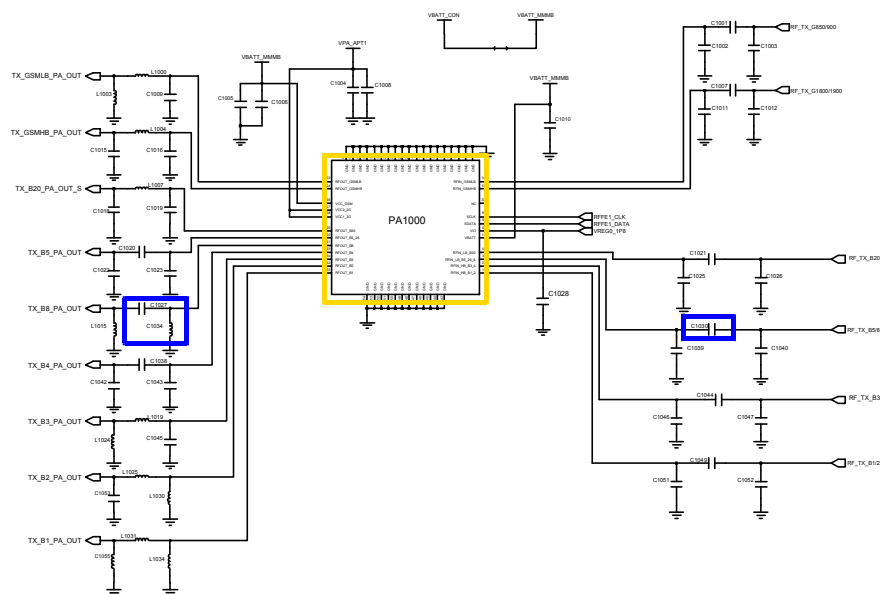
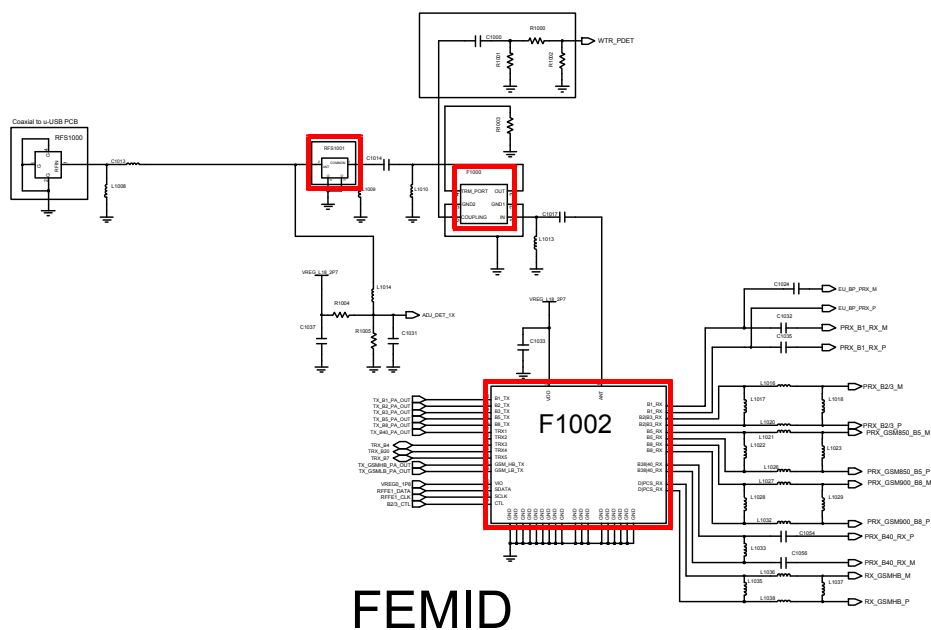


RF Transceiver

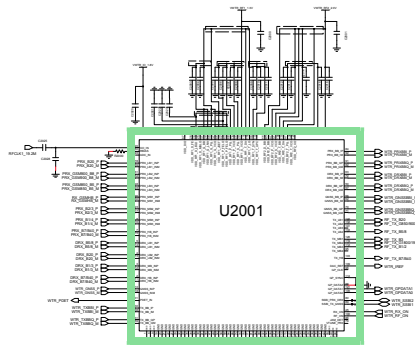


8-3-30. WCDMA B8 TX

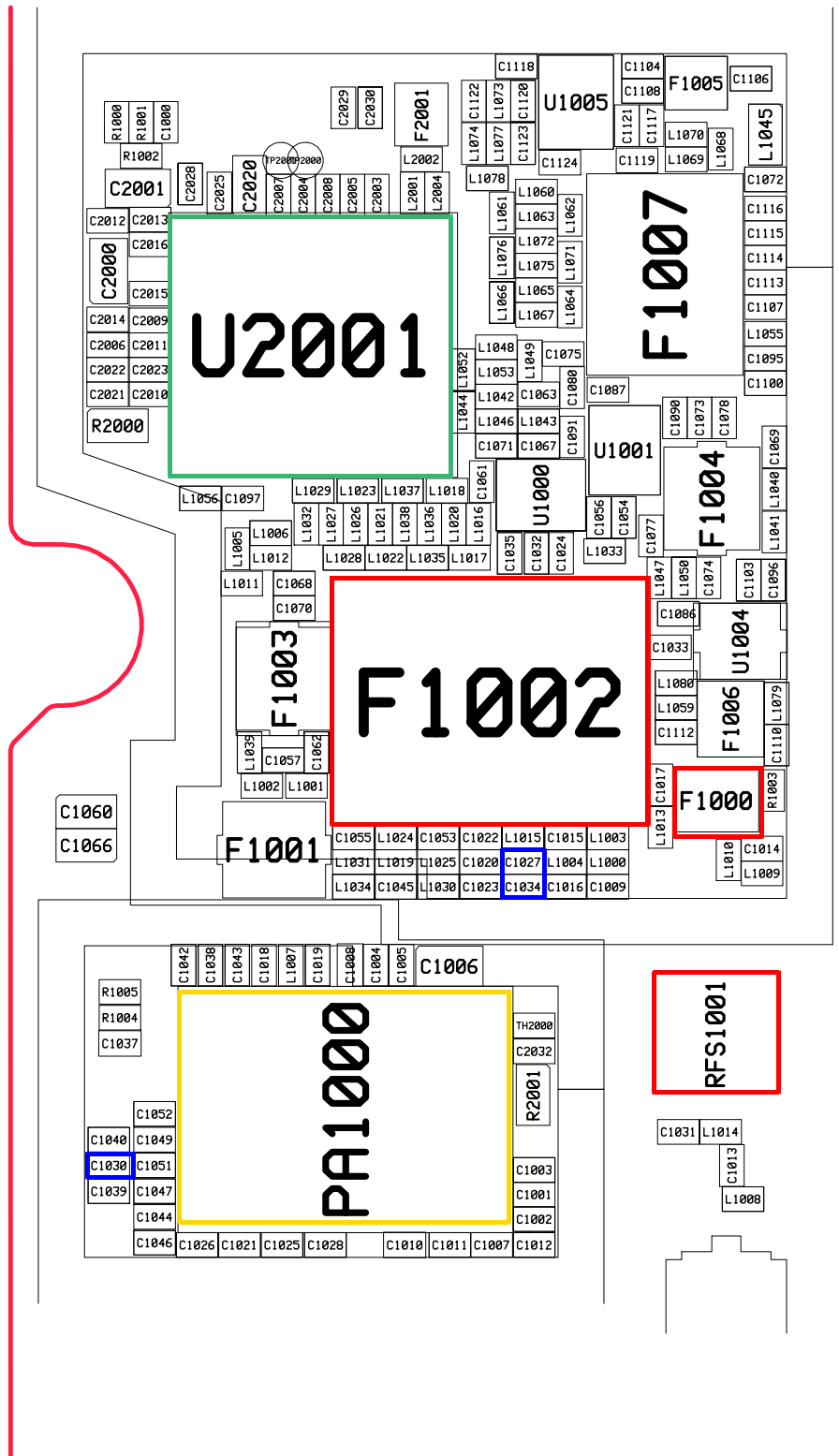




BAND1/2/3/5/8/20, GSM QUAD MMMB PA



RF Transceiver

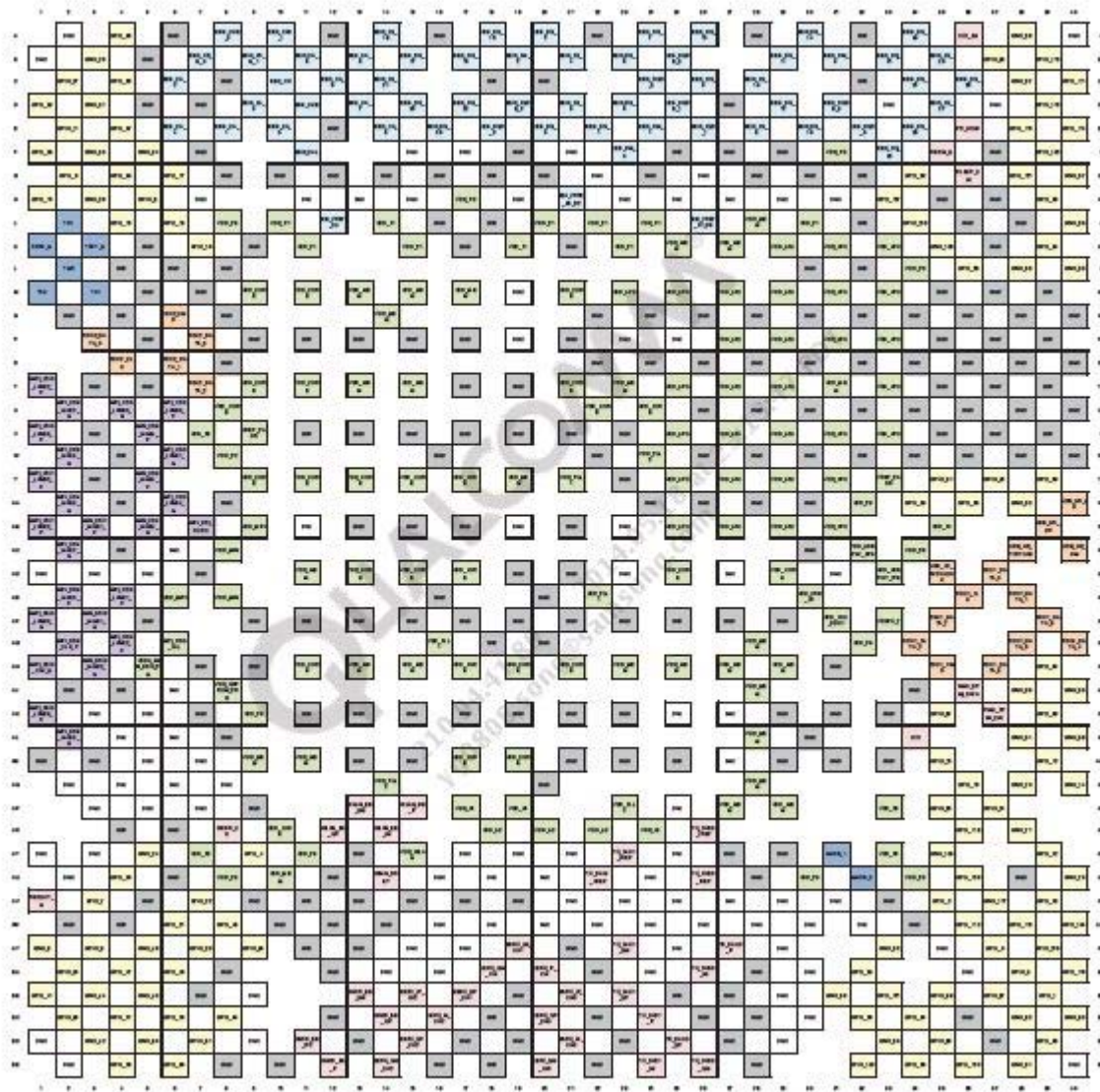


-NC Point(Top View)

●: NC

	1	2	3	4	5	6	7	8	9	10	11	12	13	14
A														
B														
C	●													●
D	●								●	●	●	●	●	●
E	●	●	●	●	●	●	●	●	●	●	●	●	●	●
F	●					●	●							●
G	●					●	●							●
H	●					●	●							●
I	●					●	●							●
J	●					●	●							●
K	●					●	●							●
L	●					●	●							●
M	●					●	●							●
N	●					●	●							●
P	●					●	●							●
R	●					●	●							●
T	●					●	●							●
U	●					●	●							●
V	●					●	●							●
W	●					●	●							●
Y	●					●	●							●
AA						●	●							
AB						●	●							

UME4000



The image displays a large, complex grid of data, likely a repair data table for a Samsung device. The grid is organized into rows and columns, with each cell containing a numerical value. The values are color-coded: blue for negative values, green for positive values, and yellow for zero. The grid is divided into several sections by vertical and horizontal lines, suggesting a hierarchical or categorical structure. The overall layout is dense and technical, typical of a service manual or repair guide.

UCP3000

	<u>1</u>	<u>2</u>	<u>3</u>	<u>4</u>	<u>5</u>	<u>6</u>	<u>7</u>	<u>8</u>	<u>9</u>	<u>10</u>	<u>11</u>	<u>12</u>	<u>13</u>	<u>14</u>
<u>A</u>														
<u>B</u>														
<u>C</u>										●				
<u>D</u>								●	●					
<u>E</u>						●								
<u>F</u>				●		●								
<u>G</u>														
<u>H</u>	●			●					●					●
<u>J</u>									●					
<u>K</u>						●	●					●		
<u>L</u>					●	●	●		●					
<u>M</u>														●
<u>N</u>														
<u>P</u>											●			

U4000